

## Low cost 32-bit transputer

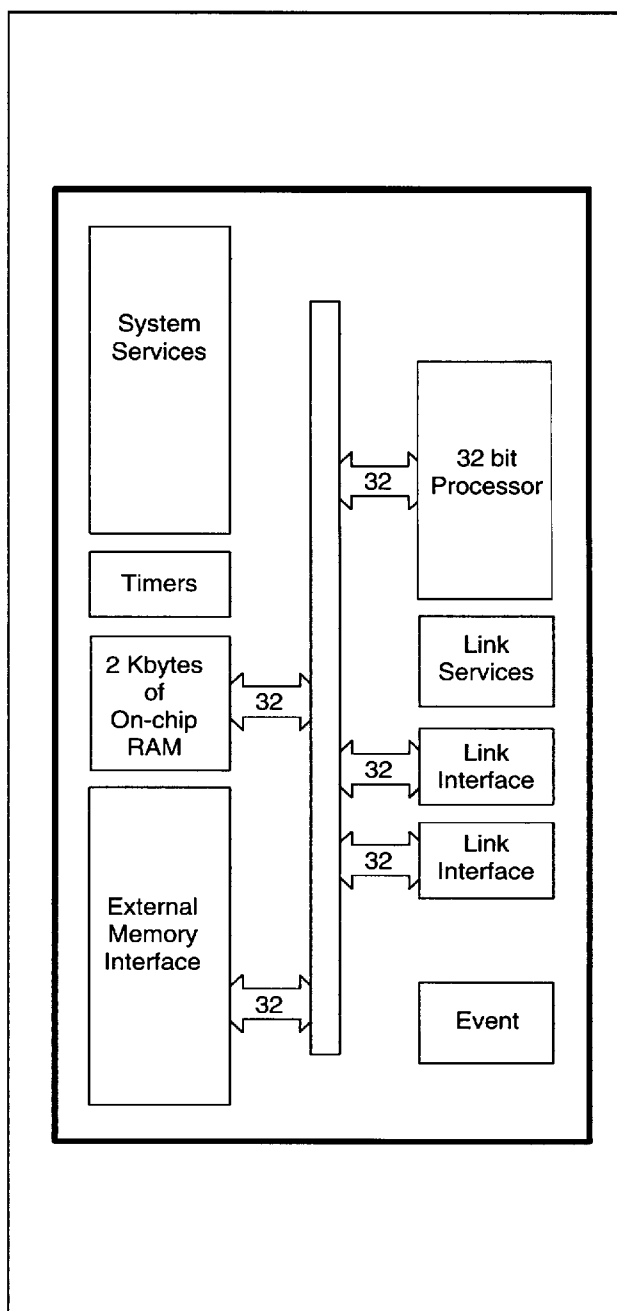
### FEATURES

- 32 bit architecture
- 50 ns internal cycle time
- 20 MHz only
- 20 MIPS peak instruction rate
- 10 MIPS sustained instruction rate
- Pin compatible with IMS T805, IMS T800, IMS T425 and IMS T414
- 2 Kbytes on-chip static RAM
- 80 Mbytes/sec sustained data rate to internal memory
- 4 Gbytes directly addressable external memory
- 26 Mbytes/sec sustained data rate to external memory
- 950 ns response to interrupts
- Whetstones/sec 704K
- Dhrystones/sec 8193
- Two INMOS serial links 5/10/20 Mbits/sec
- High performance graphics support with block move instructions
- Boot from ROM or communication links
- Single 5 MHz clock input
- Single +5V 10% power supply
- Packaging 84 pin PGA / 84 pin PLCC100 / pin PQFP / 100 pin TQFP

### APPLICATIONS

The IMS T400 is a low-cost product designed for single or multiprocessor applications in:

- Telecoms
- Office systems
- Industrial control
- Robotics
- Instrumentation
- Computing



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## 1 Introduction

The IMS T400 transputer is a 32 bit CMOS microcomputer with graphics support. It has 2 Kbytes on-chip RAM for high speed processing, a configurable memory interface and two standard INMOS communication links. The instruction set achieves efficient implementation of high level languages such as ANSI C and provides direct support for concurrency when using either a single transputer or a network. Procedure calls, process switching and typical interrupt latency are sub-microsecond.

For convenience of description, the IMS T400 operation is split into the basic blocks shown in figure 1.1.

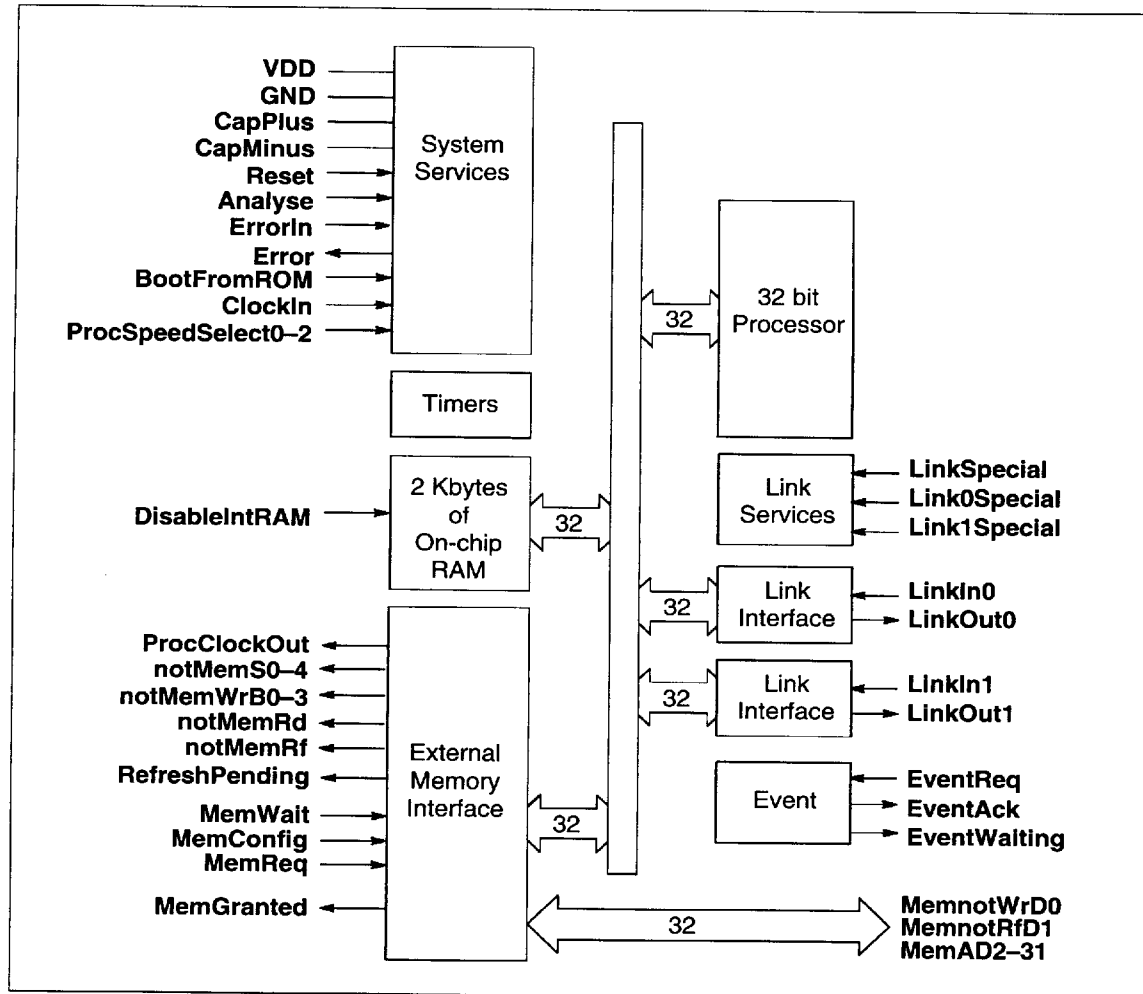


Figure 1.1 IMS T400 block diagram

The processor speed of the device is fixed at 20 MHz and achieves an instruction throughput of 20 MIPS peak and 10 MIPS sustained.

High performance graphics support is provided by microcoded block move instructions which operate at the speed of memory. The two-dimensional block move instructions provide for contiguous block moves as well as block copying of either non-zero bytes of data only or zero bytes only. Block move instructions can be used to provide graphics operations such as text manipulation, windowing, panning, scrolling and screen updating.

Cyclic redundancy checking (CRC) instructions are available for use on arbitrary length serial data streams, to provide error detection where data integrity is critical. Another feature of the IMS T400, useful for pattern recognition, is the facility to count bits set in a word.

The IMS T400 can directly access a linear address space of 4 Gbytes. The 32 bit wide memory interface uses multiplexed data and address lines and provides a data rate of up to 4 bytes every 150 nanoseconds (26.6 Mbytes/sec) for a 20 MHz device. A configurable memory controller provides all timing, control and DRAM refresh signals for a wide variety of mixed memory systems.

System Services include processor reset and bootstrap control, together with facilities for error analysis. Error signals may be daisy-chained in multi-transputer systems.

The standard INMOS communication links allow networks of transputer family products to be constructed by direct point to point connections with no external logic. The IMS T400 links support the standard operating speed of 10 Mbits/sec, but also operate at 5 or 20 Mbits/sec. Each link can transfer data bi-directionally at up to 2.35 Mbytes/sec.

The IMS T400-20 is pin compatible with the IMS T805-20 and IMS T425-20 and can be plugged directly into a circuit designed for those devices.

The transputer is designed to efficiently implement high level languages such as ANSI C and occam. Access to the transputer at machine level is seldom required, but if necessary refer to the *Transputer Instruction Set – A Compiler Writer's Guide*.

## 2 Pin designations

Signal names are preceded by **not** if they are active low, otherwise they are active high.  
Pinout details for various packages are given in section 9.

| Pin                | In/Out | Function                                           |
|--------------------|--------|----------------------------------------------------|
| VDD, GND           |        | Power supply and return                            |
| CapPlus, CapMinus  |        | External capacitor for internal clock power supply |
| ClockIn            | in     | Input clock                                        |
| ProcSpeedSelect0-2 | in     | Processor speed selectors                          |
| Reset              | in     | System reset                                       |
| Error              | out    | Error indicator                                    |
| ErrorIn            | in     | Error daisychain input                             |
| Analyse            | in     | Error analysis                                     |
| BootFromROM        | in     | Boot from external ROM or from link                |
| DisableIntRAM      | in     | Disable internal RAM                               |
| HoldToGND          |        | Must be connected to <b>GND</b>                    |
| DoNotWire          |        | Must not be wired                                  |
| N/C                |        | There is no internal connection to this pin        |

Table 2.1 IMS T400 system services

| Pin            | In/Out | Function                                       |
|----------------|--------|------------------------------------------------|
| ProcClockOut   | out    | Processor clock                                |
| MemnotWrD0     | in/out | Multiplexed data bit 0 and write cycle warning |
| MemnotRfD1     | in/out | Multiplexed data bit 1 and refresh warning     |
| MemAD2-31      | in/out | Multiplexed data and address bus               |
| notMemRd       | out    | Read strobe                                    |
| notMemWrB0-3   | out    | Four byte-addressing write strobes             |
| notMemS0-4     | out    | Five general purpose strobes                   |
| notMemRf       | out    | Dynamic memory refresh indicator               |
| RefreshPending | out    | Dynamic refresh is pending                     |
| MemWait        | in     | Memory cycle extender                          |
| MemReq         | in     | Direct memory access request                   |
| MemGranted     | out    | Direct memory access granted                   |
| MemConfig      | in     | Memory configuration data input                |

Table 2.2 IMS T400 external memory interface

| Pin          | In/Out | Function                          |
|--------------|--------|-----------------------------------|
| EventReq     | in     | Event request                     |
| EventAck     | out    | Event request acknowledge         |
| EventWaiting | out    | Event input requested by software |

Table 2.3 IMS T400 event

| Pin          | In/Out | Function                                       |
|--------------|--------|------------------------------------------------|
| LinkIn0-1    | in     | Two serial data input channels                 |
| LinkOut0-1   | out    | Two serial data output channels                |
| LinkSpecial  | in     | Select non-standard speed as 5 or 20 Mbits/sec |
| Link0Special | in     | Select special speed for Link 0                |
| Link1Special | in     | Select special speed for Link 1                |

Table 2.4 IMS T400 link

### 3 System services

System services include all the necessary logic to initialise and sustain operation of the device. They also include error handling and analysis facilities.

#### 3.1 Power

Power is supplied to the device via the **VDD** and **GND** pins. Several of each are provided to minimise inductance within the package. All supply pins must be connected. The supply must be decoupled close to the chip by at least one 100 nF low inductance (e.g. ceramic) capacitor between **VDD** and **GND**. Four layer boards are recommended; if two layer boards are used, extra care should be taken in decoupling.

Input voltages must not exceed specification with respect to **VDD** and **GND**, even during power-up and power-down ramping, otherwise *latchup* can occur. CMOS devices can be permanently damaged by excessive periods of latchup.

#### 3.2 CapPlus, CapMinus

The internally derived power supply for internal clocks requires an external low leakage, low inductance 1  $\mu$ F capacitor to be connected between **CapPlus** and **CapMinus**. A ceramic capacitor is preferred, with an impedance less than 3 Ohms between 100 KHz and 10 MHz. If a polarised capacitor is used the negative terminal should be connected to **CapMinus**. Total PCB track length should be less than 50 mm. The connections must not touch power supplies or other noise sources.

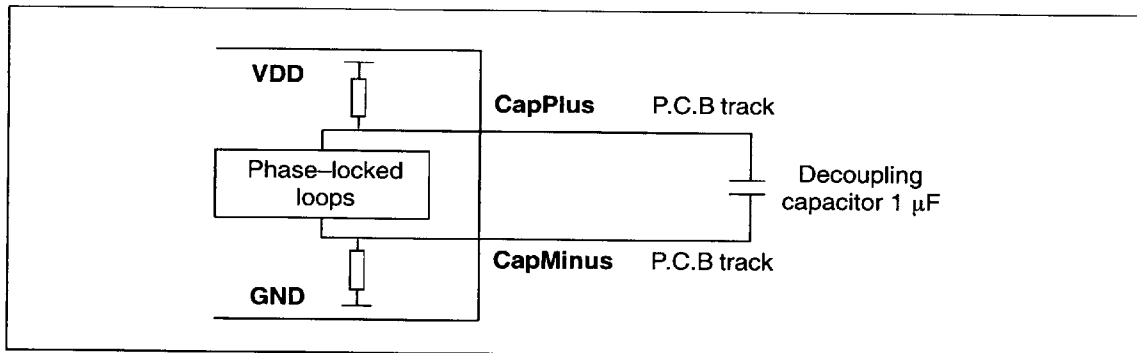


Figure 3.1 Recommended PLL decoupling

#### 3.3 ClockIn

Transputer family components use a standard clock frequency, supplied by the user on the **ClockIn** input. The nominal frequency of this clock for all transputer family components is 5 MHz, regardless of device type, transputer word length or processor cycle time. High frequency internal clocks are derived from **ClockIn**, simplifying system design and avoiding problems of distributing high speed clocks externally.

A number of transputer devices may be connected to a common clock, or may have individual clocks providing each one meets the specified stability criteria. In a multi-clock system the relative phasing of **ClockIn** clocks is not important, due to the asynchronous nature of the links. Mark/space ratio is unimportant provided the specified limits of **ClockIn** pulse widths are met.

Oscillator stability is important. **ClockIn** must be derived from a crystal oscillator; RC oscillators are not sufficiently stable. **ClockIn** must not be distributed through a long chain of buffers. Clock edges must be monotonic and remain within the specified voltage and time limits.

### 3 System services

| Symbol   | Parameter                                         | T400-20 |     |     | Units | Notes |
|----------|---------------------------------------------------|---------|-----|-----|-------|-------|
|          |                                                   | Min     | Nom | Max |       |       |
| TDCLDCH  | <b>ClockIn</b> pulse width low                    | 40      |     |     | ns    |       |
| TDCHDCL  | <b>ClockIn</b> pulse width high                   | 40      |     |     | ns    |       |
| TDCLDCL  | <b>ClockIn</b> period                             |         | 200 |     | ns    | 1,3   |
| TDCerror | <b>ClockIn</b> timing error                       |         |     | 0.5 | ns    | 2     |
| TDC1DC2  | Difference in <b>ClockIn</b> for 2 linked devices |         |     | 400 | ppm   | 3     |
| TDCr     | <b>ClockIn</b> rise time                          |         |     | 10  | ns    | 4     |
| TDCf     | <b>ClockIn</b> fall time                          |         |     | 8   | ns    | 4     |

#### Notes

- 1 Measured between corresponding points on consecutive falling edges.
- 2 Variation of individual falling edges from their nominal times.
- 3 This value allows the use of 200ppm crystal oscillators for two devices connected together by a link.
- 4 Clock transitions must be monotonic within the range **VIH** to **VIL** (table 8.3).

Table 3.1 Input clock

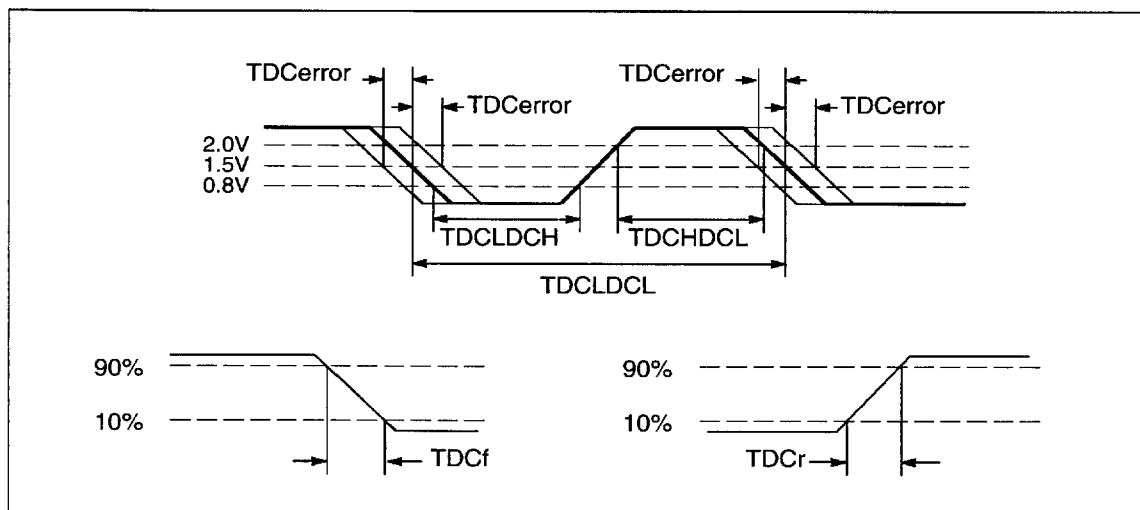


Figure 3.2 **ClockIn** timing

### 3.4 ProcSpeedSelect0–2

Processor speed of the IMS T400 is variable in discrete steps. The desired speed can be selected, up to the maximum rated for a particular component, by the three speed select lines **ProcSpeedSelect0-2**. The pins are tied high or low, according to table 3.2, for the various speeds.

Currently only the 20 MHz speed select combination is available on the IMS T400; the others are not valid speed selectors. The frequency of **ClockIn** for the speeds given in the table is 5 MHz.

| ProcSpeed-<br>Select2 | ProcSpeed-<br>Select1 | ProcSpeed-<br>Select0 | Processor<br>Clock<br>Speed MHz | Processor<br>Cycle<br>Time ns | Notes         |
|-----------------------|-----------------------|-----------------------|---------------------------------|-------------------------------|---------------|
| 0                     | 0                     | 0                     | 20.0                            | 50.0                          |               |
| 0                     | 0                     | 1                     | 22.5                            | 44.4                          | Not supported |
| 0                     | 1                     | 0                     | 25.0                            | 40.0                          | Not supported |
| 0                     | 1                     | 1                     | 30.0                            | 33.3                          | Not supported |
| 1                     | 0                     | 0                     | 35.0                            | 28.6                          | Not supported |
| 1                     | 0                     | 1                     |                                 |                               | Invalid       |
| 1                     | 1                     | 0                     | 17.5                            | 57.1                          | Not supported |
| 1                     | 1                     | 1                     |                                 |                               | Invalid       |

Table 3.2 Processor speed selection

### 3.5 Bootstrap

The transputer can be bootstrapped either from a link or from external ROM. To facilitate debugging, **BootFromROM** may be dynamically changed but must obey the specified timing restrictions. It is sampled once only by the transputer, before the first instruction is executed after **Reset** is taken low.

If **BootFromROM** is connected high (e.g. to **VDD**) the transputer starts to execute code from the top two bytes in external memory, at address #7FFFFFFE. This location should contain a backward jump to a program in ROM. Following this access, **BootFromROM** may be taken low if required. The processor is in the low priority state, and the **W** register points to *MemStart* (page 4).

If **BootFromROM** is connected low (e.g. to **GND**) the transputer will wait for the first bootstrap message to arrive on any one of its links. The transputer is ready to receive the first byte on a link within two processor cycles **TPCLPCL** after **Reset** goes low.

If the first byte received (the control byte) is greater than 1 it is taken as the quantity of bytes to be input. The following bytes, to that quantity, are then placed in internal memory starting at location *MemStart*. Following reception of the last byte the transputer will start executing code at *MemStart* as a low priority process. **BootFromROM** may be taken high after reception of the last byte, if required. The memory space immediately above the loaded code is used as work space. A byte arriving on the other link after the control byte has been received and on the bootstrapping link after the last bootstrap byte, will be retained and no acknowledge will be sent until a process inputs from them.

### 3.6 Peek and poke

Any location in internal or external memory can be interrogated and altered when the transputer is waiting for a bootstrap from link. If the control byte is 0 then eight more bytes are expected on the same link. The first four byte word is taken as an internal or external memory address at which to poke (write) the second four byte word. If the control byte is 1 the next four bytes are used as the address from which to peek (read) a word of data; the word is sent down the output channel of the same link.

Following such a peek or poke, the transputer returns to its previously held state. Any number of accesses may be made in this way until the control byte is greater than 1, when the transputer will commence reading its bootstrap program. Either link can be used, but addresses and data must be transmitted via the same link as the control byte.



### 3.7 Reset

**Reset** can go high with **VDD**, but must at no time exceed the maximum specified voltage for **VIH**. After **VDD** is valid **ClockIn** should be running for a minimum period **TDCVRL** before the end of **Reset**. The falling edge of **Reset** initialises the transputer, triggers the memory configuration sequence and starts the bootstrap routine. Link outputs are forced low during reset; link inputs and **EventReq** should be held low. Memory request (DMA) must not occur whilst **Reset** is high but can occur before bootstrap (page 29).

After the end of **Reset** there will be a delay of 144 periods of **ClockIn** (figure 3.3). Following this, the **MemnotWrD0**, **MemnotRfD1** and **MemAD2-31** pins will be scanned to check for the existence of a pre-programmed memory interface configuration (page 31). This lasts for a further 144 periods of **ClockIn**. Regardless of whether a configuration was found, 36 configuration read cycles will then be performed on external memory using the default memory configuration (page 33), in an attempt to access the external configuration ROM. A delay will then occur, its period depending on the actual configuration. Finally eight complete and consecutive refresh cycles will initialise any dynamic RAM, using the new memory configuration. If the memory configuration does not enable refresh of dynamic RAM the refresh cycles will be replaced by an equivalent delay with no external memory activity.

If **BootFromROM** is high bootstrapping will then take place immediately, using data from external memory; otherwise the transputer will await an input from any link. The processor will be in the low priority state.

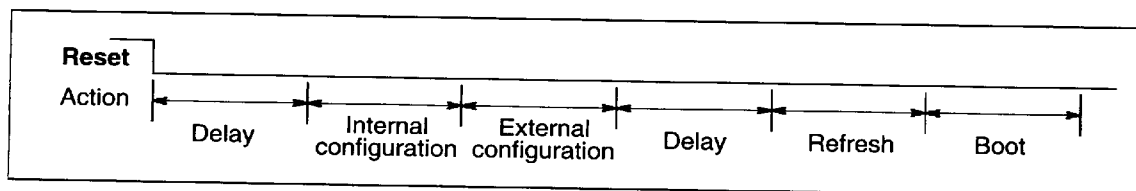


Figure 3.3 IMS T400 post-reset sequence

### 3.8 Analyse

If **Analyse** is taken high when the transputer is running, the transputer will halt at the next descheduling point (page 64). From **Analyse** being asserted, the processor will halt within three time slice periods plus the time taken for any high priority process to complete. As much of the transputer status is maintained as is necessary to permit analysis of the halted machine.

Processor flags **Error**, **HaltOnError** and **EnableJ0Break** are normally cleared at reset on the IMS T400; however, if **Analyse** is asserted the flags are not altered. Memory refresh continues.

Input links will continue with outstanding transfers. Output links will not make another access to memory for data but will transmit only those bytes already in the link buffer. Providing there is no delay in link acknowledgement, the links should be inactive within a few microseconds of the transputer halting.

**Reset** should not be asserted before the transputer has halted and link transfers have ceased. When **Reset** is taken low whilst **Analyse** is high, neither the memory configuration sequence nor the block of eight refresh cycles will occur; the previous memory configuration will be used for any external memory accesses. If **BootFromROM** is high the transputer will bootstrap as soon as **Analyse** is taken low, otherwise it will await a control byte on any link. If **Analyse** is taken low without **Reset** going high the transputer state and operation are undefined. After the end of a valid **Analyse** sequence the registers have the values given in table 3.3.

|          |                                                                                                                                                           |
|----------|-----------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>I</b> | <b>MemStart</b> if bootstrapping from a link, or the external memory bootstrap address if bootstrapping from ROM.                                         |
| <b>W</b> | <b>MemStart</b> if bootstrapping from ROM, or the address of the first free word after the bootstrap program if bootstrapping from link.                  |
| <b>A</b> | The value of <b>I</b> when the processor halted.                                                                                                          |
| <b>B</b> | The value of <b>W</b> when the processor halted, together with the priority of the process when the transputer was halted (i.e. the <b>W</b> descriptor). |
| <b>C</b> | The ID of the bootstrapping link if bootstrapping from link.                                                                                              |

Table 3.3 Register values after Analyse

| Symbol | Parameter                                      | T400-20 |     |     | Units   | Notes |
|--------|------------------------------------------------|---------|-----|-----|---------|-------|
|        |                                                | Min     | Nom | Max |         |       |
| TPVRH  | Power valid before <b>Reset</b>                | 10      |     |     | ms      |       |
| TRHRL  | <b>Reset</b> pulse width high                  | 8       |     |     | ClockIn | 1     |
| TDCVRL | <b>ClockIn</b> running before <b>Reset</b> end | 10      |     |     | ms      | 2     |
| TAHRH  | <b>Analyse</b> setup before <b>Reset</b>       | 3       |     |     | ms      |       |
| TRLAL  | <b>Analyse</b> hold after <b>Reset</b> end     | 1       |     |     | ClockIn | 1     |
| TBRVRL | <b>BootFromROM</b> setup                       | 0       |     |     | ms      |       |
| TRLBRX | <b>BootFromROM</b> hold after <b>Reset</b>     | 50      |     |     | ms      | 3     |
| TALBRX | <b>BootFromROM</b> hold after <b>Analyse</b>   | 50      |     |     | ms      | 3     |

#### Notes

- 1 Full periods of **ClockIn** **TDCLDCL** required.
- 2 At power-on reset.
- 3 Must be stable until after end of bootstrap period. See Bootstrap section 3.5.

Table 3.4 **Reset** , **Analyse** and **BootFromROM** timing

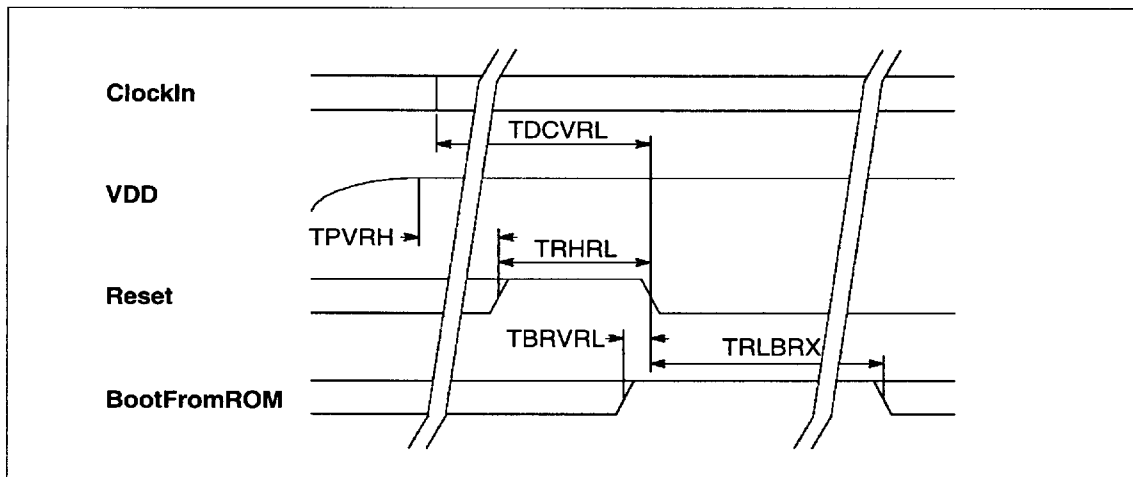


Figure 3.4 Transputer **Reset** timing with **Analyse** low

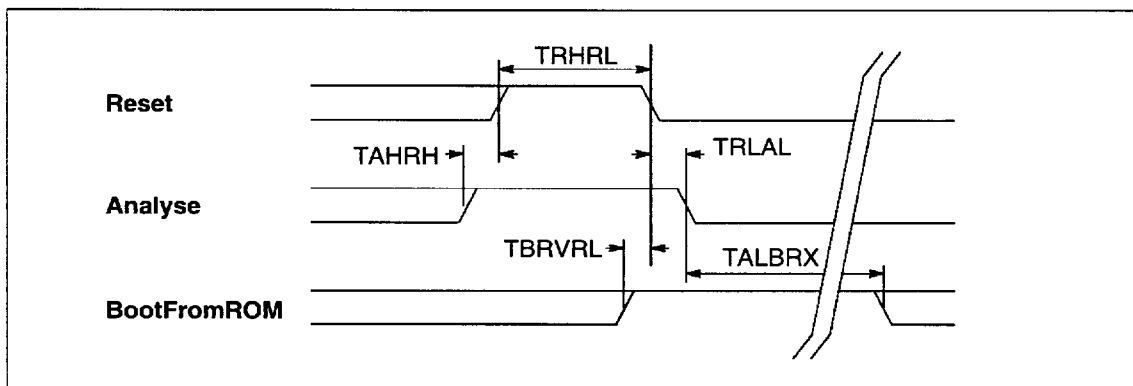


Figure 3.5 Transputer **Reset**, **Analyse** and **BootFromROM** timing

### 3.9 Error, ErrorIn

The **Error** pin carries the OR'ed output of the internal *Error* flag and the **ErrorIn** input. If **Error** is high it indicates either that **ErrorIn** is high or that an error was detected in one of the processes. An internal error can be caused, for example, by arithmetic overflow, divide by zero, array bounds violation or software setting the flag directly. Once set, the *Error* flag is only cleared by executing the instruction *testerr*. The error is not cleared by processor reset, in order that analysis can identify any errant transputer (page 9).

A process can be programmed to stop if the *Error* flag is set; it cannot then transmit erroneous data to other processes, but processes which do not require that data can still be scheduled. Eventually all processes which rely, directly or indirectly, on data from the process in error will stop through lack of data. **ErrorIn** does not directly affect the status of a processor in any way.

By setting the *HaltOnError* flag the transputer itself can be programmed to halt if *Error* becomes set. If *Error* becomes set after *HaltOnError* has been set, all processes on that transputer will cease but will not necessarily cause other transputers in a network to halt. Setting *HaltOnError* after *Error* will not cause the transputer to halt; this allows the processor reset and analyse facilities to function with the flags in indeterminate states.

An alternative method of error handling is to have the errant process or transputer cause all transputers to halt. This can be done by 'daisy-chaining' the **ErrorIn** and **Error** pins of a number of processors and applying the final **Error** output signal to the **EventReq** pin of a suitably programmed master transputer. Since the process state is preserved when stopped by an error, the master transputer can then use the analyse function to debug the fault. When using such a circuit, note that the *Error* flag is in an indeterminate state on power up; the circuit and software should be designed with this in mind.

Error checks can be removed completely to optimise the performance of a proven program; any unexpected error then occurring will have an arbitrary undefined effect.

If a high priority process pre-empt a low priority one, status of the *Error* and *HaltOnError* flags is saved for the duration of the high priority process and restored at the conclusion of it. Status of both flags is transmitted to the high priority process. Either flag can be altered in the process without upsetting the error status of any complex operation being carried out by the pre-empted low priority process.

In the event of a transputer halting because of *HaltOnError*, the links will finish outstanding transfers before shutting down. If **Analyse** is asserted then all inputs continue but outputs will not make another access to memory for data. Memory refresh will continue to take place.

After halting due to the *Error* flag changing from 0 to 1 whilst *HaltOnError* is set, register **I** points two bytes past the instruction which set *Error*. After halting due to the **Analyse** pin being taken high, register **I** points one byte past the instruction being executed. In both cases **I** will be copied to register **A**.

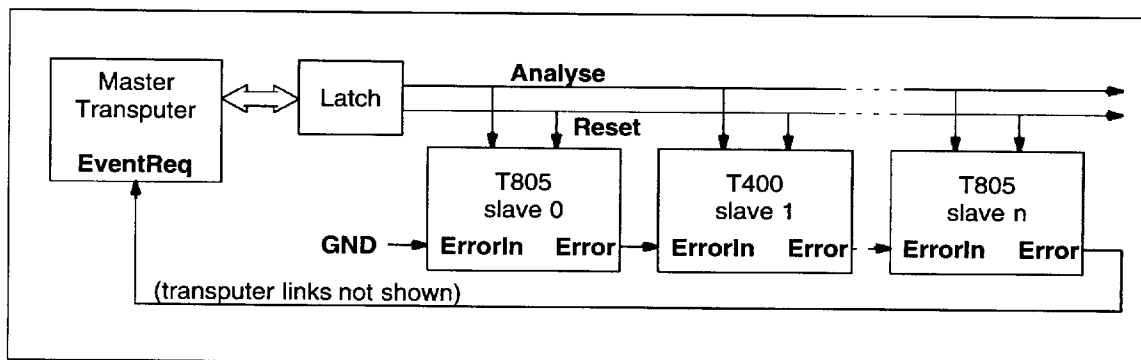


Figure 3.6 Error handling in a multi-transputer system

## 4 Memory

The IMS T400 has 2 Kbytes of fast internal static memory for high rates of data throughput. Each internal memory access takes one processor cycle **ProcClockOut** (page 16). The transputer can also access 4 Gbytes of external memory space. Internal and external memory are part of the same linear address space. Internal RAM can be disabled by holding **DisableIntRAM** high. All internal addresses are then mapped to external RAM. This pin should not be altered after **Reset** has been taken low.

IMS T400 memory is byte addressed, with words aligned on four-byte boundaries. The least significant byte of a word is the lowest addressed byte.

The bits in a byte are numbered 0 to 7, with bit 0 the least significant. The bytes are numbered from 0, with byte 0 the least significant. In general, wherever a value is treated as a number of component values, the components are numbered in order of increasing numerical significance, with the least significant component numbered 0. Where values are stored in memory, the least significant component value is stored at the lowest (most negative) address.

Internal memory starts at the most negative address #80000000 and extends to #800007FF. User memory begins at #80000070; this location is given the name *MemStart*. An instruction *ldmemstartval* is provided to obtain the value of **MemStart**.

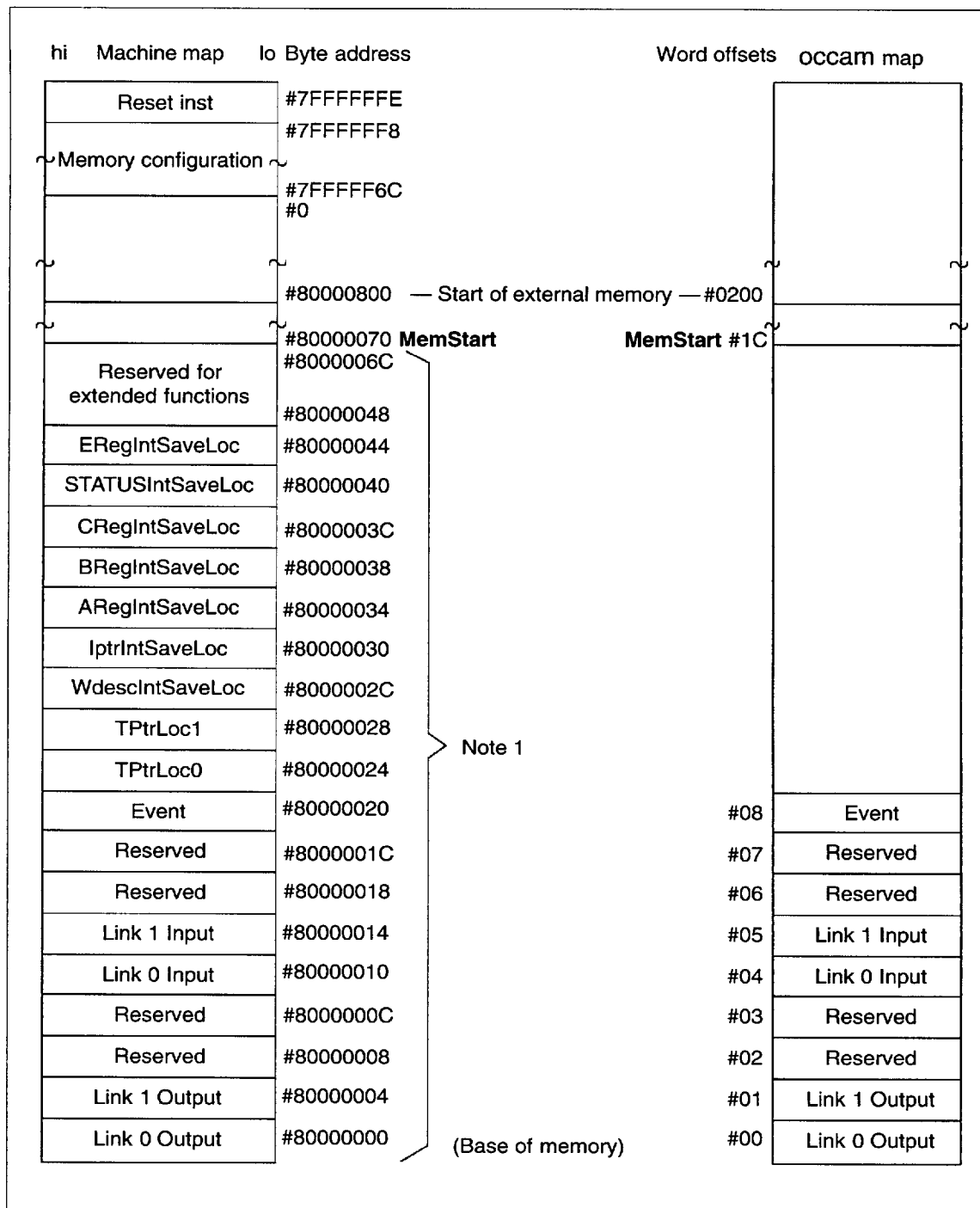
The context of a process in the transputer model involves a workspace descriptor ( **WPtr**) and an instruction pointer ( **IPtr**). **WPtr** is a word address pointer to a workspace in memory. **IPtr** points to the next instruction to be executed for the process which is the currently executing process. The context switch performed by the breakpoint instruction swaps the **WPtr** and **IPtr** of the currently executing process with the **WPtr** and **IPtr** held above **MemStart**. Two contexts are held above **MemStart**, one for high priority and one for low priority; this allows processes at both levels to have breakpoints. Note that on bootstrapping from a link, these contexts are overwritten by the loaded code. If this is not acceptable, the values should be peeked from memory before bootstrapping from a link.

The reserved area of internal memory below **MemStart** is used to implement link and event channels.

Two words of memory are reserved for timer use, *TPtrLoc0* for high priority processes and *TPtrLoc1* for low priority processes. They either indicate the relevant priority timer is not in use or point to the first process on the timer queue at that priority level.

Values of certain processor registers for the current low priority process are saved in the reserved *IntSaveLoc* locations when a high priority process pre-empts a low priority one. Other locations are reserved for extended features such as block moves.

External memory space starts at #80000800 and extends up through #00000000 to #7FFFFFFF. Memory configuration data and ROM bootstrapping code must be in the most positive address space, starting at #7FFFFFF6C and #7FFFFFFE respectively. Address space immediately below this is conventionally used for ROM based code.



## Notes

- 1 These locations are used as auxiliary processor registers and should not be manipulated by the user. Like processor registers, their contents may be useful for implementing debugging tools (**Analyse**, page 9). For details see *Transputer Instruction Set – A Compiler Writers' Guide*.

Figure 4.1 IMS T400 memory map

## 5 External memory interface

The External Memory Interface (EMI) allows access to a 32 bit address space, supporting dynamic and static RAM as well as ROM and EPROM. EMI timing can be configured at **Reset** to cater for most memory types and speeds, and a program is supplied with the Transputer Development System to aid in this configuration.

There are 17 internal configurations which can be selected by a single pin connection (page 31). If none are suitable the user can configure the interface to specific requirements, as shown in page 33.

The external memory cycle is divided into six **Tstates** with the following functions:

- T1** Address setup time before address valid strobe.
- T2** Address hold time after address valid strobe.
- T3** Read cycle tristate or write cycle data setup.
- T4** Extendable data setup time.
- T5** Read or write data.
- T6** Data hold.

Under normal conditions each **Tstate** may be from one to four periods **Tm** long, the duration being set during memory configuration. The default condition on **Reset** is that all **Tstates** are the maximum four periods **Tm** long to allow external initialisation cycles to read slow ROM.

Period **T4** can be extended indefinitely by adding externally generated wait states.

An external memory cycle is always an even number of periods **Tm** in length and the start of **T1** always coincides with a rising edge of **ProcClockOut**. If the total configured quantity of periods **Tm** is an odd number, one extra period **Tm** will be added at the end of **T6** to force the start of the next **T1** to coincide with a rising edge of **ProcClockOut**. This period is designated **E** in configuration diagrams (figure 5.19).

During an internal memory access cycle the external memory interface bus **MemAD2-31** reflects the word address used to access internal RAM, **MemnotWrD0** reflects the read/write operation and **MemnotRfD1** is high; all control strobes are inactive. This is true unless and until a memory refresh cycle or DMA (memory request) activity takes place, when the bus will carry the appropriate external address or data.

The bus activity is not adequate to trace the internal operation of the transputer in full, but may be used for hardware debugging in conjunction with peek and poke (page 8).

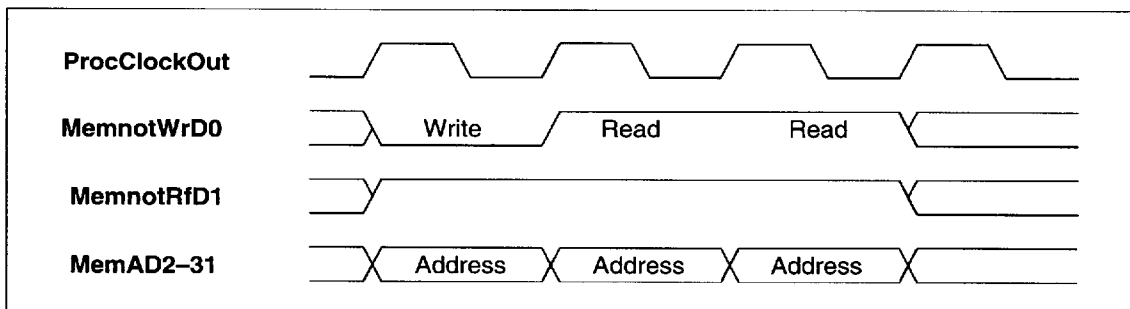


Figure 5.1 IMS T400 bus activity for internal memory cycle

### 5.1 Pin functions

#### 5.1.1 MemAD2-31

External memory addresses and data are multiplexed on one bus. Only the top 30 bits of address are output on the external memory interface, using pins **MemAD2-31**. They are normally output only during **Tstates T1** and **T2**, and should be latched during this time. The data bus is 32 bits wide. It uses **MemAD2-31** for the top 30 bits and **MemnotRfD1** and **MemnotWrD0** for the lower two bits.

#### 5.1.2 notMemRd

For a read cycle the read strobe **notMemRd** is low during **T4** and **T5**. Data is read by the transputer on the rising edge of this strobe, and may be removed immediately afterward. If the strobe duration is insufficient it may be extended by adding extra periods **Tm** to either or both of the **Tstates T4** and **T5**. Further extension may be obtained by inserting wait states at the end of **T4**.

#### 5.1.3 MemnotWrD0

During **T1** and **T2** this pin will be low if the cycle is a write cycle, otherwise it will be high. During **Tstates T3** to **T6** it becomes bit 0 of the data bus. In both cases it follows the general timing of **MemAD2-31**.

#### 5.1.4 notMemWrB0-3

Because the transputer uses word addressing, four write strobes are provided; one to write each byte of the word. **notMemWrB0** addresses the least significant byte.

#### 5.1.5 notMemS0-4

To facilitate control of different types of memory and devices, the EMI is provided with five strobe outputs, four of which can be configured by the user. The strobes are conventionally assigned the functions shown in the read and write cycle diagrams, although there is no compulsion to retain these designations.

#### 5.1.6 MemWait

Wait states can be selected by taking **MemWait** high. Externally generated wait states can be added to extend the duration of **T4** indefinitely.

#### 5.1.7 MemnotRfD1

During **T1** and **T2**, this pin is low if the address on **MemAD2-31** is a refresh address, otherwise it is high. During **Tstates T3** to **T6** it becomes bit 1 of the data bus. In both cases it follows the general timing of **MemAD2-31**.

#### 5.1.8 notMemRf

The IMS T400 can be operated with memory refresh enabled or disabled. The selection is made during memory configuration, when the refresh interval is also determined.

#### 5.1.9 RefreshPending

When high, this pin signals that a refresh cycle is pending.

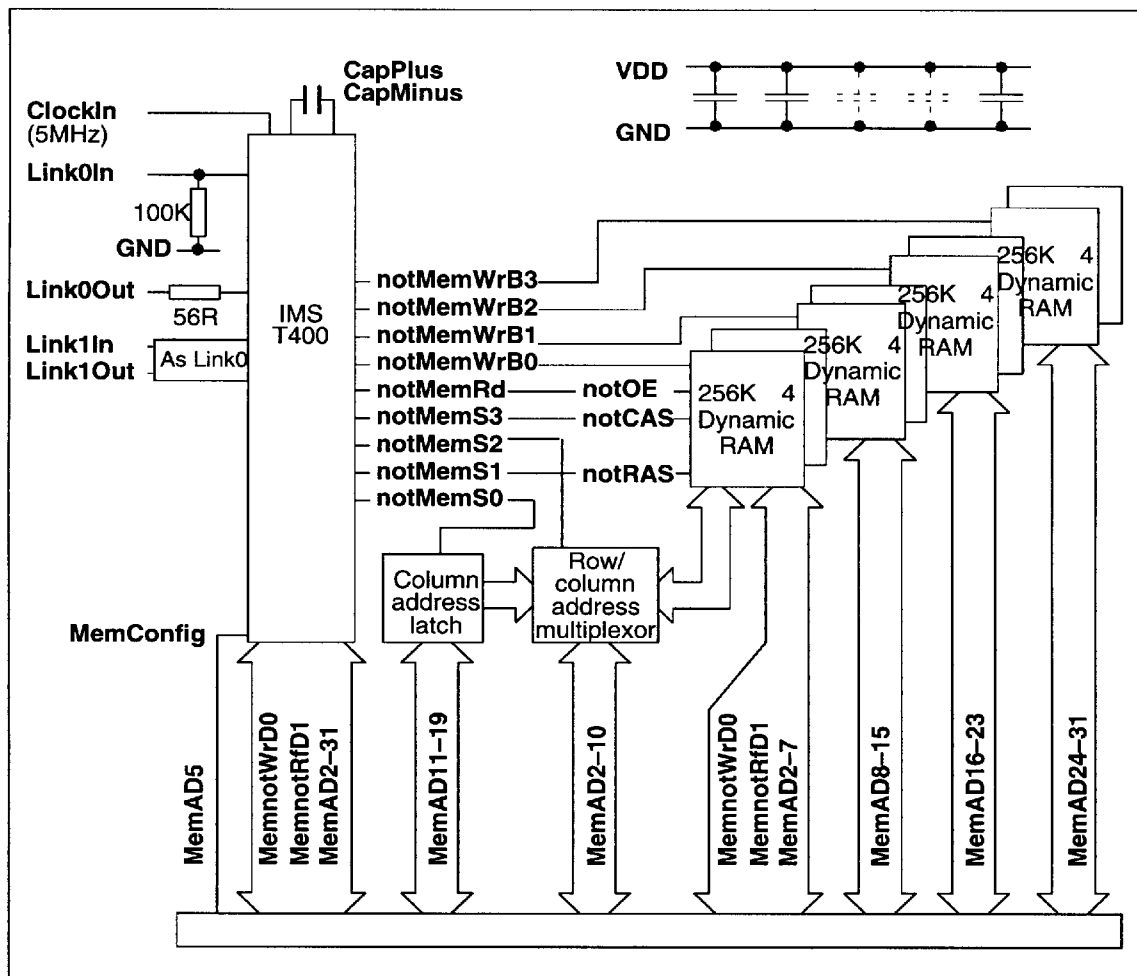


Figure 5.2 IMS T400 dynamic RAM application

#### 5.1.10 MemReq, MemGranted

Direct memory access (DMA) can be requested at any time by driving the asynchronous **MemReq** input high. **MemGranted** follows the timing of the bus being tristated and can be used to signal to the device requesting the DMA that it has control of the bus. Note that **MemGranted** changes on the falling edge of **ProcClockOut** and can therefore be sampled to establish control of the bus on the rising edge of **ProcClockOut**.

#### 5.1.11 MemConfig

**MemConfig** is an input pin used to read configuration data when setting external memory interface (EMI) characteristics.

#### 5.1.12 ProcClockOut

This clock is derived from the internal processor clock, which is in turn derived from **ClockIn**. Its period is equal to one internal microcode cycle time, and can be derived from the formula

$$TPCLPCL = TDCLDCL / PLLx$$

where **TPCLPCL** is the **ProcClockOut Period**, **TDCLDCL** is the **ClockIn Period** and **PLLx** is the phase lock loop factor for the relevant speed part, obtained from the ordering details (Ordering section).



## 5 External memory interface

The time value **T<sub>m</sub>** is used to define the duration of **T<sub>states</sub>** and, hence, the length of external memory cycles; its value is exactly half the period of one **ProcClockOut** cycle ( $0.5 \cdot \text{TPCLPCL}$ ), regardless of mark/space ratio of **ProcClockOut**.

Edges of the various external memory strobes coincide with rising or falling edges of **ProcClockOut**. It should be noted, however, that there is a skew associated with each coincidence. The value of skew depends on whether coincidence occurs when the **ProcClockOut** edge and strobe edge are both rising, when both are falling or if either is rising when the other is falling. Timing values given in the strobe tables show the best and worst cases. If a more accurate timing relationship is required, the exact **T<sub>state</sub>** timing and strobe edge to **ProcClockOut** relationships should be calculated and the correct skew factors applied from the edge skew timing table 5.4.

| Symbol         | Parameter                            | T400-20 |      | Units | Notes |
|----------------|--------------------------------------|---------|------|-------|-------|
|                |                                      | Min     | Max  |       |       |
| TPCLPCL        | <b>ProcClockOut</b> period           | 48      | 52   | ns    |       |
| TPCHPCL        | <b>ProcClockOut</b> pulse width high | 13.5    | 28.5 | ns    |       |
| TPCLPCH        | <b>ProcClockOut</b> pulse width low  | a       |      | ns    | 2,3   |
| T <sub>m</sub> | <b>ProcClockOut</b> half cycle       | 24      | 26   | ns    |       |
| TPCstab        | <b>ProcClockOut</b> stability        |         | 8    | %     | 1     |

### Notes

- 1 Stability is the variation of cycle periods between two consecutive cycles, measured at corresponding points on the cycles.
- 2 a is  $\text{TPCLPCL} - \text{TPCHPCL}$ .
- 3 This is a nominal value.

Table 5.1 **ProcClockOut**

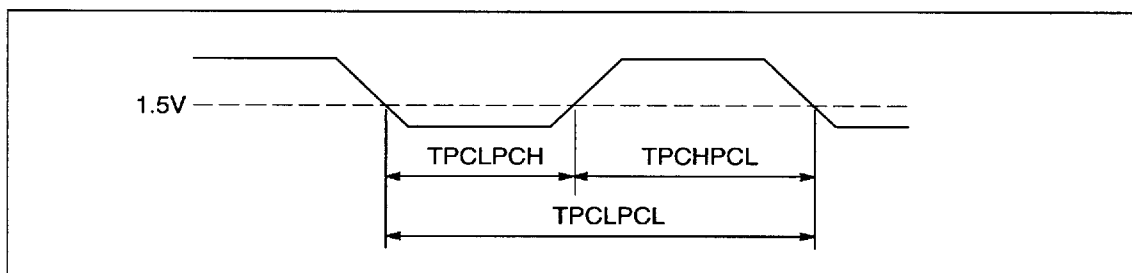


Figure 5.3 IMS T400 **ProcClockOut** timing

## 5.2 Read cycle

Byte addressing is carried out internally by the transputer for read cycles. For a read cycle the read strobe **notMemRd** is low during **T4** and **T5**. Read cycle data may be set up on the data bus at any time after the start of **T3**, but must be valid when the transputer reads it at the end of **T5**. Data may be removed any time during **T6**, but must be off the bus no later than the end of that period.

**notMemS0** is a fixed format strobe. Its leading edge is always coincident with the start of **T2** and its trailing edge always coincident with the end of **T5**.

The leading edge of **notMemS1** is always coincident with the start of **T2**, but its duration may be configured to be from zero to 31 periods **Tm**. Regardless of the configured duration, the strobe will terminate no later than the end of **T6**. The strobe is sometimes programmed to extend beyond the normal end of **Tmx**. When wait states are inserted into an EMI cycle the end of **Tmx** is delayed, but the potential active duration of the strobe is not altered. Thus the strobe can be configured to terminate relatively early under certain conditions (page 24). If **notMemS1** is configured to be zero it will never go low.

**notMemS2**, **notMemS3** and **notMemS4** are identical in operation. They all terminate at the end of **T5**, but the start of each can be delayed from one to 31 periods **Tm** beyond the start of **T2**. If the duration of one of these strobes would take it past the end of **T5** it will stay high. This can be used to cause a strobe to become active only when wait states are inserted. If one of these strobes is configured to zero it will remain low during **T1–T5** and only go high during the first **Tm** of **T6**. Figure 5.6 shows the effect of **Wait** on strobes in more detail; each division on the scale is one period **Tm**.

In the read cycle timing diagrams **ProcClockOut** is included as a guide only; it is shown with each **Tstate** configured to one period **Tm**.

| Symbol  | Parameter                               | T400-20 |     | Units | Notes |
|---------|-----------------------------------------|---------|-----|-------|-------|
|         |                                         | Min     | Max |       |       |
| TaZdV   | Address tristate to data valid          | 0       |     | ns    |       |
| TdVRdH  | Data setup before read                  | 25      |     | ns    |       |
| TRdHdX  | Data hold after read                    | 0       |     | ns    |       |
| TS0LRdL | <b>notMemS0</b> before start of read    | a-4     | a+4 | ns    | 1     |
| TS0HRdH | End of read from end of <b>notMemS0</b> | -4      | 4   | ns    |       |
| TRdLRdH | Read period                             | b-3     | b+5 | ns    | 2     |

### Notes

- 1 **a** is total of **T2+T3** where **T2**, **T3** can be from one to four periods **Tm** each in length.
- 2 **b** is total of **T4+Twait+T5** where **T4**, **T5** can be from one to four periods **Tm** each in length and **Twait** may be any number of periods **Tm** in length.

Table 5.2 Read

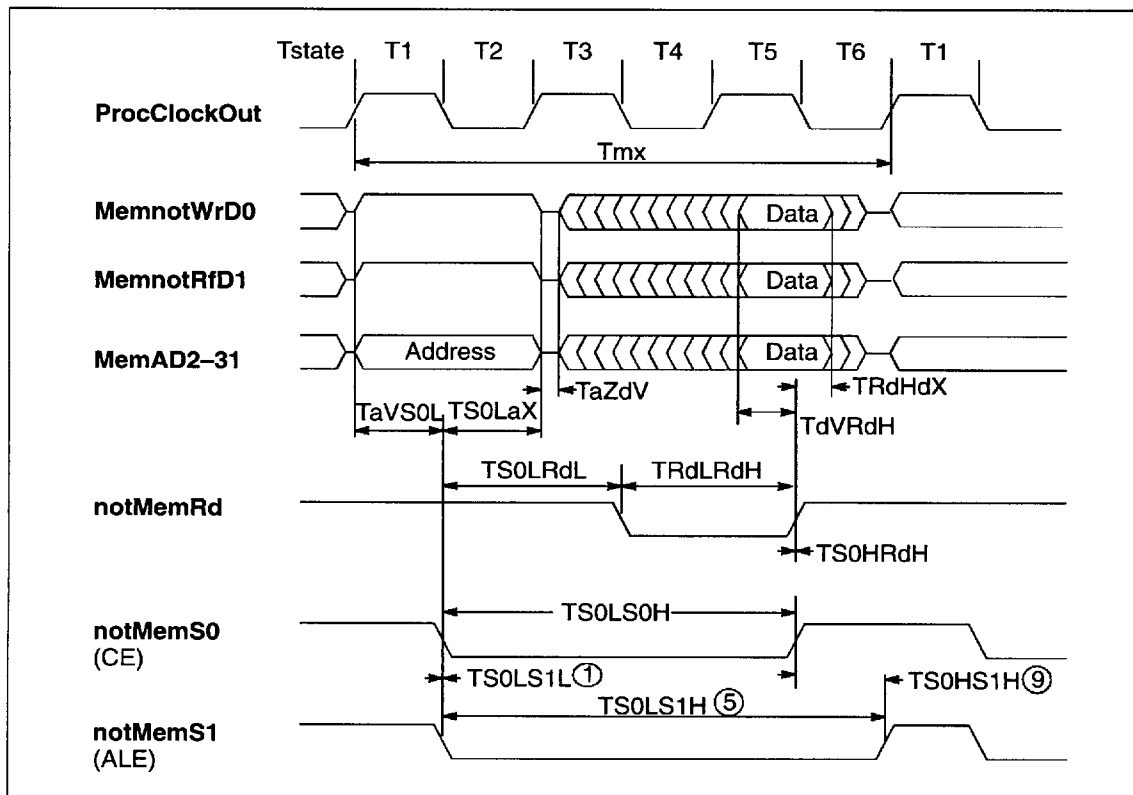


Figure 5.4 IMS T400 external read cycle: static memory

| Symbol  | n  | Parameter                                     | T400-20     |             | Units | Notes |
|---------|----|-----------------------------------------------|-------------|-------------|-------|-------|
|         |    |                                               | Min         | Max         |       |       |
| TaVS0L  |    | Address setup before <b>notMemS0</b>          | <b>a</b> -8 |             | ns    | 1     |
| TS0LaX  |    | Address hold after <b>notMemS0</b>            | <b>b</b> -8 | <b>b</b> +8 | ns    | 2     |
| TS0LS0H |    | <b>notMemS0</b> pulse width low               | <b>c</b> -5 | <b>c</b> +6 | ns    | 3     |
| TS0LS1L | 1  | <b>notMemS1</b> from <b>notMemS0</b>          | -4          | 4           | ns    |       |
| TS0LS1H | 5  | <b>notMemS1</b> end from <b>notMemS0</b>      | <b>d</b> -3 | <b>d</b> +7 | ns    | 4,6   |
| TS0HS1H | 9  | <b>notMemS1</b> end from <b>notMemS0</b> end  | <b>e</b> -8 | <b>e</b> +4 | ns    | 5,6   |
| TS0LS2L | 2  | <b>notMemS2</b> delayed after <b>notMemS0</b> | <b>f</b> -6 | <b>f</b> +5 | ns    | 7     |
| TS0LS2H | 6  | <b>notMemS2</b> end from <b>notMemS0</b>      | <b>c</b> -5 | <b>c</b> +7 | ns    | 3     |
| TS0HS2H | 10 | <b>notMemS2</b> end from <b>notMemS0</b> end  | -4          | 7           | ns    |       |
| TS0LS3L | 3  | <b>notMemS3</b> delayed after <b>notMemS0</b> | <b>f</b> -6 | <b>f</b> +5 | ns    | 7     |
| TS0LS3H | 7  | <b>notMemS3</b> end from <b>notMemS0</b>      | <b>c</b> -5 | <b>c</b> +7 | ns    | 3     |
| TS0HS3H | 11 | <b>notMemS3</b> end from <b>notMemS0</b> end  | -4          | 7           | ns    |       |
| TS0LS4L | 4  | <b>notMemS4</b> delayed after <b>notMemS0</b> | <b>f</b> -6 | <b>f</b> +5 | ns    | 7     |
| TS0LS4H | 8  | <b>notMemS4</b> end from <b>notMemS0</b>      | <b>c</b> -5 | <b>c</b> +7 | ns    | 3     |
| TS0HS4H | 12 | <b>notMemS4</b> end from <b>notMemS0</b> end  | -4          | 7           | ns    |       |
| Tmx     |    | Complete external memory cycle                |             |             |       | 8     |

## Notes

- 1 **a** is **T1** where **T1** can be from one to four periods **Tm** in length.
- 2 **b** is **T2** where **T2** can be from one to four periods **Tm** in length.
- 3 **c** is total of **T2+T3+T4+Twait+T5** where **T2, T3, T4, T5** can be from one to four periods **Tm** each in length and **Twait** may be any number of periods **Tm** in length.
- 4 **d** can be from zero to 31 periods **Tm** in length.
- 5 **e** can be from -27 to +4 periods **Tm** in length.
- 6 If the configuration would cause the strobe to remain active past the end of **T6** it will go high at the end of **T6**. If the strobe is configured to zero periods **Tm** it will remain high throughout the complete cycle **Tmx**.
- 7 **f** can be from zero to 31 periods **Tm** in length. If this length would cause the strobe to remain active past the end of **T5** it will go high at the end of **T5**. If the strobe value is zero periods **Tm** it will remain low throughout **T1** to **T5** and only go high during the first **Tm** of **T6**.
- 8 **Tmx** is one complete external memory cycle comprising the total of **T1+T2+T3+T4+Twait+T5+T6** where **T1, T2, T3, T4, T5** can be from one to four periods **Tm** each in length, **T6** can be from one to five periods **Tm** in length and **Twait** may be zero or any number of periods **Tm** in length.

Table 5.3 IMS T400 strobe timing

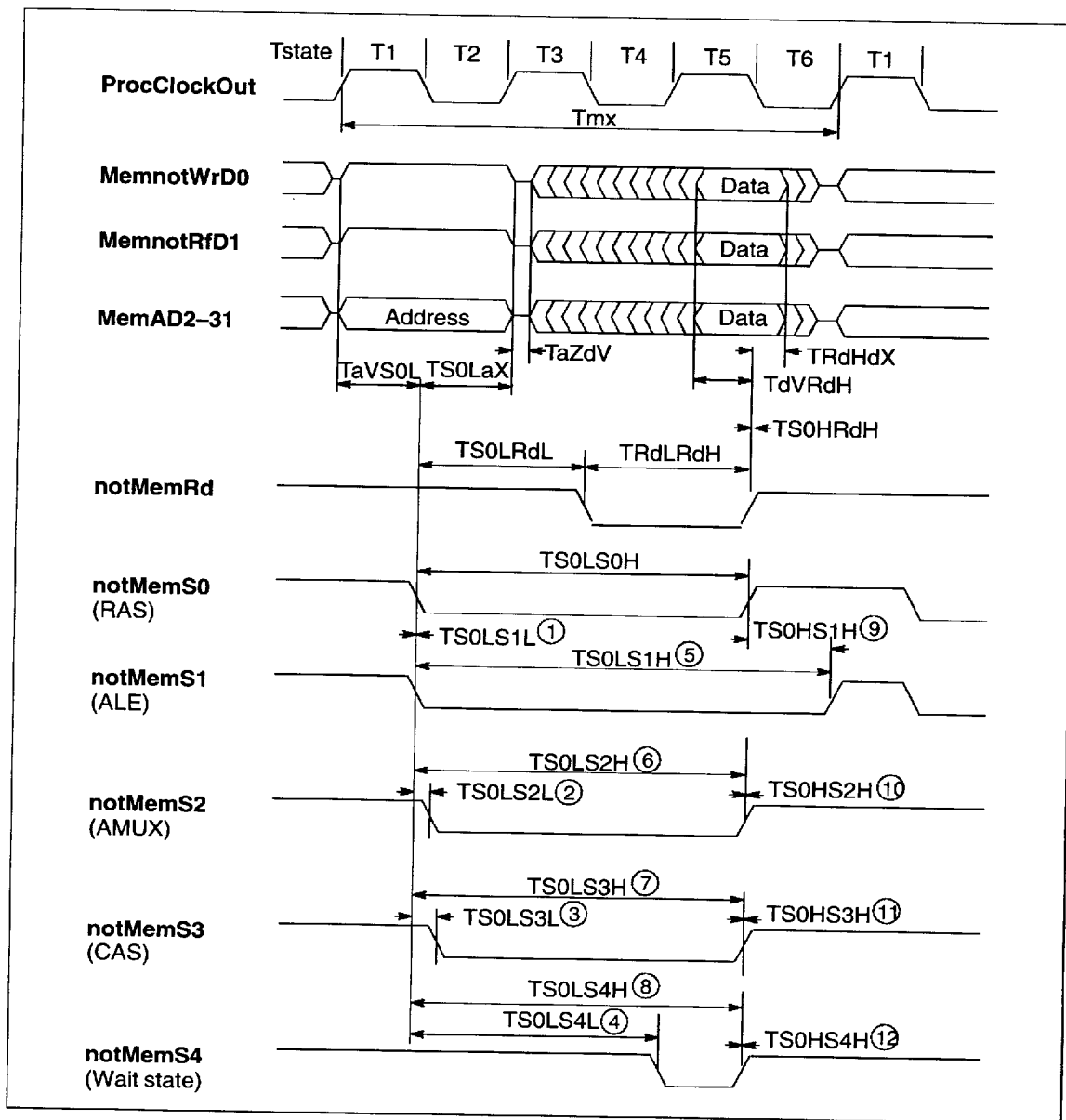


Figure 5.5 IMS T400 external read cycle: dynamic memory

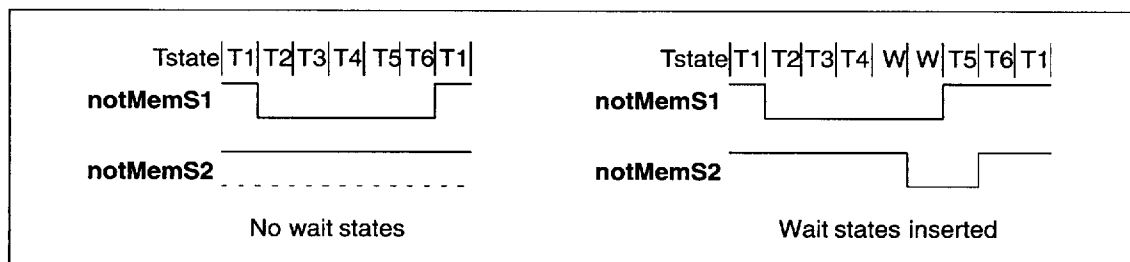
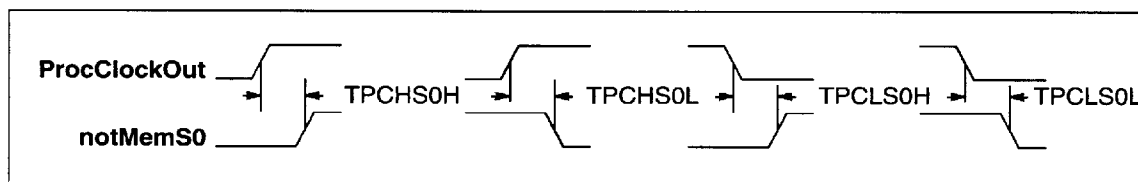


Figure 5.6 IMS T400 effect of wait states on strobes

| Symbol  | Parameter                                                | T400-20 |     | Units |
|---------|----------------------------------------------------------|---------|-----|-------|
|         |                                                          | Min     | Max |       |
| TPCHS0H | <b>notMemS0</b> rising from <b>ProcClockOut</b> rising   | -6      | 4   | ns    |
| TPCLS0H | <b>notMemS0</b> rising from <b>ProcClockOut</b> falling  | -5      | 10  | ns    |
| TPCHS0L | <b>notMemS0</b> falling from <b>ProcClockOut</b> rising  | -8      | 3   | ns    |
| TPCLS0L | <b>notMemS0</b> falling from <b>ProcClockOut</b> falling | -5      | 7   | ns    |

Table 5.4 Strobe S0 to **ProcClockOut** skewFigure 5.7 IMS T400 skew of **notMemS0** to **ProcClockOut**

### 5.3 Write cycle

For write cycles the relevant bytes in memory are addressed by the write strobes **notMemWrB0-3**. If a particular byte is not to be written, then the corresponding data outputs are tristated.

For a write cycle pin **MemnotWrD0** will be low during **T1** and **T2**. Write data is placed on the bus at the start of **T3** and removed at the end of **T6**. If **T6** is extended to force the next cycle **Tmx** (page 15) to start on a rising edge of **ProcClockOut**, data will be valid during this time also.

The transputer has both early and late write cycle modes. For a late write cycle the relevant write strobes **notMemWrB0-3** are low during **T4** and **T5**; for an early write they are also low during **T3**. Data should be latched into memory on the rising edge of the strobes in both cases, although it is valid until the end of **T6**. If the strobe duration is insufficient, it may be extended at configuration time by adding extra periods **Tm** to either or both of **Tstates T4** and **T5** for both early and late modes. For an early cycle they may also be added to **T3**. Further extension may be obtained by inserting wait states at the end of **T4**. If the data hold time is insufficient, extra periods **Tm** may be added to **T6** to extend it.

In the write cycle timing diagram **ProcClockOut** is included as a guide only; it is shown with each **Tstate** configured to one period **Tm**. The strobe is inactive during internal memory cycles.

| Symbol  | Parameter                                   | T400-20 |      | Units | Notes |
|---------|---------------------------------------------|---------|------|-------|-------|
|         |                                             | Min     | Max  |       |       |
| TdVWrH  | Data setup before write                     | d-7     | d+10 | ns    | 1,5   |
| TWrHdX  | Data hold after write                       | a-10    | a+5  | ns    | 1,2   |
| TSOLWrL | <b>notMemS0</b> before start of early write | b-5     | b+5  | ns    | 1,3   |
|         | <b>notMemS0</b> before start of late write  | c-5     | c+5  | ns    | 1,4   |
| TSOHWrH | End of write from end of <b>notMemS0</b>    | -5      | 4    | ns    | 1     |
| TWrLWrH | Early write pulse width                     | d-4     | d+7  | ns    | 1,5   |
|         | Late write pulse width                      | e-4     | e+7  | ns    | 1,6   |

#### Notes

- 1 Timing is for all write strobes **notMemWrB0-3**.
- 2 **a** is **T6** where **T6** can be from one to five periods **Tm** in length.
- 3 **b** is **T2** where **T2** can be from one to four periods **Tm** in length.
- 4 **c** is total of **T2+T3** where **T2**, **T3** can be from one to four periods **Tm** each in length.
- 5 **d** is total of **T3+T4+Twait+T5** where **T3**, **T4**, **T5** can be from one to four periods **Tm** each in length and **Twait** may be zero or any number of periods **Tm** in length.
- 6 **e** is total of **T4+Twait+T5** where **T4**, **T5** can be from one to four periods **Tm** each in length and **Twait** may be zero or any number of periods **Tm** in length.

Table 5.5 Write

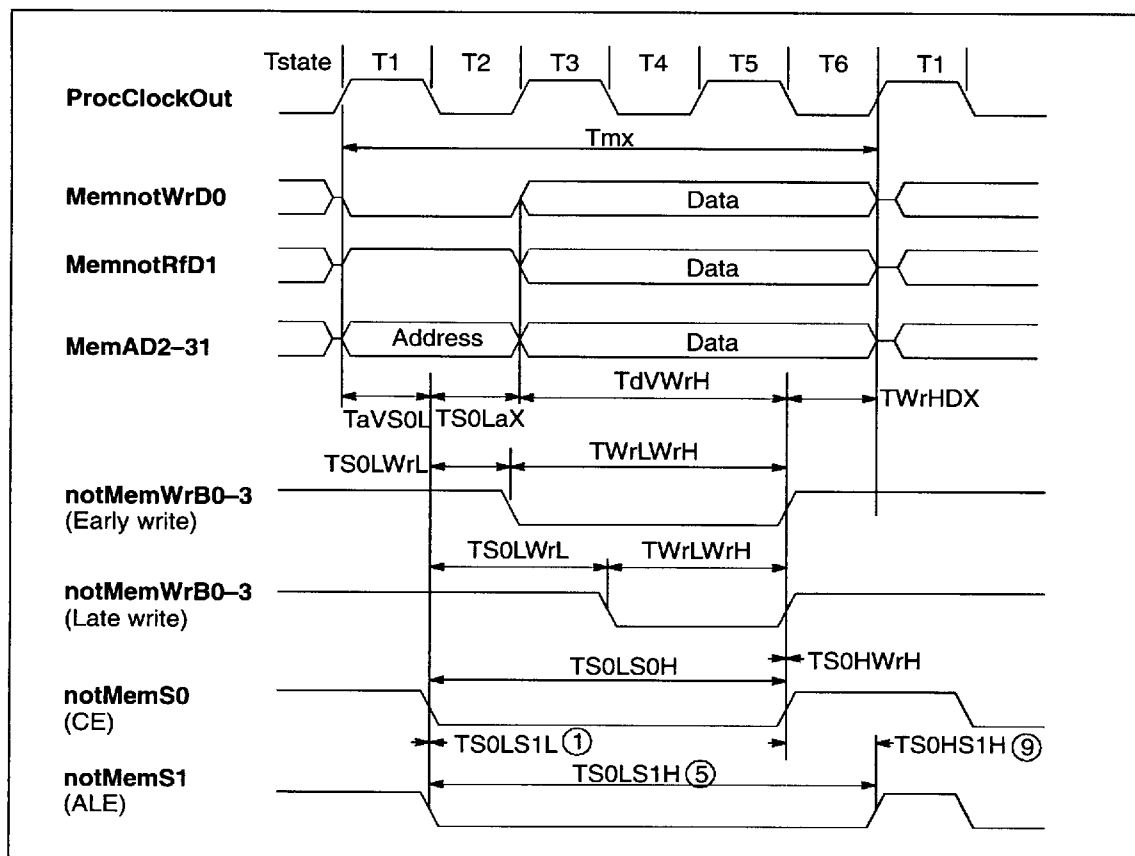


Figure 5.8 IMS T400 external write cycle

## 5.4 Wait

Taking **MemWait** high with the timing shown (figure 5.9) will extend the duration of **T4**. **MemWait** is sampled close to the falling edge of **ProcClockOut** during a **T3** or **T4** period, prior to, but not at the end of **T4**. By convention, **notMemS4** is used to synchronize wait state insertion. If this or another strobe is used, its delay should be such as to take the strobe low an even number of periods **Tm** after the start of **T1**, to coincide with a rising edge of **ProcClockOut**.

**MemWait** may be kept high indefinitely, although if dynamic memory refresh is used it should not be kept high long enough to interfere with refresh timing. **MemWait** operates normally during all cycles, including refresh and configuration cycles. It does not affect internal memory access in any way.

If the start of **T5** would coincide with a falling edge of **ProcClockOut** an extra wait period **Tm (EW)** is generated by the EMI to force coincidence with a rising edge. Rising edge coincidence is only forced if wait states are added, otherwise coincidence with a falling edge is permitted.



## 5 External memory interface

| Symbol  | Parameter                         | IMS T400-20 |     | Units | Notes |
|---------|-----------------------------------|-------------|-----|-------|-------|
|         |                                   | Min         | Max |       |       |
| TPCLWtH | Wait setup                        | 10          |     | ns    | 1,2   |
| TPCLWtL | Wait hold                         | 8           |     | ns    | 1,2   |
| TWtLWtH | Delay before re-assertion of Wait | 50          |     | ns    |       |

### Notes

- 1 **ProcClockOut** load should not exceed 50pf.
- 2 If wait period exceeds refresh interval, refresh cycles will be lost.

Table 5.6 IMS T400 memory wait

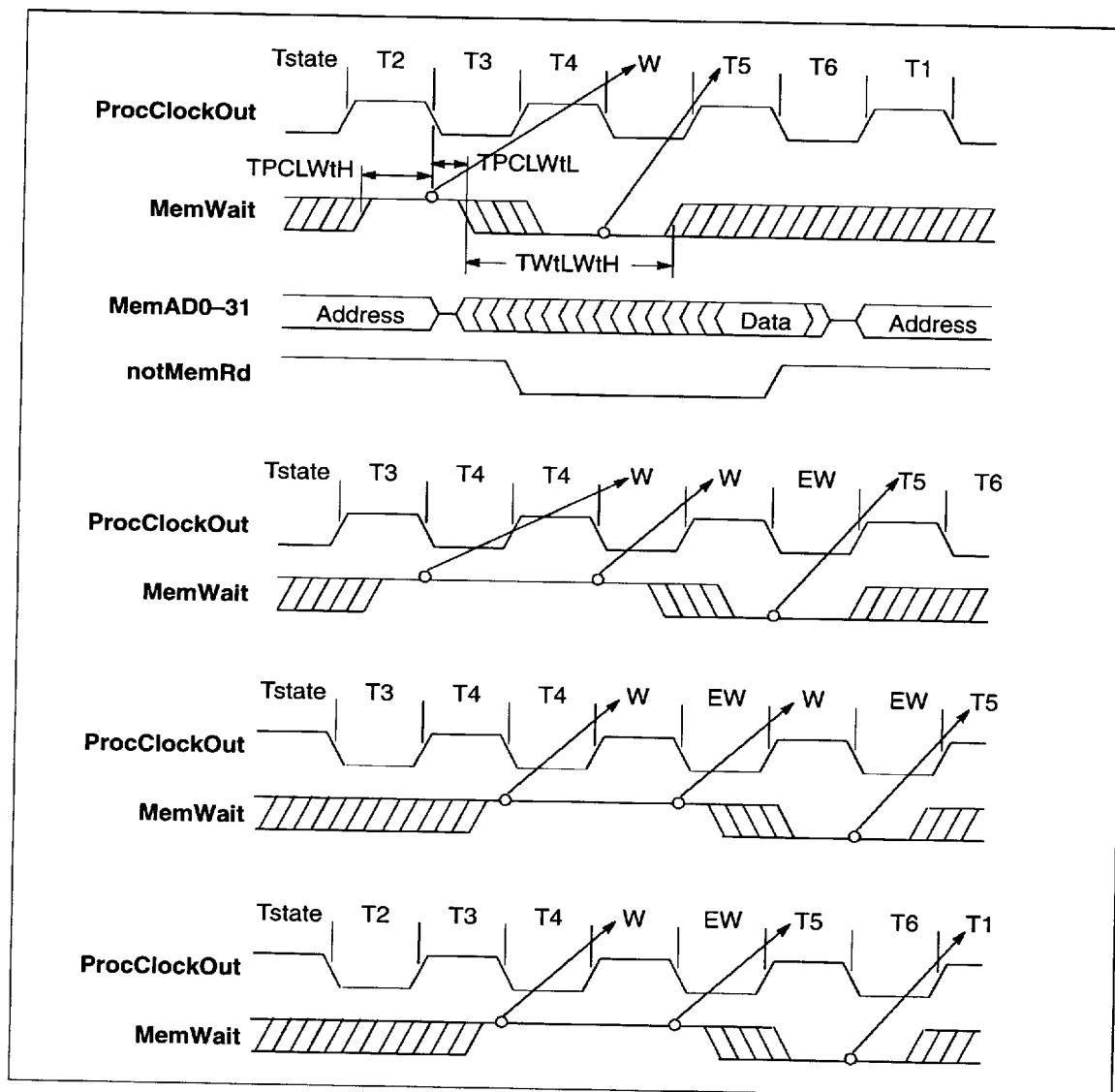


Figure 5.9 IMS T400 memory wait timing

## 5.5 Memory refresh

The **RefreshPending** pin is asserted high when the external memory interface is about to perform a refresh cycle. It remains high until the refresh cycle is started by the transputer. The minimum time for the **RefreshPending** pin to be high is for one cycle of **ProcClockOut** (two periods **T<sub>m</sub>**), when the EMI was not about to perform a memory read or write. If the EMI was held in the tristate condition with **MemGranted** asserted, then **RefreshPending** will be asserted when the refresh controller in the EMI is ready to perform a refresh. **MemReq** may be re-asserted any time after the commencement of the refresh cycle. **RefreshPending** changes state near the rising edge of **ProcClockOut** and can therefore be sampled by the falling edge of **ProcClockOut**.

If no DMA is active then refresh will be performed following the end of the current internal or external memory cycle. If DMA is active the transputer will wait for DMA to terminate before commencing the refresh cycle. Unlike **MemnotRfD1**, **RefreshPending** is never tristated and can thus be interrogated by the DMA device; the DMA cycle can then be suspended, at the discretion of the DMA device, to allow refresh to take place.

The simple circuit of Figure 5.10 will suspend DMA requests from the external logic when **RefreshPending** is asserted, so that a memory refresh cycle can be performed. DMA is restored on completion of the refresh cycle. The transputer will not perform an external memory cycle other than a refresh cycle, using this method, until the requesting device removes its DMA request.

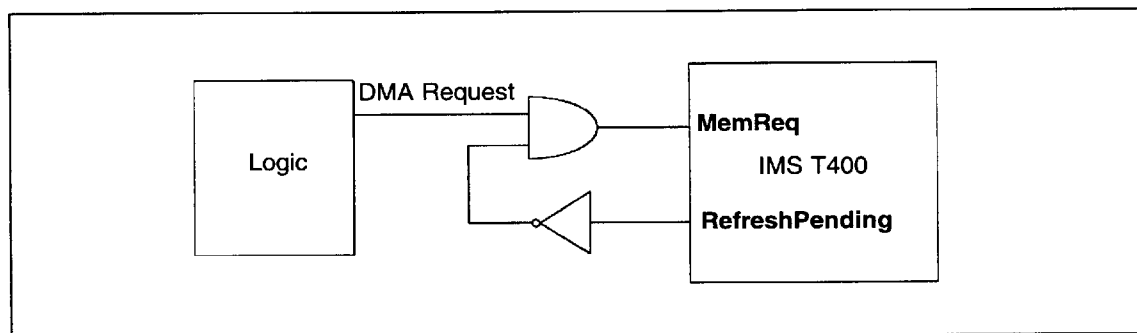


Figure 5.10 IMS T400 refresh with DMA

When refresh is disabled no refresh cycles occur. During the post-**Reset** period eight dummy refresh cycles will occur with the appropriate timing but with no bus or strobe activity.

A refresh cycle uses the same basic external memory timing as a normal external memory cycle, except that it starts two periods **T<sub>m</sub>** before the start of **T<sub>1</sub>**. If a refresh cycle is due during an external memory access, it will be delayed until the end of that external cycle. Two extra periods **T<sub>m</sub>** (periods **R** in the diagram) will then be inserted between the end of **T<sub>6</sub>** of the external memory cycle and the start of **T<sub>1</sub>** of the refresh cycle itself. The refresh address and various external strobes become active approximately one period **T<sub>m</sub>** before **T<sub>1</sub>**. Bus signals are active until the end of **T<sub>2</sub>**, whilst **notMemRf** remains active until the end of **T<sub>6</sub>**.

For a refresh cycle, **MemnotRfD1** goes low when **notMemRf** goes low and **MemnotWrD0** goes high with the same timing as **MemnotRfD1**. All the address lines share the same timing, but only **MemAD2-11** give the refresh address. **MemAD12-30** stay high during the address period, whilst **MemAD31** remains low. Refresh cycles generate strobes **notMemS0-4** with timing as for a normal external cycle, but **notMemRd** and **notMemWrB0-3** remain high. **MemWait** operates normally during refresh cycles.

Refresh cycles do not interrupt internal memory accesses, although the internal addresses cannot be reflected on the external bus during refresh.

## 5 External memory interface

| Symbol  | Parameter                                      | T400-20 |     | Units | Notes |
|---------|------------------------------------------------|---------|-----|-------|-------|
|         |                                                | Min     | Max |       |       |
| TRfLRfH | Refresh pulse width low                        | a-2     | a+9 | ns    | 1     |
| TRaVS0L | Refresh address setup before <b>notMemS0</b>   | b-12    |     | ns    |       |
| TRfLS0L | Refresh indicator setup before <b>notMemS0</b> | b-4     | b+6 | ns    | 2     |

## Notes

- 1 **a** is total **Tmx+Tm**.
- 2 **b** is total **T1+Tm** where **T1** can be from one to four periods **Tm** in length.

Table 5.7 Memory refresh

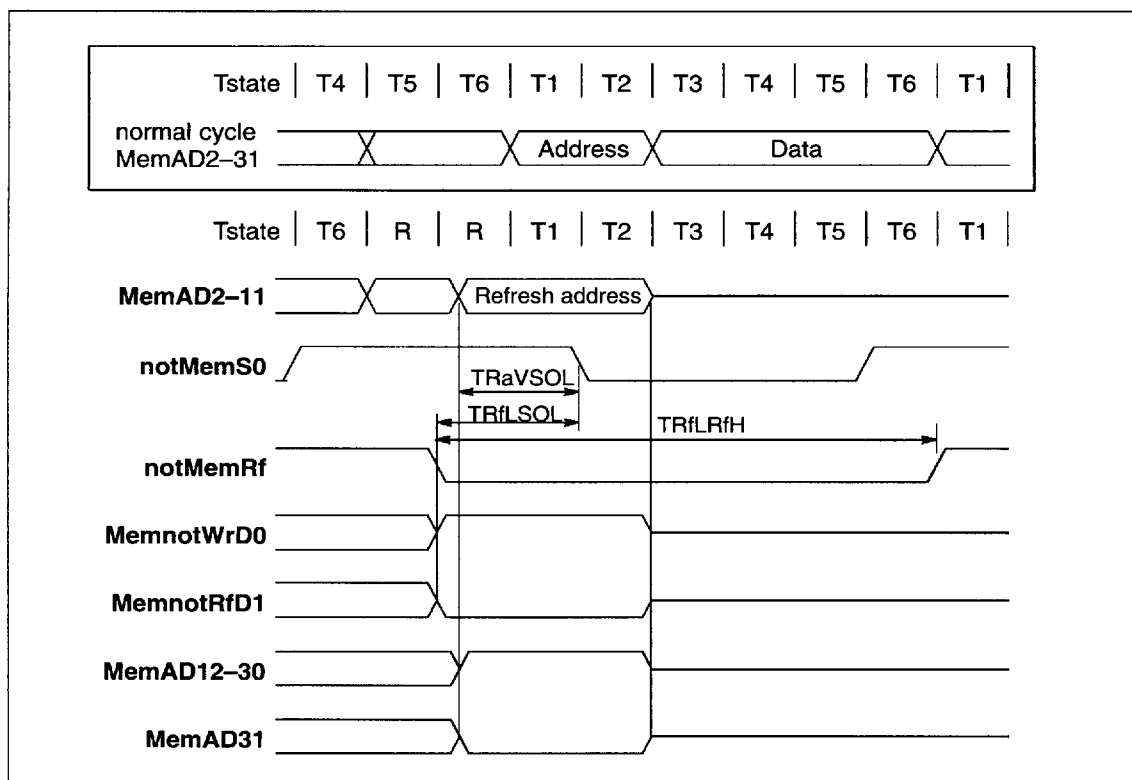


Figure 5.11 IMS T400 refresh cycle timing

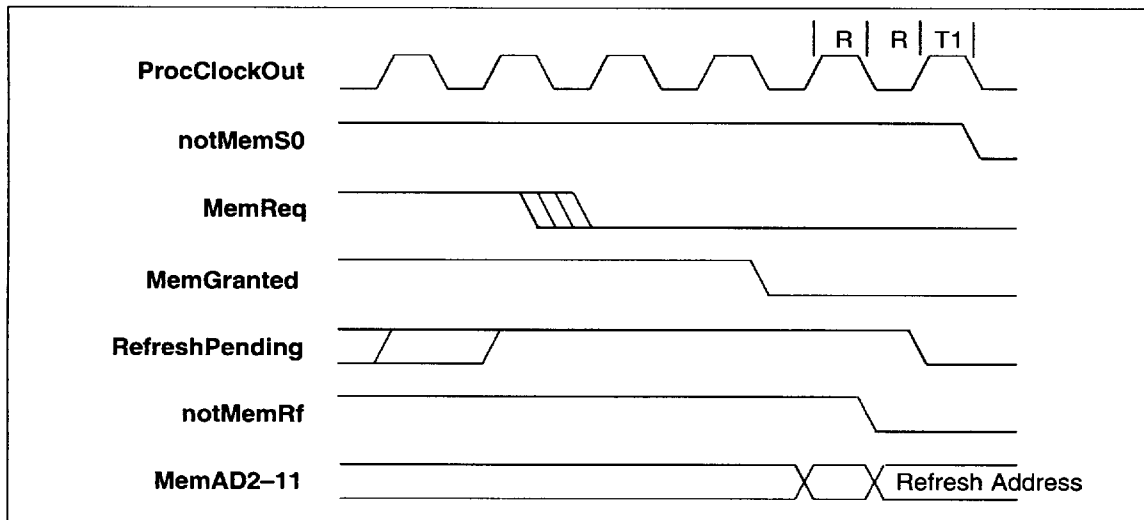


Figure 5.12 IMS T400 Refresh Pending timing

## 5.6 Direct memory access

Direct memory access (DMA) can be requested at any time by taking the asynchronous **MemReq** input high. The transputer samples **MemReq** just before falling edges of **ProcClockOut**. To guarantee taking over the bus immediately following either a refresh or external memory cycle, **MemReq** must be sampled at least four periods **Tm** before the end of **T6**. In the absence of an external memory cycle, the address bus is tristated two periods **Tm** after the **ProcClockOut** rising edge which follows the sample.

Removal of **MemReq** is sampled just before falling edges of **ProcClockOut** and **MemGranted** is removed synchronously with the second falling edge of **ProcClockOut** which follows the sample. If accurate timing of DMA is required, the setup time relative to **ProcClockOut** must be met. Further external bus activity, either refresh, external cycles or reflection of internal cycles, will commence at the next but one rising edge of **ProcClockOut**.

The strobes (**notMemS0-4** and **notMemWrB0-3**) are left in their inactive states during DMA. DMA cannot interrupt a refresh or external memory cycle, and outstanding refresh cycles will occur before the bus is released to DMA. DMA does not interfere with internal memory cycles in any way, although a program running in internal memory would have to wait for the end of DMA before accessing external memory. DMA cannot access internal memory. If DMA extends longer than one refresh interval (Memory Refresh Configuration Coding, table 5.11), the DMA user becomes responsible for refresh (see section 5.5). DMA may also inhibit an internally running program from accessing external memory.

DMA allows a bootstrap program to be loaded into external RAM ready for execution after reset. If **MemReq** is held high throughout reset, **MemGranted** will be asserted before the bootstrap sequence begins. **MemReq** must be high at least one period **TDCLDCL** of **ClockIn** before **Reset**. The circuit should be designed to ensure correct operation if **Reset** could interrupt a normal DMA cycle.

| Symbol  | Parameter                                                | T400-20 |     | Units | Note |
|---------|----------------------------------------------------------|---------|-----|-------|------|
|         |                                                          | Min     | Max |       |      |
| TMRHPCL | <b>MemReq</b> setup before <b>ProcClockOut</b> falling   | 3       | 14  | ns    | 1    |
| TPCLMGH | <b>MemReq</b> response time                              | 96      | 110 | ns    | 2    |
| TMRLPCL | <b>Memreq</b> removal before <b>ProcClockOut</b> falling | 4       | 16  |       |      |
| TPCLMGL | <b>MemReq</b> end response time                          | 50      | 66  | ns    |      |
| TADZMGH | Bus tristate before <b>MemGranted</b>                    | 0       | 27  | ns    |      |
| TMGLADV | Bus active after end of <b>MemGranted</b>                | 0       | 32  | ns    |      |

### Notes

- 1 Setup time need only be met to guarantee sampling on this edge.
- 2 If an external cycle is active, maximum time could be  
(1 EMI cycle **Tmx**)+(1 refresh cycle **TRfLRfH**)+(6 periods **Tm**).

Table 5.8 Memory request

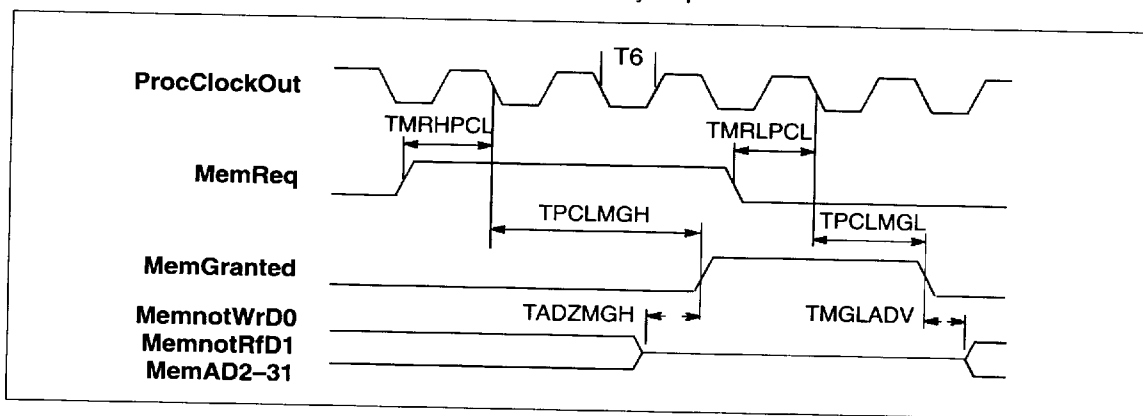


Figure 5.13 IMS T400 memory request timing

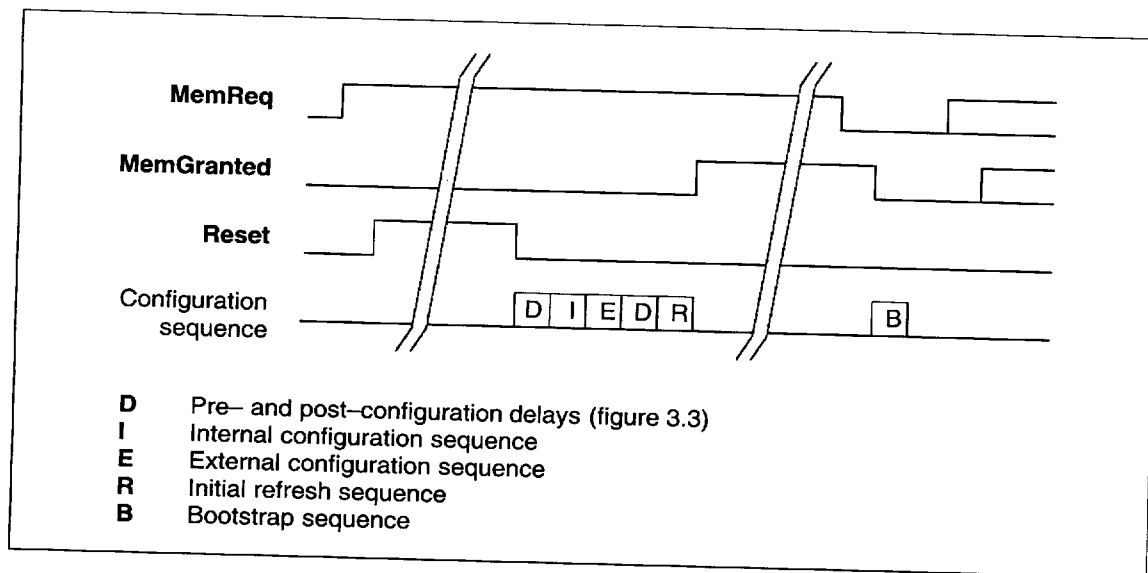
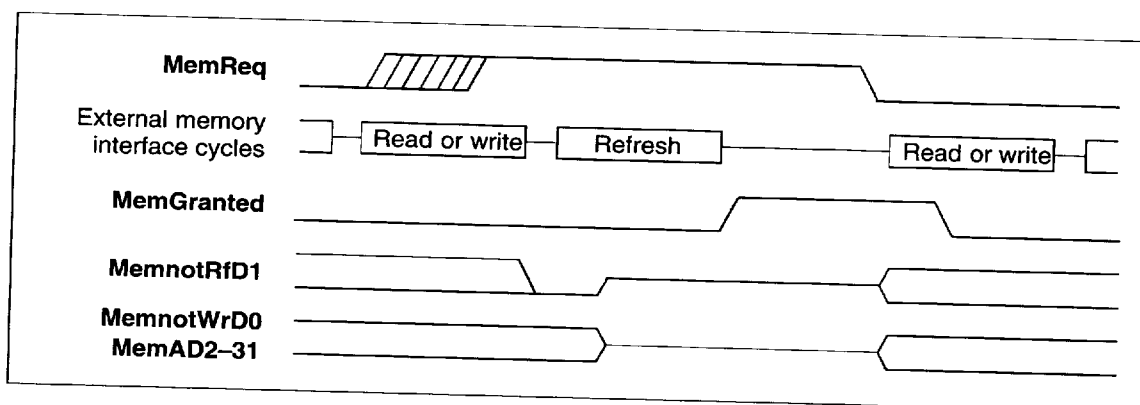
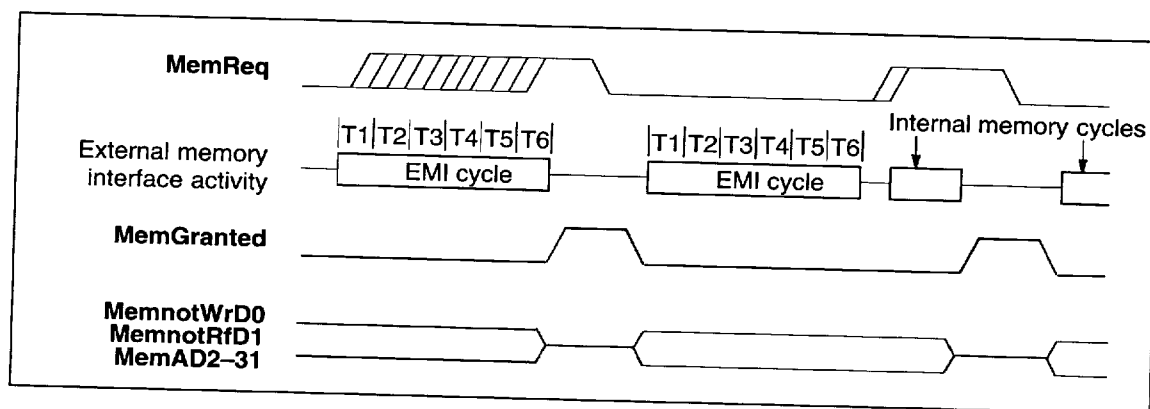


Figure 5.14 IMS T400 DMA sequence at reset

Figure 5.15 IMS T400 operation of **MemReq**, **MemGranted** with external, refresh memory cyclesFigure 5.16 IMS T400 operation of **MemReq**, **MemGranted** with external, internal memory cycles

## 5.7 Memory configuration

**MemConfig** is an input pin used to read configuration data when setting external memory interface (EMI) characteristics. It is read by the processor on two occasions after **Reset** goes low; first to check if one of the preset internal configurations is required, then to determine a possible external configuration.

### 5.7.1 Internal configuration

The internal configuration scan comprises 64 periods **TDCLDCL** of **ClockIn** during the internal scan period of 144 **ClockIn** periods. **MemnotWrD0**, **MemnotRfD1** and **MemAD2-32** are all high at the beginning of the scan. Starting with **MemnotWrD0**, each of these lines goes low successively at intervals of two **ClockIn** periods and stays low until the end of the scan. If one of these lines is connected to **MemConfig** the preset internal configuration mode associated with that line will be used as the EMI configuration. The default configuration is that defined in the table for **MemAD31**; connecting **MemConfig** to **VDD** will also produce this default configuration. Note that only 17 of the possible configurations are valid, all others remain at the default configuration.

| Pin               | Duration of each Tstate periods Tm |    |    |    |    |    | Strobe coefficient |    |    |    | Write cycle | Refresh interval | Cycle time  |
|-------------------|------------------------------------|----|----|----|----|----|--------------------|----|----|----|-------------|------------------|-------------|
|                   | T1                                 | T2 | T3 | T4 | T5 | T6 | s1                 | s2 | s3 | s4 | type        | ClockIn cycles   | Proc cycles |
| <b>MemnotWrD0</b> | 1                                  | 1  | 1  | 1  | 1  | 1  | 30                 | 1  | 3  | 5  | late        | 72               | 3           |
| <b>MemnotRfD1</b> | 1                                  | 2  | 1  | 1  | 1  | 2  | 30                 | 1  | 2  | 7  | late        | 72               | 4           |
| <b>MemAD2</b>     | 1                                  | 2  | 1  | 1  | 2  | 3  | 30                 | 1  | 2  | 7  | late        | 72               | 5           |
| <b>MemAD3</b>     | 2                                  | 3  | 1  | 1  | 2  | 3  | 30                 | 1  | 3  | 8  | late        | 72               | 6           |
| <b>MemAD4</b>     | 1                                  | 1  | 1  | 1  | 1  | 1  | 3                  | 1  | 2  | 3  | early       | 72               | 3           |
| <b>MemAD5</b>     | 1                                  | 1  | 2  | 1  | 2  | 1  | 5                  | 1  | 2  | 3  | early       | 72               | 4           |
| <b>MemAD6</b>     | 2                                  | 1  | 2  | 1  | 3  | 1  | 6                  | 1  | 2  | 3  | early       | 72               | 5           |
| <b>MemAD7</b>     | 2                                  | 2  | 2  | 1  | 3  | 2  | 7                  | 1  | 3  | 4  | early       | 72               | 6           |
| <b>MemAD8</b>     | 1                                  | 1  | 1  | 1  | 1  | 1  | 30                 | 1  | 2  | 3  | early       | †                | 3           |
| <b>MemAD9</b>     | 1                                  | 1  | 2  | 1  | 2  | 1  | 30                 | 2  | 5  | 9  | early       | †                | 4           |
| <b>MemAD10</b>    | 2                                  | 2  | 2  | 2  | 4  | 2  | 30                 | 2  | 3  | 8  | late        | 72               | 7           |
| <b>MemAD11</b>    | 3                                  | 3  | 3  | 3  | 3  | 3  | 30                 | 2  | 4  | 13 | late        | 72               | 9           |
| <b>MemAD12</b>    | 1                                  | 1  | 2  | 1  | 2  | 1  | 4                  | 1  | 2  | 3  | early       | 72               | 4           |
| <b>MemAD13</b>    | 2                                  | 1  | 2  | 1  | 2  | 2  | 5                  | 1  | 2  | 3  | early       | 72               | 5           |
| <b>MemAD14</b>    | 2                                  | 2  | 2  | 1  | 3  | 2  | 6                  | 1  | 3  | 4  | early       | 72               | 6           |
| <b>MemAD15</b>    | 2                                  | 1  | 2  | 3  | 3  | 3  | 8                  | 1  | 2  | 3  | early       | 72               | 7           |
| <b>MemAD31</b>    | 4                                  | 4  | 4  | 4  | 4  | 4  | 31                 | 30 | 30 | 18 | late        | 72               | 12          |

† Provided for static RAM only.

Table 5.9 IMS T400 internal configuration coding

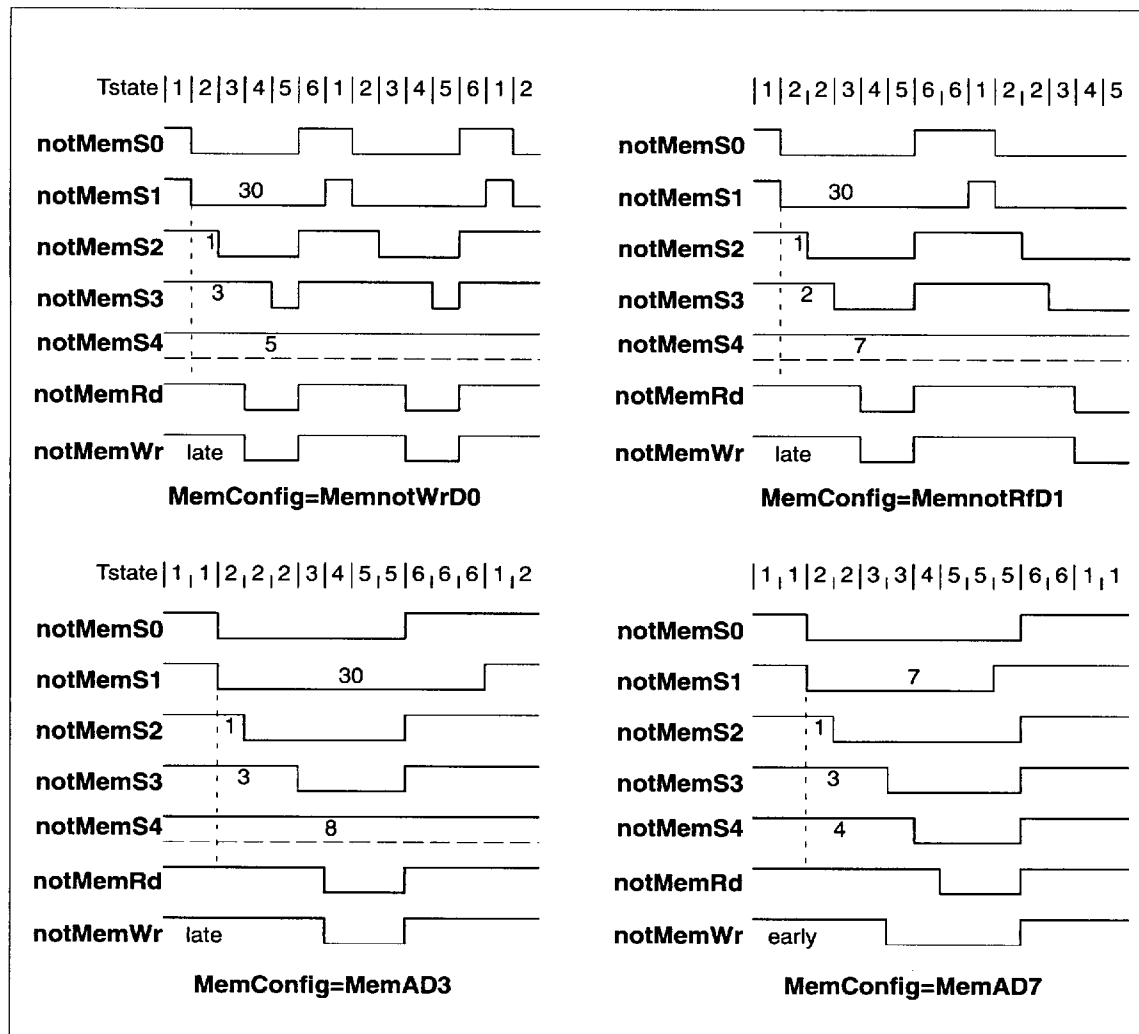


Figure 5.17 IMS T400 internal configuration



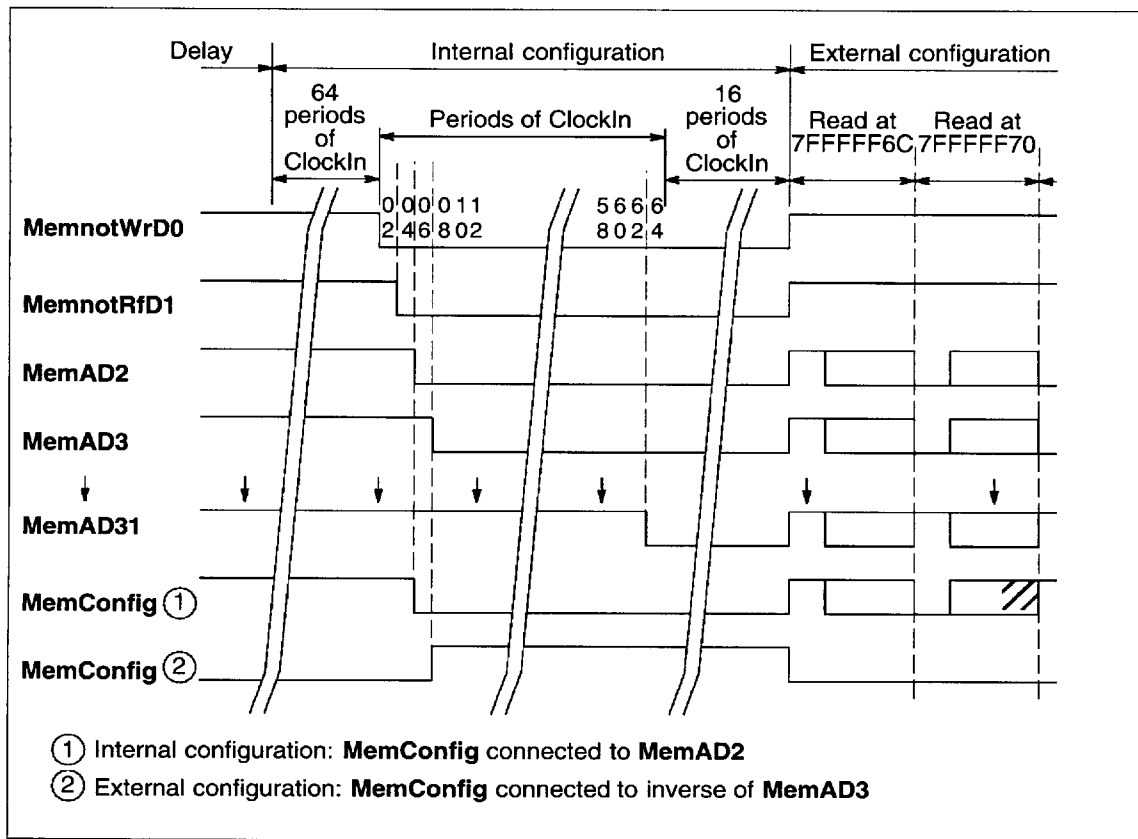


Figure 5.18 IMS T400 internal configuration scan

### 5.7.2 External configuration

If **MemConfig** is held low until **MemnotWrD0** goes low the internal configuration is ignored and an external configuration will be loaded instead. An external configuration scan always follows an internal one, but if an internal configuration occurs any external configuration is ignored.

The external configuration scan comprises 36 successive external read cycles, using the default EMI configuration preset by **MemAD31**. However, instead of data being read on the data bus as for a normal read cycle, only a single bit of data is read on **MemConfig** at each cycle. Addresses put out on the bus for each read cycle are shown in table 5.10, and are designed to address ROM at the top of the memory map. The table shows the data to be held in ROM; data required at the **MemConfig** pin is the inverse of this.

**MemConfig** is typically connected via an inverter to **MemnotWrD0**. Data bit zero of the least significant byte of each ROM word then provides the configuration data stream. By switching **MemConfig** between various data bus lines up to 32 configurations can be stored in ROM, one per bit of the data bus. **MemConfig** can be permanently connected to a data line or to **GND**. Connecting **MemConfig** to **GND** gives all **Tstates** configured to four periods; **notMemS1** pulse of maximum duration; **notMemS2-4** delayed by maximum; refresh interval 72 periods of **ClockIn**; refresh enabled; late write.

The external memory configuration table 5.10 shows the contribution of each memory address to the 13 configuration fields. The lowest 12 words (#7FFFFFF6C to #7FFFFFF98, fields 1 to 6) define the number of extra periods **Tm** to be added to each **Tstate**. If field 2 is 3 then three extra periods will be added to **T2** to extend it to the maximum of four periods.

The next five addresses (field 7) define the duration of **notMemS1** and the following fifteen (fields 8 to 10) define the delays before strobes **notMemS2-4** become active. The five bits allocated to each strobe allow durations of from 0 to 31 periods **Tm**, as described in strobes page 15.

Addresses #7FFFFFFEC to #7FFFFFF4 (fields 11 and 12) define the refresh interval and whether refresh is to be used, whilst the final address (field 13) supplies a high bit to **MemConfig** if a late write cycle is required.

The columns to the right of the coding table show the values of each configuration bit for the four sample external configuration diagrams. Note the inclusion of period **E** at the end of **T6** in some diagrams. This is inserted to bring the start of the next **Tstate T1** to coincide with a rising edge of **ProcClockOut** (page 16).

Wait states **W** have been added to show the effect of them on strobe timing; they are not part of a configuration. In each case which includes wait states, two wait periods are defined. This shows that if a wait state would cause the start of **T5** to coincide with a falling edge of **ProcClockOut**, another period **Tm** is generated by the EMI to force it to coincide with a rising edge of **ProcClockOut**. This coincidence is only necessary if wait states are added, otherwise coincidence with a falling edge is permitted. Any configuration memory access is only permitted to be extended using wait, up to a total of 14 **ClockIn** periods.

## 5 External memory interface

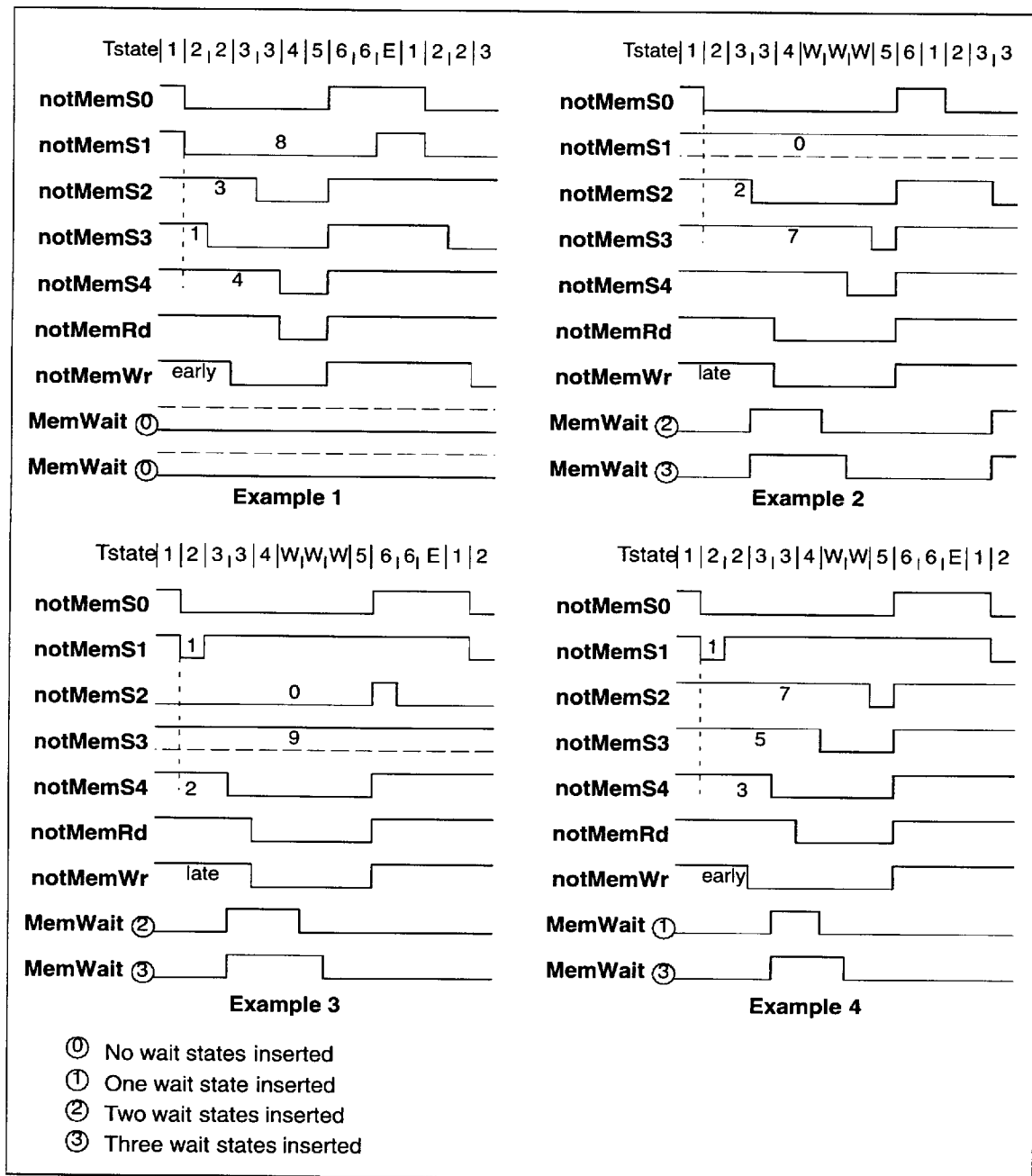


Figure 5.19 IMS T400 external configuration

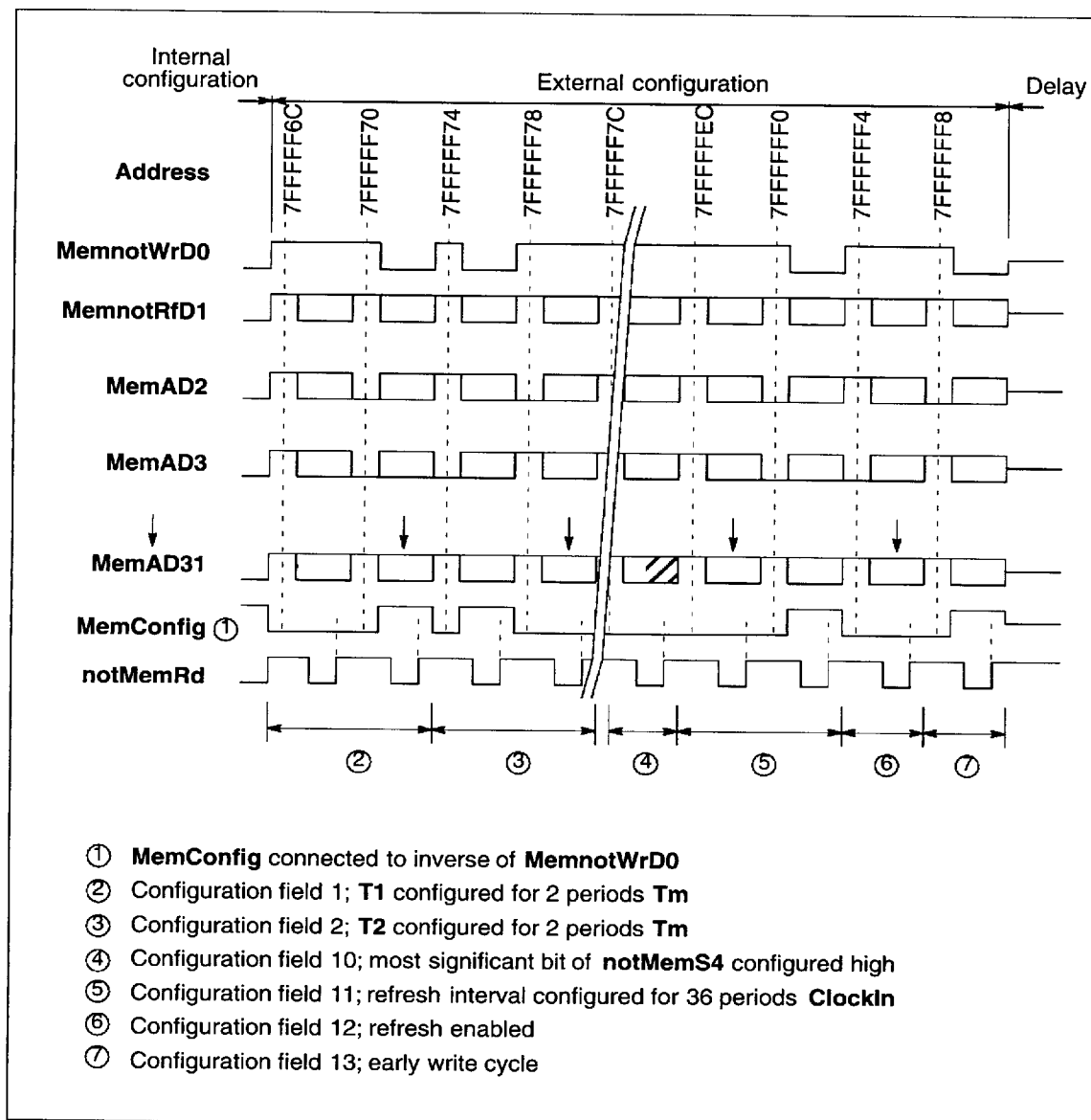


Figure 5.20 IMS T400 external configuration scan

## 5 External memory interface

| Scan cycle | Mem AD address | Field | Function                               | Example diagram |   |   |   |
|------------|----------------|-------|----------------------------------------|-----------------|---|---|---|
|            |                |       |                                        | 1               | 2 | 3 | 4 |
| 1          | 7FFFFFF6C      | 1     | T1 least significant bit               | 0               | 0 | 0 | 0 |
| 2          | 7FFFFFF70      | 1     | T1 most significant bit                | 0               | 0 | 0 | 0 |
| 3          | 7FFFFFF74      | 2     | T2 least significant bit               | 1               | 0 | 0 | 1 |
| 4          | 7FFFFFF78      | 2     | T2 most significant bit                | 0               | 0 | 0 | 0 |
| 5          | 7FFFFFF7C      | 3     | T3 least significant bit               | 1               | 1 | 1 | 1 |
| 6          | 7FFFFFF80      | 3     | T3 most significant bit                | 0               | 0 | 0 | 0 |
| 7          | 7FFFFFF84      | 4     | T4 least significant bit               | 0               | 0 | 0 | 0 |
| 8          | 7FFFFFF88      | 4     | T4 most significant bit                | 0               | 0 | 0 | 0 |
| 9          | 7FFFFFF8C      | 5     | T5 least significant bit               | 0               | 0 | 0 | 0 |
| 10         | 7FFFFFF90      | 5     | T5 most significant bit                | 0               | 0 | 0 | 0 |
| 11         | 7FFFFFF94      | 6     | T6 least significant bit               | 1               | 0 | 1 | 1 |
| 12         | 7FFFFFF98      | 6     | T6 most significant bit                | 0               | 0 | 0 | 0 |
| 13         | 7FFFFFF9C      | 7     | notMemS1 least significant bit         | 0               | 0 | 1 | 1 |
| 14         | 7FFFFFFA0      | 7     | ⌚ ⌚                                    | 0               | 0 | 0 | 0 |
| 15         | 7FFFFFFA4      | 7     |                                        | 0               | 0 | 0 | 0 |
| 16         | 7FFFFFFA8      | 7     |                                        | 1               | 0 | 0 | 0 |
| 17         | 7FFFFFFAC      | 7     | notMemS1 most significant bit          | 0               | 0 | 0 | 0 |
| 18         | 7FFFFFFB0      | 8     | notMemS2 least significant bit         | 1               | 0 | 0 | 1 |
| 19         | 7FFFFFFB4      | 8     | ⌚ ⌚                                    | 1               | 1 | 0 | 1 |
| 20         | 7FFFFFFB8      | 8     |                                        | 0               | 0 | 0 | 1 |
| 21         | 7FFFFFFBC      | 8     |                                        | 0               | 0 | 0 | 0 |
| 22         | 7FFFFFFC0      | 8     | notMemS2 most significant bit          | 0               | 0 | 0 | 0 |
| 23         | 7FFFFFFC4      | 9     | notMemS3 least significant bit         | 1               | 1 | 1 | 1 |
| 24         | 7FFFFFFC8      | 9     | ⌚ ⌚                                    | 0               | 1 | 0 | 0 |
| 25         | 7FFFFFFCC      | 9     |                                        | 0               | 1 | 0 | 1 |
| 26         | 7FFFFFFD0      | 9     |                                        | 0               | 0 | 1 | 0 |
| 27         | 7FFFFFFD4      | 9     | notMemS3 most significant bit          | 0               | 0 | 0 | 0 |
| 28         | 7FFFFFFD8      | 10    | notMemS4 least significant bit         | 0               | 0 | 0 | 1 |
| 29         | 7FFFFFFDC      | 10    | ⌚ ⌚                                    | 0               | 1 | 1 | 1 |
| 30         | 7FFFFFFE0      | 10    |                                        | 1               | 1 | 0 | 0 |
| 31         | 7FFFFFFE4      | 10    |                                        | 0               | 0 | 0 | 0 |
| 32         | 7FFFFFFE8      | 10    | notMemS4 most significant bit          | 0               | 0 | 0 | 0 |
| 33         | 7FFFFFFEC      | 11    | Refresh Interval least significant bit | -               | - | - | - |
| 34         | 7FFFFFFF0      | 11    | Refresh Interval most significant bit  | -               | - | - | - |
| 35         | 7FFFFFFF4      | 12    | Refresh Enable                         | -               | - | - | - |
| 36         | 7FFFFFFF8      | 13    | Late Write                             | 0               | 1 | 1 | 0 |

Table 5.10 IMS T400 external configuration coding

| Refresh interval | Interval in $\mu\text{s}$ | Field 11 encoding | Complete cycle (ms) |
|------------------|---------------------------|-------------------|---------------------|
| 18               | 3.6                       | 00                | 0.922               |
| 36               | 7.2                       | 01                | 1.843               |
| 54               | 10.8                      | 10                | 2.765               |
| 72               | 14.4                      | 11                | 3.686               |

Table 5.11 IMS T400 memory refresh configuration coding

Refresh intervals are in periods of **ClockIn** and **ClockIn** frequency is 5 MHz:

$$\text{Interval} = 18 * 200 = 3600 \text{ ns}$$

Refresh interval is between successive incremental refresh addresses.  
Complete cycles are shown for 256 row DRAMS.

| Symbol  | Parameter                                  | T400-20 |     | Units |
|---------|--------------------------------------------|---------|-----|-------|
|         |                                            | Min     | Max |       |
| TMCVRdH | Memory configuration data setup            | 25      |     | ns    |
| TRdHMCX | Memory configuration data hold             | 0       |     | ns    |
| TS0LRdH | <b>notMemS0</b> to configuration data read | 388     | 412 | ns    |

Table 5.12 Memory configuration

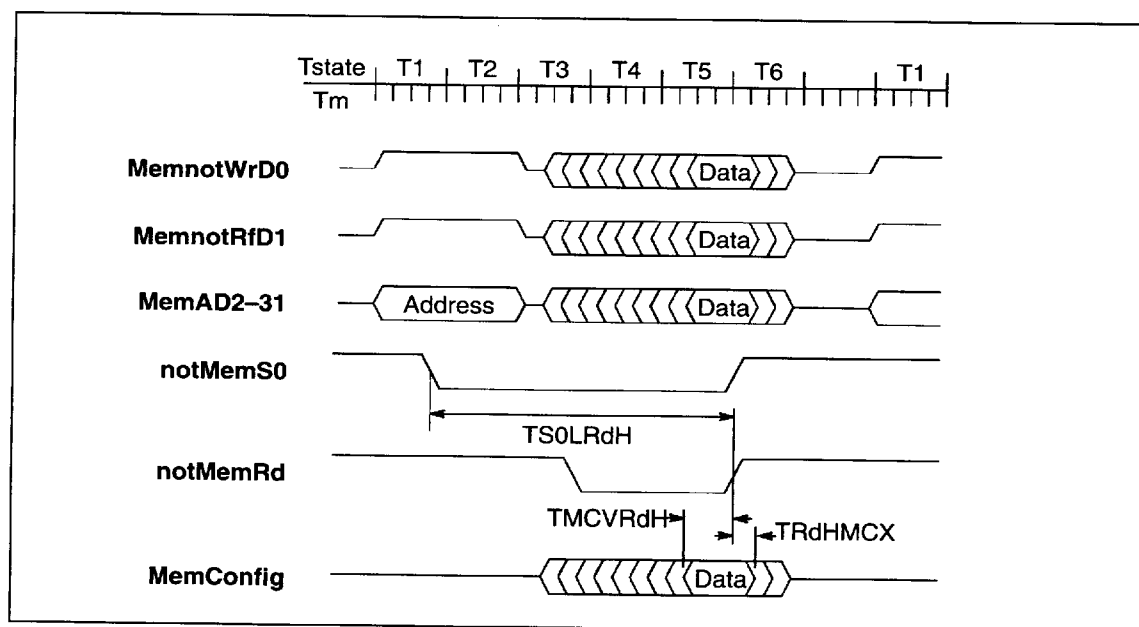


Figure 5.21 IMS T400 external configuration read cycle timing

## 6 Events

**EventReq** and **EventAck** provide an asynchronous handshake interface between an external event and an internal process. When an external event takes **EventReq** high the external event channel (additional to the external link channels) is made ready to communicate with a process. When both the event channel and the process are ready the processor takes **EventAck** high and the process, if waiting, is scheduled. **EventAck** is removed after **EventReq** goes low.

**EventWaiting** is asserted high by the transputer when a process executes an input on the event channel; typically with the occam `EVENT ? ANY` instruction. It remains high whilst the transputer is waiting for or servicing **EventReq** and is returned low when **EventAck** goes high. The **EventWaiting** pin changes near the falling edge of **ProcClockOut** and can therefore be sampled by the rising edge of **ProcClockOut**.

The **EventWaiting** pin can only be asserted by executing an *in* instruction on the event channel. The **EventWaiting** pin is not asserted high when an enable channel (*enbc*) instruction is executed on the Event channel (during an ALT construct in occam, for example). The **EventWaiting** pin can be asserted by executing the occam input on the event channel (such as `Event ? ANY`), provided that this does not occur as a guard in an alternative process. The **EventWaiting** pin can not be used to signify that an alternative process (ALT) is waiting on an input from the event channel.

**EventWaiting** allows a process to control external logic; for example, to clock a number of inputs into a memory mapped data latch so that the event request type can be determined. This function is not available on the IMS T414 and IMS T800.

Only one process may use the event channel at any given time. If no process requires an event to occur **EventAck** will never be taken high. Although **EventReq** triggers the channel on a transition from low to high, it must not be removed before **EventAck** is high. **EventReq** should be low during **Reset**; if not it will be ignored until it has gone low and returned high. **EventAck** is taken low when **Reset** occurs.

If the process is a high priority one and no other high priority process is running, typical latency is 19 full processor cycles **TCPLCPL** (38 **Tm**), and maximum latency (assuming all memory accesses are internal) is 58 full processor cycles (116 **Tm**). Setting a high priority task to wait for an event input allows the user to interrupt a transputer program running at low priority. The time taken from asserting **EventReq** to the execution of the microcode interrupt handler in the CPU is four cycles. The following functions take place during the four cycles:

- Cycle 1**     Sample **EventReq** at pad on the rising edge of **ProcClockOut** and synchronise.
- Cycle 2**     Edge detect the synchronised **EventReq** and form the interrupt request.
- Cycle 3**     Sample interrupt vector for microcode ROM in the CPU.
- Cycle 4**     Execute the interrupt routine for Event rather than the next instruction.

| Symbol | Parameter                                     | T400-20 |     | Units |
|--------|-----------------------------------------------|---------|-----|-------|
|        |                                               | Min     | Max |       |
| TVHKH  | <b>EventReq</b> response                      | 0       |     | ns    |
| TKHVL  | <b>EventReq</b> hold                          | 0       |     | ns    |
| TVLKL  | Delay before removal of <b>EventAck</b>       | 0       | 157 | ns    |
| TKLVH  | Delay before re-assertion of <b>EventReq</b>  | 0       |     | ns    |
| TKHEWL | <b>EventAck</b> to end of <b>EventWaiting</b> | 0       |     | ns    |

Table 6.1 Event

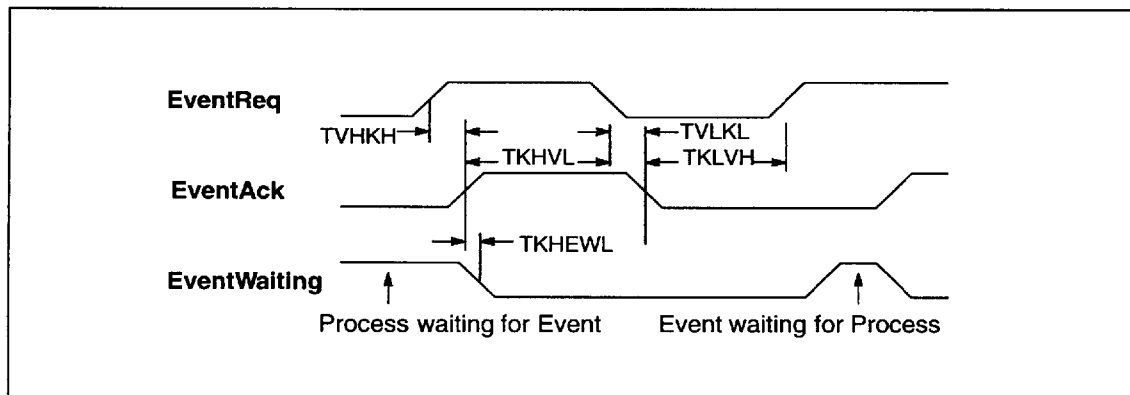


Figure 6.1 IMS T400 event timing



## 7 Links

Two identical INMOS bi-directional serial links provide synchronized communication between processors and with the outside world. Each link comprises an input channel and output channel. A link between two transputers is implemented by connecting a link interface on one transputer to a link interface on the other transputer. Every byte of data sent on a link is acknowledged on the input of the same link, thus each signal line carries both data and control information.

The quiescent state of a link output is low. Each data byte is transmitted as a high start bit followed by a one bit followed by eight data bits followed by a low stop bit. The least significant bit of data is transmitted first. After transmitting a data byte the sender waits for the acknowledge, which consists of a high start bit followed by a zero bit. The acknowledge signifies both that a process was able to receive the acknowledged data byte and that the receiving link is able to receive another byte. The sending link reschedules the sending process only after the acknowledge for the final byte of the message has been received.

The IMS T400 links allow an acknowledge packet to be sent before the data packet has been fully received. This overlapped acknowledge technique is fully compatible with all other INMOS transputer links.

The IMS T400 links support the standard INMOS communication speed of 10 Mbits/sec. In addition they can be used at 5 or 20 Mbits/sec. Links are not synchronised with **ClockIn** or **ProcClockOut** and are insensitive to their phases. Thus links from independently clocked systems may communicate, providing only that the clocks are nominally identical and within specification.

Links are TTL compatible and intended to be used in electrically quiet environments, between devices on a single printed circuit board or between two boards via a backplane. Direct connection may be made between devices separated by a distance of less than 300 millimetres. For longer distances a matched 100 ohm transmission line should be used with series matching resistors **RM**. When this is done the line delay should be less than 0.4 bit time to ensure that the reflection returns before the next data bit is sent.

Buffers may be used for very long transmissions. If so, their overall propagation delay should be stable within the skew tolerance of the link, although the absolute value of the delay is immaterial.

Link speeds can be set by **LinkSpecial**, **Link0Special** and **Link1Special**. Table 7.1 shows uni-directional and bi-directional data rates in Kbytes/sec for each link speed; **LinknSpecial** is to be read as **Link0Special** when selecting link 0 speed and as **Link1Special** for link 1. Data rates are quoted for a transputer using internal memory, and will be affected by a factor depending on the number of external memory accesses and the length of the external memory cycle.

| Link<br>Special | Linkn<br>Special | Mbits/sec | Kbytes/sec |      |
|-----------------|------------------|-----------|------------|------|
|                 |                  |           | Uni        | Bi   |
| 0               | 0                | 10        | 910        | 1250 |
| 0               | 1                | 5         | 450        | 670  |
| 1               | 0                | 10        | 910        | 1250 |
| 1               | 1                | 20        | 1740       | 2350 |

Table 7.1 Speed Settings for Transputer Links

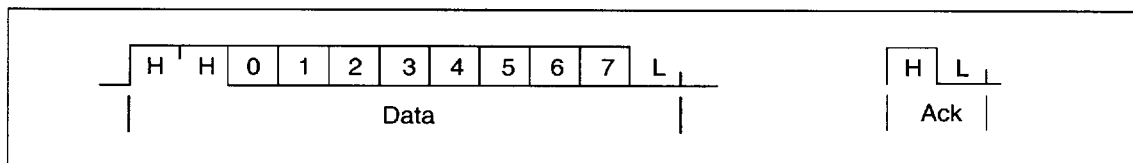


Figure 7.1 IMS T400 link data and acknowledge packets

| Symbol  | Parameter                                  | Min | Nom | Max | Units | Notes |
|---------|--------------------------------------------|-----|-----|-----|-------|-------|
| TJQr    | LinkOut rise time                          |     |     | 20  | ns    |       |
| TJQf    | LinkOut fall time                          |     |     | 10  | ns    |       |
| TJDr    | LinkIn rise time                           |     |     | 20  | ns    |       |
| TJDf    | LinkIn fall time                           |     |     | 20  | ns    |       |
| TJQJD   | Buffered edge delay                        | 0   |     |     | ns    |       |
| TJBskew | Variation in TJQJD                         |     |     | 3   | ns    | 1     |
|         | 20 Mbits/s                                 |     |     | 10  | ns    | 1     |
|         | 10 Mbits/s                                 |     |     | 30  | ns    | 1     |
| CLIZ    | LinkIn capacitance @ f=1MHz                |     |     | 7   | pF    |       |
| CLL     | LinkOut load capacitance                   |     |     | 50  | pF    |       |
| RM      | Series resistor for 100Ω transmission line |     | 56  |     | ohms  |       |

**Notes**

- 1 This is the variation in the total delay through buffers, transmission lines, differential receivers etc., caused by such things as short term variation in supply voltages and differences in delays for rising and falling edges.

Table 7.2 Link

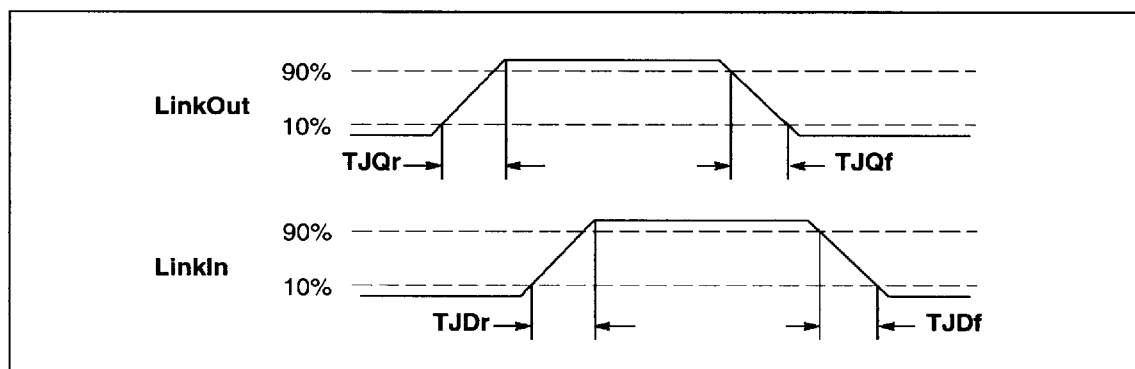


Figure 7.2 IMS T400 link timing

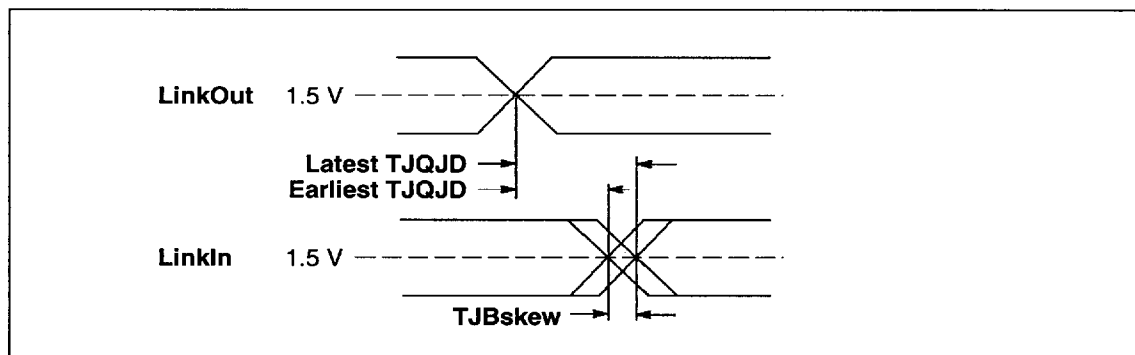


Figure 7.3 IMS T400 buffered link timing

## 7 Links

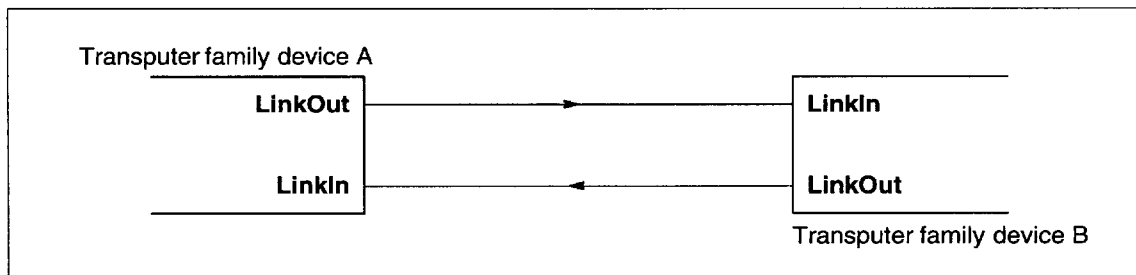


Figure 7.4 Links directly connected

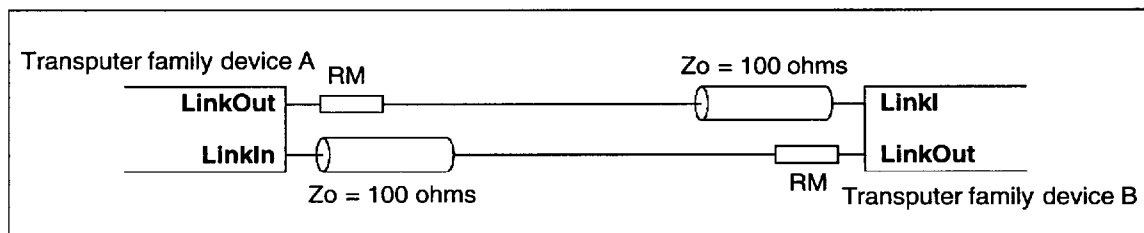


Figure 7.5 Links connected by transmission line

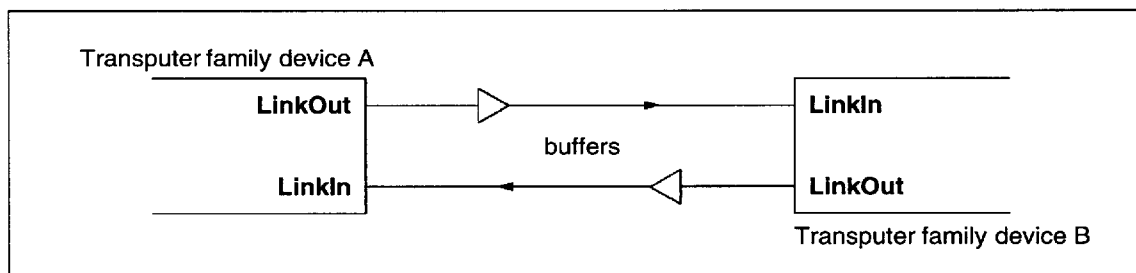


Figure 7.6 Links connected by buffers

## 8 Electrical specifications

### 8.1 DC electrical characteristics

| SYMBOL | PARAMETER                           | MIN  | MAX     | UNITS | NOTES |
|--------|-------------------------------------|------|---------|-------|-------|
| VDD    | DC supply voltage                   | 0    | 7.0     | V     | 1,2,3 |
| VI, VO | Voltage on input and output pins    | -0.5 | VDD+0.5 | V     | 1,2,3 |
| II     | Input current                       |      | 25      | mA    | 4     |
| tOSC   | Output short circuit time (one pin) |      | 1       | s     | 2     |
| TS     | Storage temperature                 | -65  | 150     | °C    | 2     |
| TA     | Ambient temperature under bias      | -55  | 125     | °C    | 2     |
| PDmax  | Maximum allowable dissipation       |      | 2       | W     |       |

#### Notes

- 1 All voltages are with respect to **GND**.
- 2 This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operating sections of this specification is not implied. Stresses greater than those listed may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- 3 This device contains circuitry to protect the inputs against damage caused by high static voltages or electrical fields. However, it is advised that normal precautions be taken to avoid application of any voltage higher than the absolute maximum rated voltages to this high impedance circuit. Unused inputs should be tied to an appropriate logic level such as **VDD** or **GND**.
- 4 The input current applies to any input or output pin and applies when the voltage on the pin is between **GND** and **VDD**.

Table 8.1 Absolute maximum ratings

| SYMBOL | PARAMETER                              | MIN | MAX | UNITS | NOTES |
|--------|----------------------------------------|-----|-----|-------|-------|
| VDD    | DC supply voltage                      | 4.5 | 5.5 | V     | 1     |
| VI, VO | Input or output voltage                | 0   | VDD | V     | 1,2   |
| CL     | Load capacitance on any pin            |     | 60  | pF    | 3     |
| TA     | Operating temperature range IMS T400-S | 0   | 70  | °C    | 4     |
| TA     | Operating temperature range IMS T400-I | -40 | +85 | °C    | 4,5   |

#### Notes

- 1 All voltages are with respect to **GND**.
- 2 Excursions beyond the supplies are permitted but not recommended; see DC characteristics.
- 3 Excluding **LinkOut** load capacitance.
- 4 Air flow rate 400 linear ft/min transverse air flow.
- 5 Industrial temperature range part.

Table 8.2 Operating conditions

## 8 Electrical specifications

| SYMBOL          | PARAMETER                                                     | MIN                | MAX                  | UNITS | NOTES |
|-----------------|---------------------------------------------------------------|--------------------|----------------------|-------|-------|
| V <sub>IH</sub> | High level input voltage                                      | 2.0                | V <sub>DD</sub> +0.5 | V     | 1, 2  |
| V <sub>IL</sub> | Low level input voltage                                       | -0.5               | 0.8                  | V     | 1, 2  |
| I <sub>I</sub>  | Input current @ GND<V <sub>I</sub> <V <sub>DD</sub>           |                    | 10                   | μA    | 1, 2  |
| V <sub>OH</sub> | Output high voltage @ I <sub>OH</sub> =2mA                    | V <sub>DD</sub> -1 |                      | V     | 1, 2  |
| V <sub>OL</sub> | Output low voltage @ I <sub>OL</sub> =4mA                     |                    | 0.4                  | V     | 1, 2  |
| I <sub>OZ</sub> | Tristate output current @ GND<V <sub>O</sub> <V <sub>DD</sub> |                    | 10                   | μA    | 1, 2  |
| P <sub>D</sub>  | Power dissipation                                             |                    | 1.0                  | W     | 2, 3  |
| C <sub>IN</sub> | Input capacitance @ f=1MHz                                    |                    | 7                    | pF    |       |
| C <sub>OZ</sub> | Output capacitance @ f=1MHz                                   |                    | 10                   | pF    |       |

### Notes

- 1 All voltages are with respect to **GND**.
- 2 Parameters for IMS T400 measured at 4.75V<**VDD**<5.25V and 0°C<**TA**<70°C.  
Input clock frequency = 5 MHz.
- 3 Power dissipation varies with output loading and program execution.  
Power dissipation for processor operating at 20 MHz.

Table 8.3 DC characteristics

## 8.2 Equivalent circuits

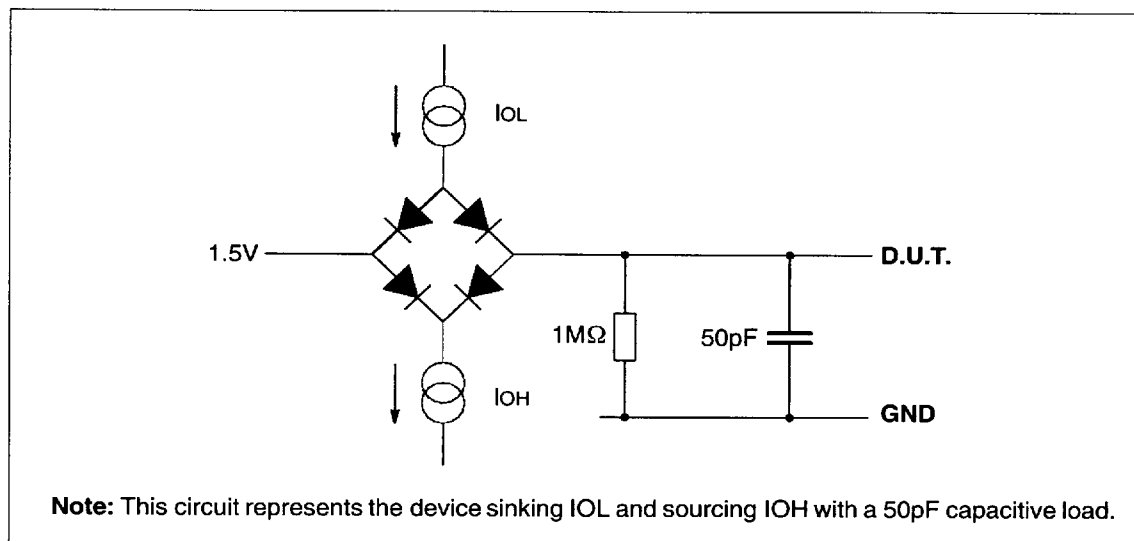


Figure 8.1 Load circuit for AC measurements

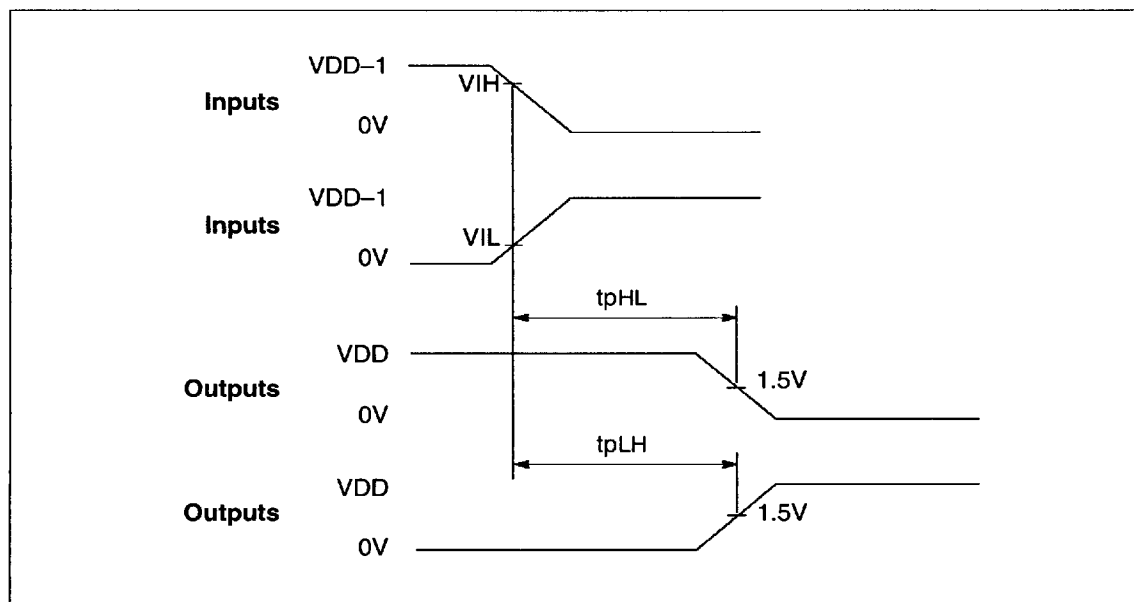


Figure 8.2 AC measurements timing waveforms

### 8.3 AC timing characteristics

| Symbol | Parameter                          | Min | Max | Units | Notes |
|--------|------------------------------------|-----|-----|-------|-------|
| TDr    | Input rising edges                 | 2   | 20  | ns    | 1,2   |
| TDf    | Input falling edges                | 2   | 20  | ns    | 1,2   |
| TQr    | Output rising edges                |     | 25  | ns    | 1,2   |
| TQf    | Output falling edges               |     | 15  | ns    | 1,2   |
| TSOLaX | Address hold after <b>notMemS0</b> | a-8 | a+8 | ns    | 3     |

#### Notes

- 1 Non-link pins; see section on links.
- 2 All inputs except **ClockIn**; see section on **ClockIn**.
- 3 **a** is **T2** where **T2** can be from one to four periods **Tm** in length.  
Address lines include **MemnotWrD0**, **MemnotRfD1**, **MemAD2-31**.

Table 8.4 Input and output edges

## 8 Electrical specifications

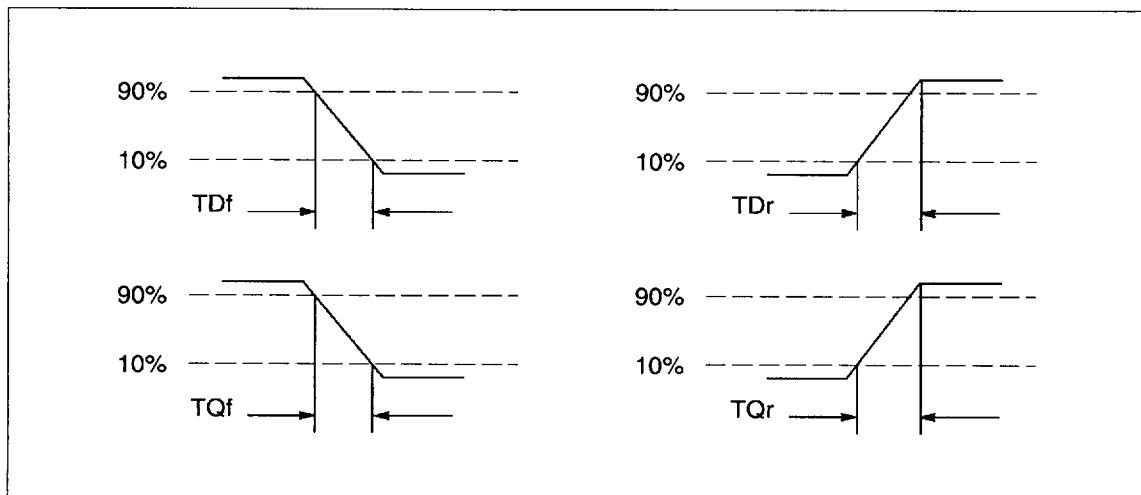


Figure 8.3 IMS T400 input and output edge timing

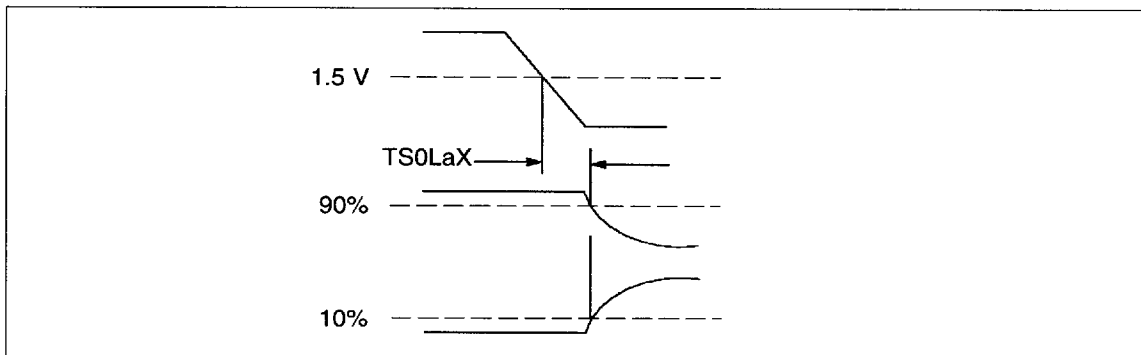


Figure 8.4 IMS T400 tristate timing relative to notMemS0

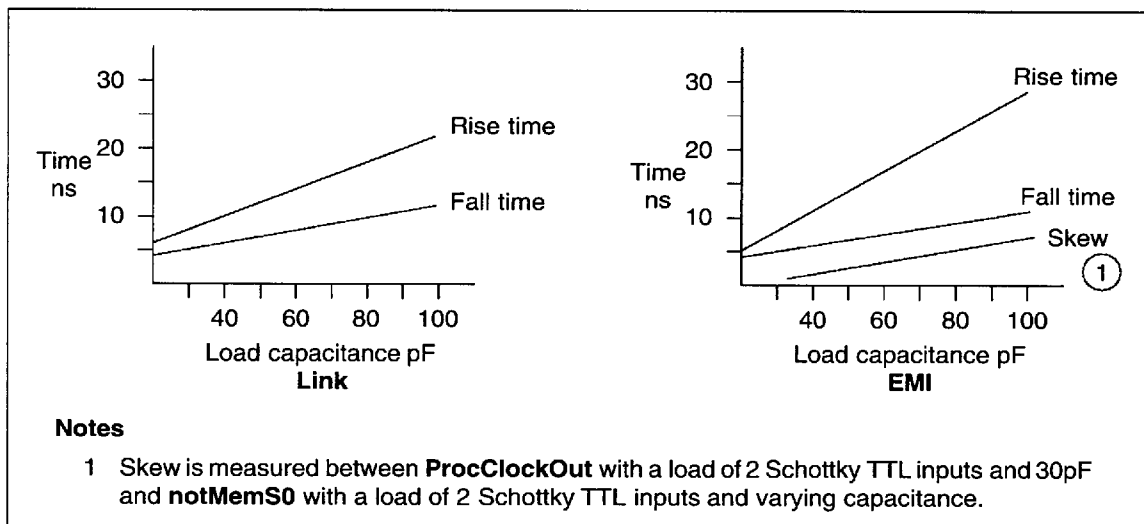


Figure 8.5 Typical rise/fall times

## 8.4 Power rating

Internal power dissipation ( $P_{INT}$ ) of transputer and peripheral chips depends on  $V_{DD}$ , as shown in figure 8.6.  $P_{INT}$  is substantially independent of temperature.

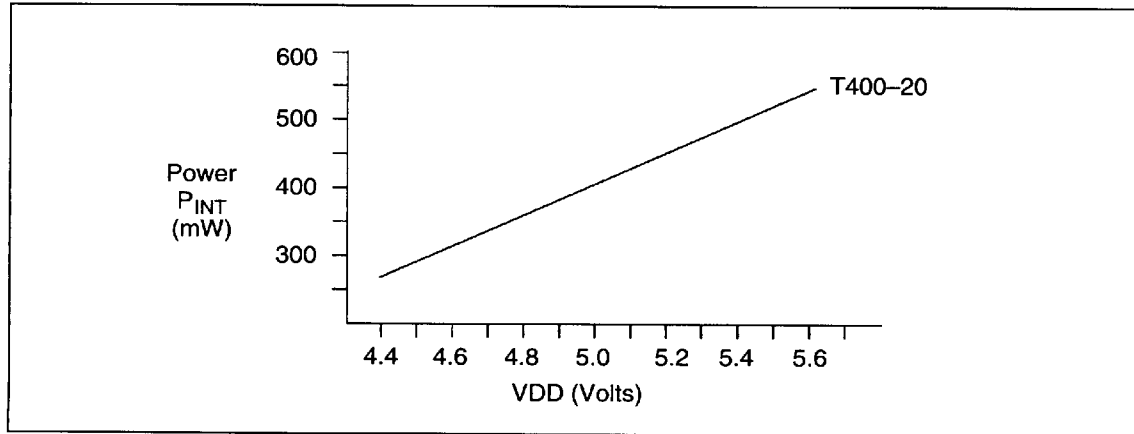


Figure 8.6 IMS T400 internal power dissipation vs  $V_{DD}$

Total power dissipation ( $P_D$ ) of the chip is

$$P_D = P_{INT} + P_{IO}$$

where  $P_{IO}$  is the power dissipation in the input and output pins; this is application dependent.

Internal working temperature  $T_J$  of the chip is

$$T_J = T_A + \theta_{JA} * P_D$$

where  $T_A$  is the external ambient temperature in  $^{\circ}\text{C}$  and  $\theta_{JA}$  is the junction-to-ambient thermal resistance in  $^{\circ}\text{C/W}$ .

Further information about device thermal characteristics can be found in section 9.5.



## 9 Package details

### 9.1 84 pin grid array package

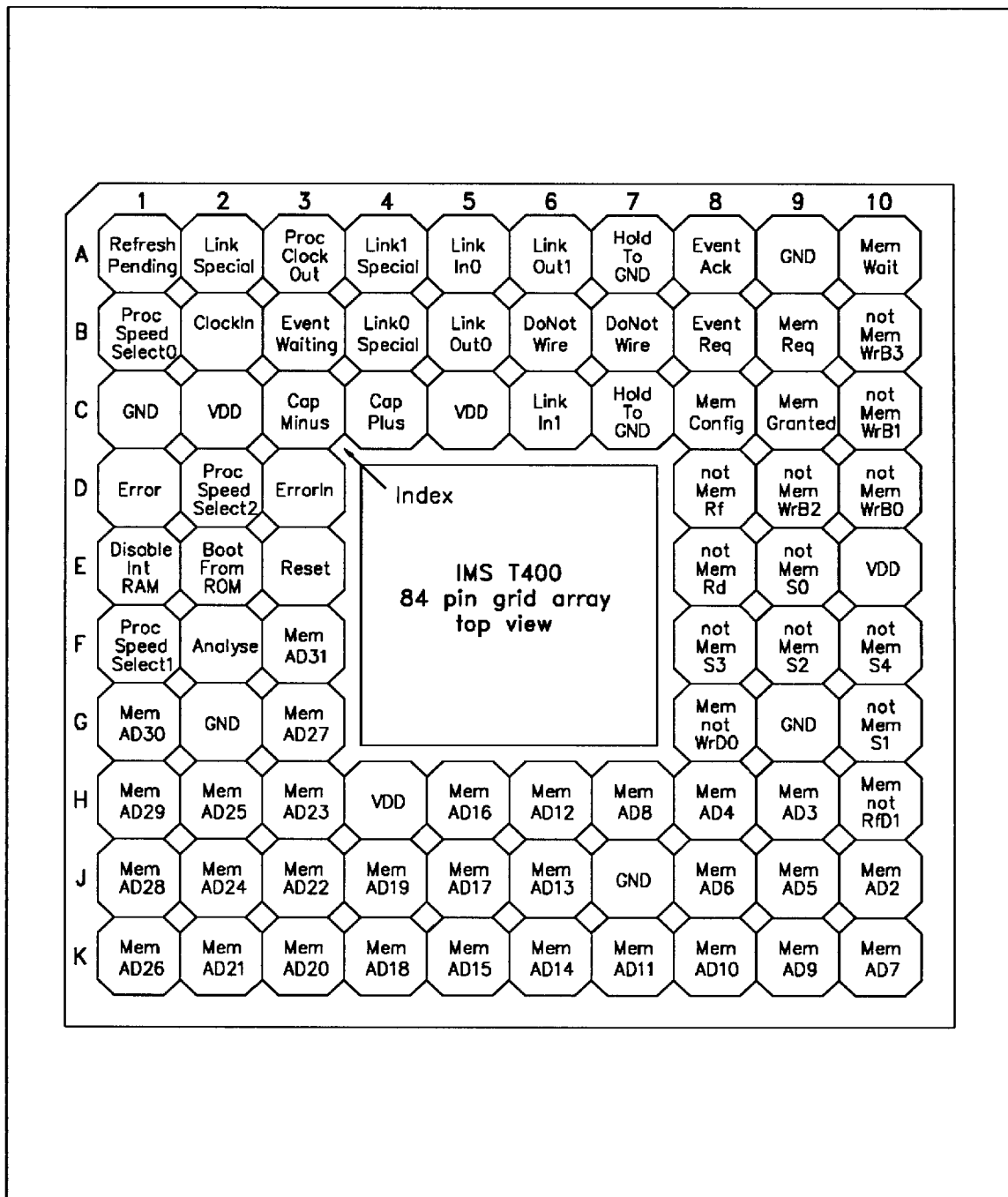


Figure 9.1 IMS T400 84-pin PGA package pinout

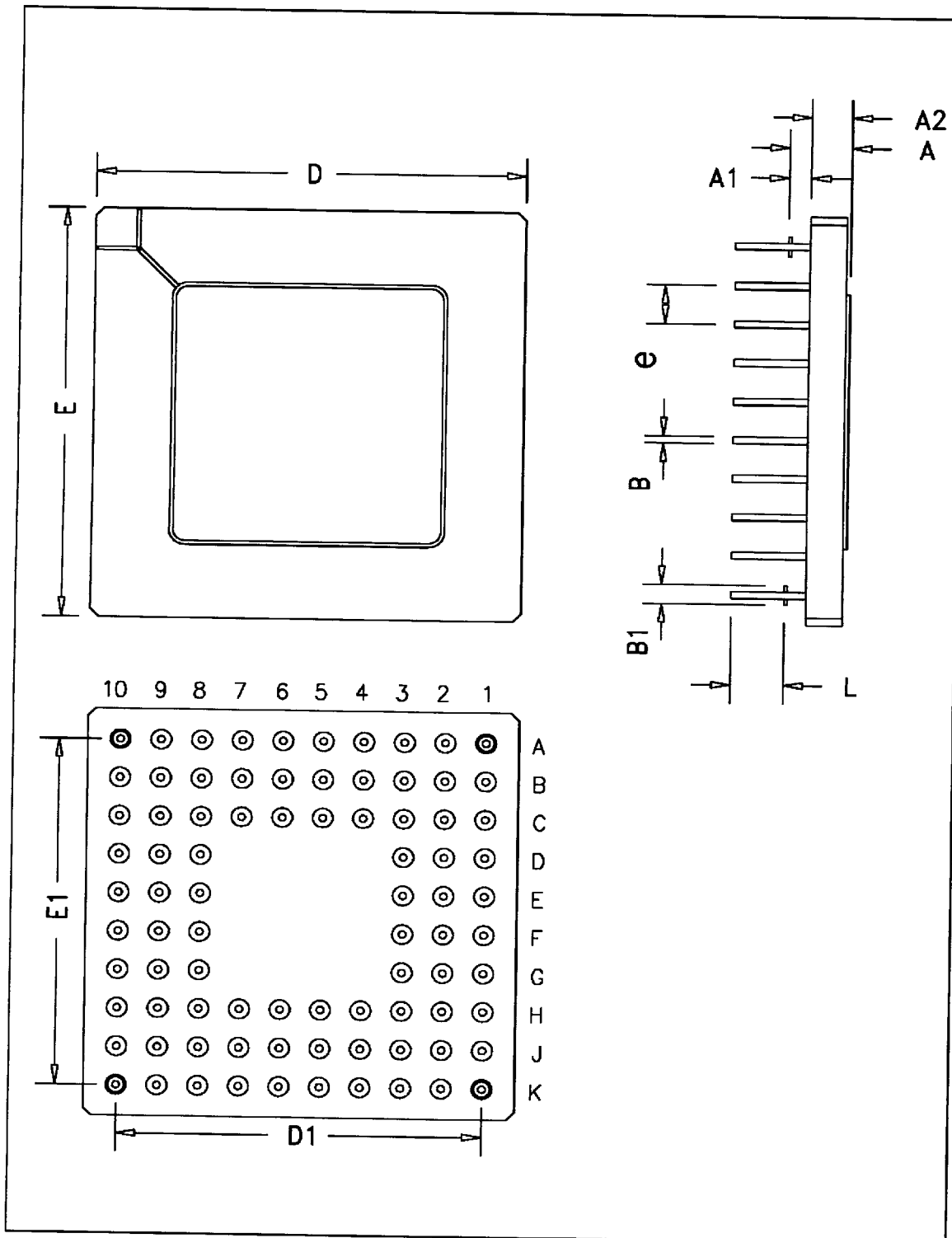


Figure 9.2 IMS T400 84-pin PGA package dimensions

## 9 Package details

### DIMENSIONS

| REF. | CONTROL DIM. INCHES |       |       | ALTERNATIVE DIM. mm |        |        | Notes |
|------|---------------------|-------|-------|---------------------|--------|--------|-------|
|      | Min                 | Nom   | Max   | Min                 | Nom    | Max    |       |
| A    | 0.135               | 0.147 | 0.160 | 3.429               | 3.734  | 4.064  | REF   |
| A1   | —                   | 0.050 | —     | —                   | 1.270  | —      |       |
| A2   | 0.085               | 0.097 | 0.110 | 2.159               | 2.464  | 2.794  |       |
| B    | 0.016               | 0.018 | 0.020 | 0.406               | 0.457  | 0.508  | REF   |
| B1   | —                   | 0.050 | —     | —                   | 1.270  | —      |       |
| D    | 1.050               | 1.060 | 1.070 | 26.670              | 26.924 | 27.178 |       |
| D1   | —                   | 0.900 | —     | —                   | 22.860 | —      | REF   |
| E    | 1.050               | 1.060 | 1.070 | 26.670              | 26.924 | 27.178 |       |
| E1   | —                   | 0.900 | —     | —                   | 22.860 | —      |       |
| e    | —                   | 0.100 | —     | —                   | 2.540  | —      | BSC   |
| L    | 0.120               | 0.130 | 0.140 | 3.048               | 3.302  | 3.556  |       |

#### Notes:

- 1 Lead finish to be 60  $\mu$ inch min. Au on 80  $\mu$ inch Ni plate, for commercial, and 100  $\mu$ inch min. Au on 80  $\mu$ inch Ni plate, for military applications.
- 2 Maximum lead displacement from the notional centre line will be no greater than + 0.005 inch.

## 9.2 84 pin PLCC package

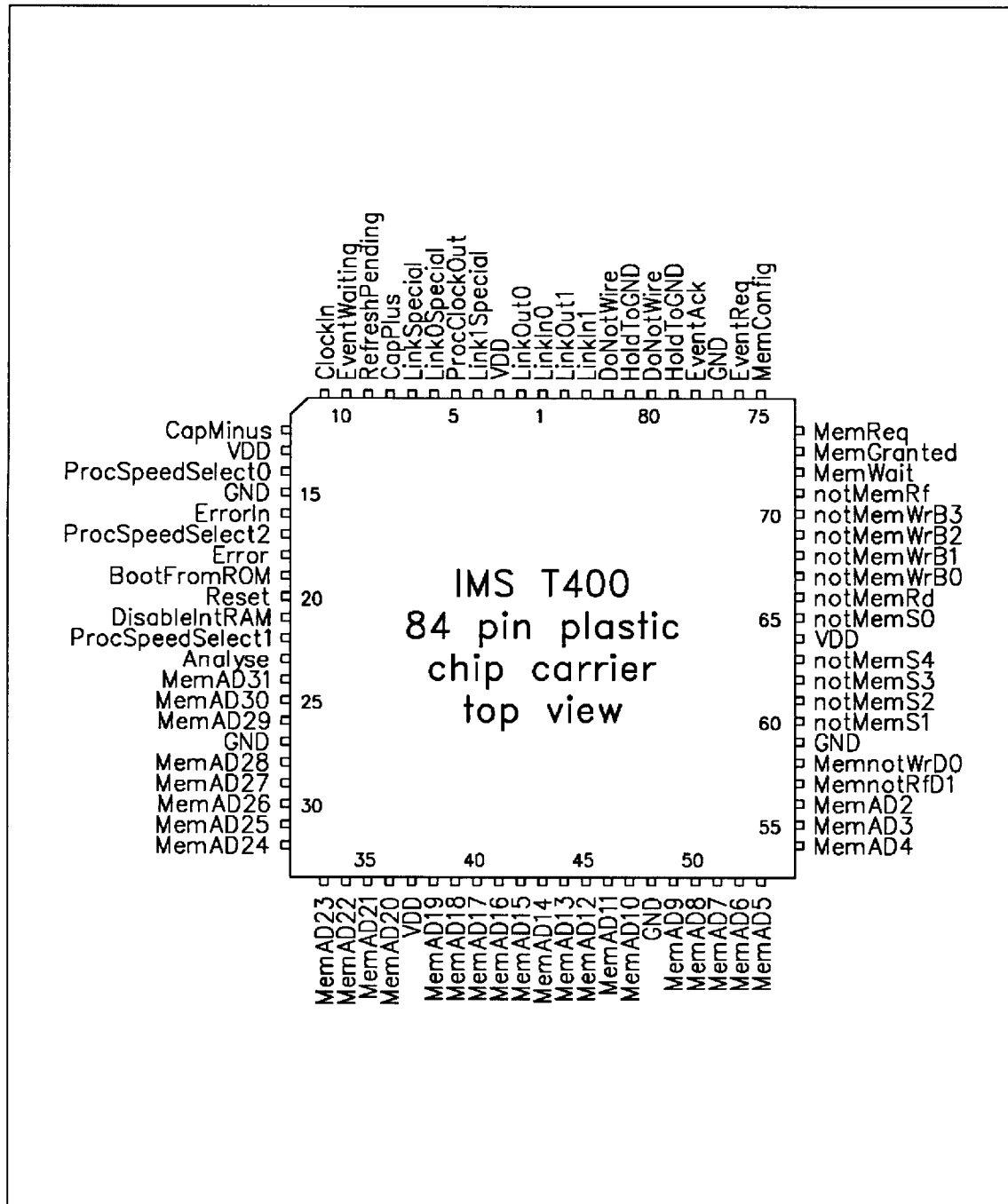


Figure 9.3 IMS T400 84-pin PLCC package pinout

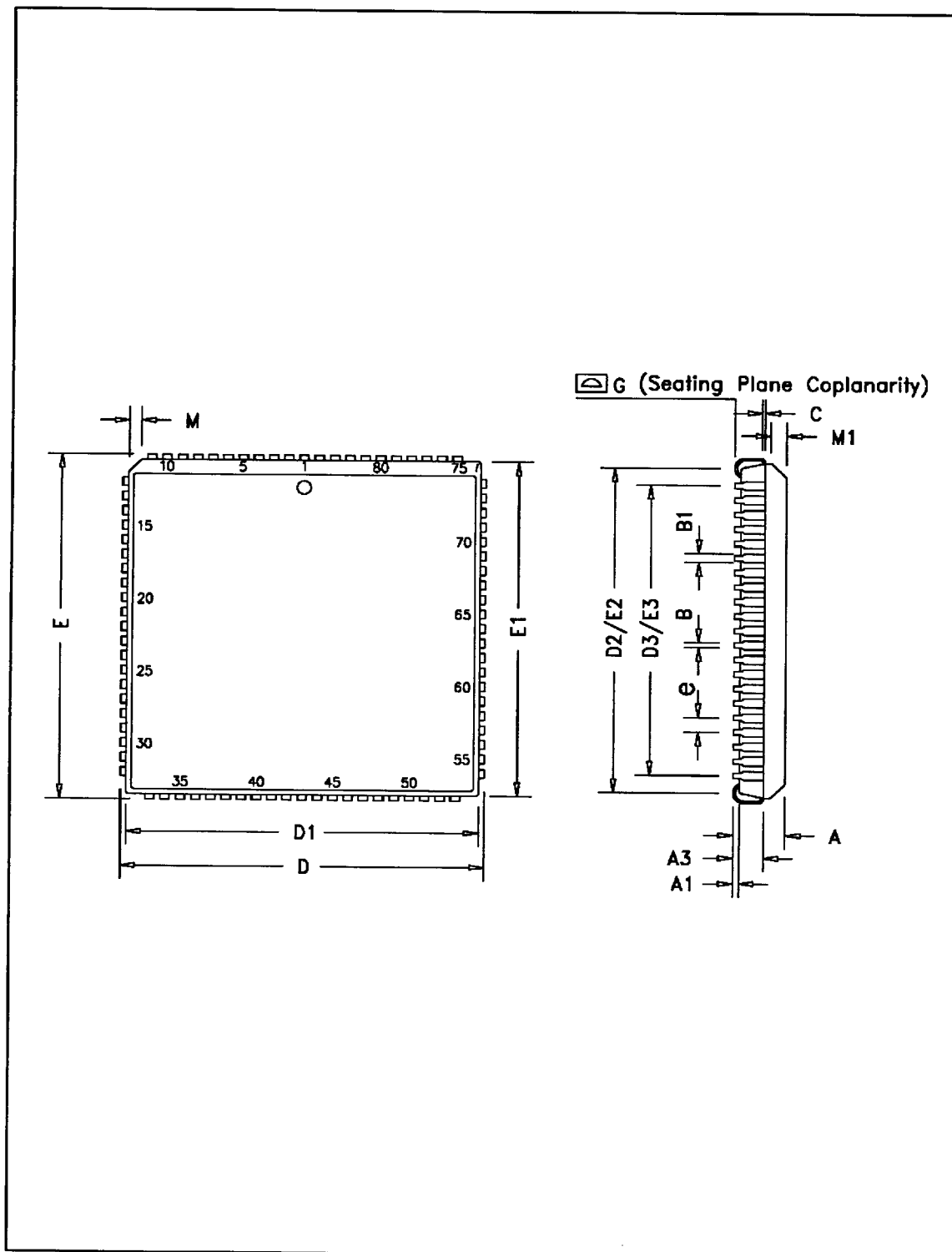


Figure 9.4 IMS T400 84-pin PLCC package dimensions

## DIMENSIONS

| REF. | CONTROL DIM. INCHES |       |        | ALTERNATIVE DIM. mm |        |        | Notes |
|------|---------------------|-------|--------|---------------------|--------|--------|-------|
|      | Min                 | Nom   | Max    | Min                 | Nom    | Max    |       |
| A    | 0.165               | 0.170 | 0.200  | 4.191               | 4.318  | 5.080  | REF   |
| A1   | 0.020               | —     | —      | 0.508               | —      | —      |       |
| A3   | 0.090               | —     | 0.130  | 2.290               | —      | 3.302  |       |
| B    | 0.013               | —     | 0.023  | 0.330               | —      | 0.584  |       |
| B1   | 0.025               | —     | 0.035  | 0.635               | —      | 0.889  |       |
| C    | 0.0075              | 0.008 | 0.0085 | 0.191               | 0.203  | 0.216  |       |
| D    | 1.185               | 1.190 | 1.195  | 30.099              | 30.266 | 30.353 |       |
| D1   | 1.150               | 1.155 | 1.160  | 29.210              | 29.337 | 29.464 |       |
| D2   | 1.090               | 1.120 | 1.130  | 27.686              | 28.488 | 28.702 |       |
| D3   | —                   | 1.000 | —      | —                   | 24.400 | —      |       |
| E    | 1.185               | 1.190 | 1.195  | 30.099              | 30.266 | 30.353 |       |
| E1   | 1.150               | 1.155 | 1.160  | 29.210              | 29.337 | 29.464 |       |
| E2   | 1.090               | 1.120 | 1.130  | 27.686              | 28.488 | 28.702 |       |
| E3   | —                   | 1.000 | —      | —                   | 25.400 | —      | REF   |
| e    | —                   | 0.050 | —      | —                   | 1.270  | —      | BSC   |
| G    | —                   | —     | 0.004  | —                   | —      | 0.102  |       |
| M    | 0.042               | —     | 0.048  | 1.067               | —      | 1.219  |       |
| M1   | 0.042               | —     | 0.056  | 1.067               | —      | 1.422  |       |

## Notes:

- 1 Lead finish to be 60 Sn/40 Pb solder plate.
- 2 Maximum lead displacement from the notional centre line will be no greater than +0.007 inches

## 9.3 100 pin plastic quad flat pack (PQFP) package

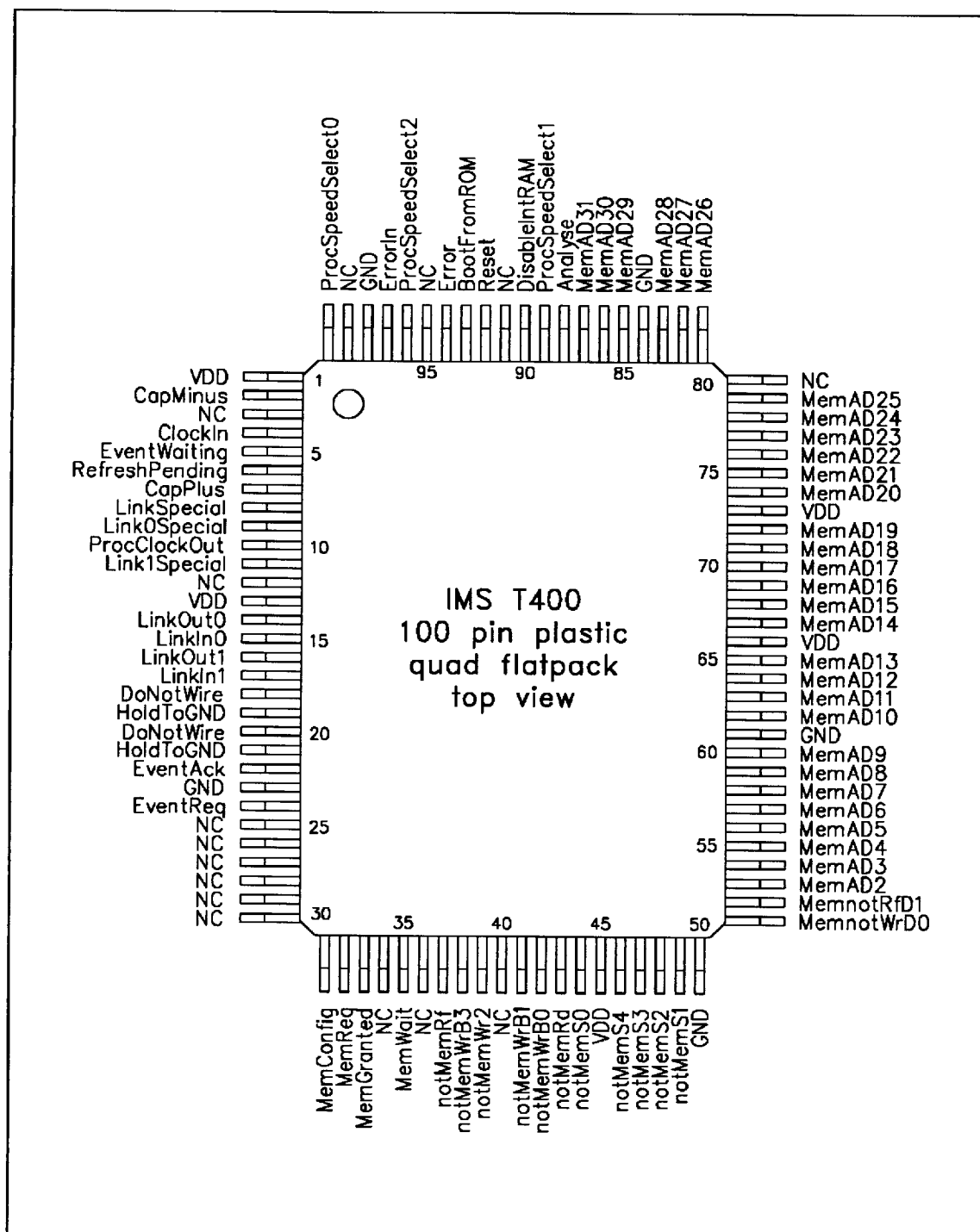


Figure 9.5 IMS T400 100-pin PQFP package pinout

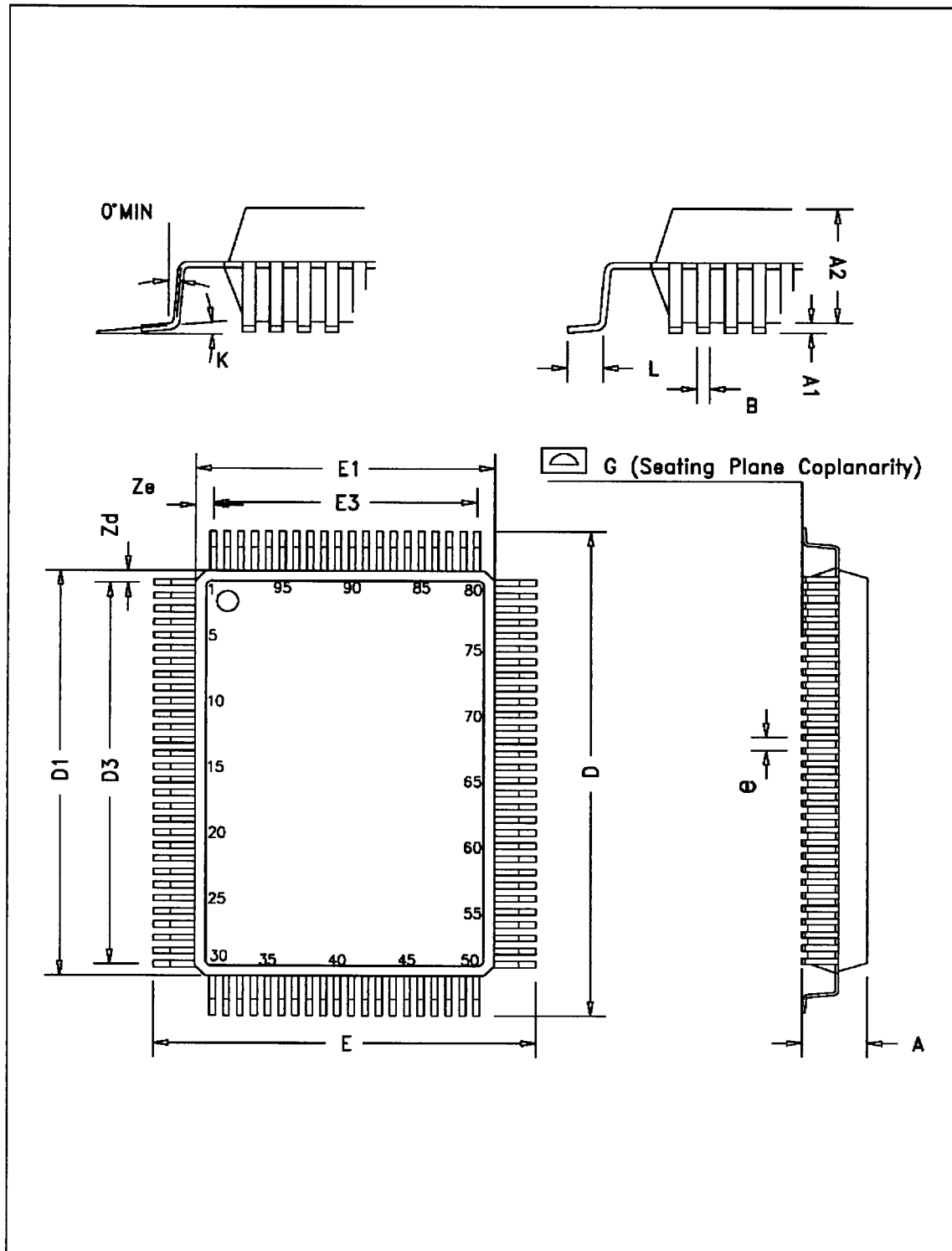


Figure 9.6 IMS T400 100-pin PQFP package dimensions



## 9 Package details

### DIMENSIONS

| REF. | CONTROL DIM. mm |        |        | ALTERNATIVE DIM. INCHES |       |       | Notes |
|------|-----------------|--------|--------|-------------------------|-------|-------|-------|
|      | Min             | Nom    | Max    | Min                     | Nom   | Max   |       |
| A    | —               | —      | 3.400  | —                       | —     | 0.134 | REF   |
| A1   | 0.100           | —      | —      | 0.004                   | —     | —     |       |
| A2   | 2.540           | 2.800  | 3.050  | 0.096                   | 0.110 | 0.120 |       |
| B    | 0.220           | —      | 0.380  | 0.009                   | —     | 0.015 |       |
| C    | 0.130           | —      | 0.230  | 0.005                   | —     | 0.009 |       |
| D    | 22.950          | —      | 24.150 | 0.904                   | —     | 0.951 |       |
| D1   | 19.900          | 20.000 | 20.100 | 0.783                   | 0.787 | 0.791 |       |
| D3   | —               | 18.850 | —      | —                       | 0.742 | —     |       |
| E    | 16.950          | —      | 18.150 | 0.667                   | —     | 0.715 |       |
| E1   | 13.900          | 14.000 | 14.100 | 0.547                   | 0.551 | 0.555 |       |
| E3   | —               | 12.350 | —      | —                       | 0.486 | —     | REF   |
| e    | —               | 0.650  | —      | —                       | 0.026 | —     | BSC   |
| G    | —               | —      | 0.100  | —                       | —     | 0.004 |       |
| K    | 05              | —      | 75     | 05                      | —     | 75    |       |
| L    | 0.650           | 0.800  | 0.950  | 0.026                   | 0.031 | 0.037 |       |
| Zd   | —               | 0.580  | —      | —                       | 0.23  | —     | REF   |
| Ze   | —               | 0.830  | —      | —                       | 0.033 | —     | REF   |

#### Notes:

- 1 Lead finish to be 60 Sn/40 Pb solder plate.
- 2 Maximum lead displacement from the notional centre line will be no greater than + 0.125 mm.

#### 9.4 100 pin thin plastic quad flat pack (TQFP) package

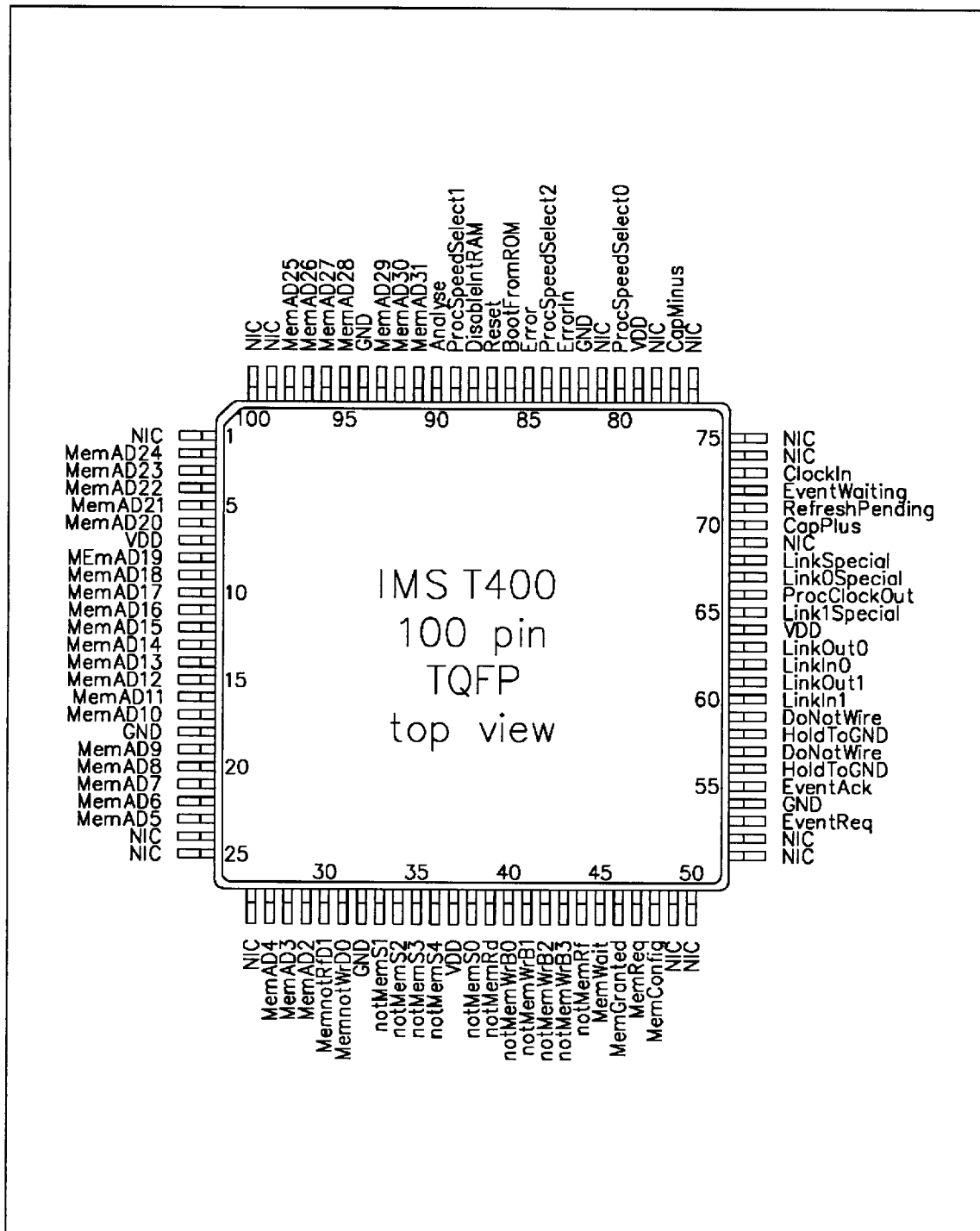


Figure 9.7 IMS T400 100-pin thin plastic quad flatpack (TQFP) package pinout

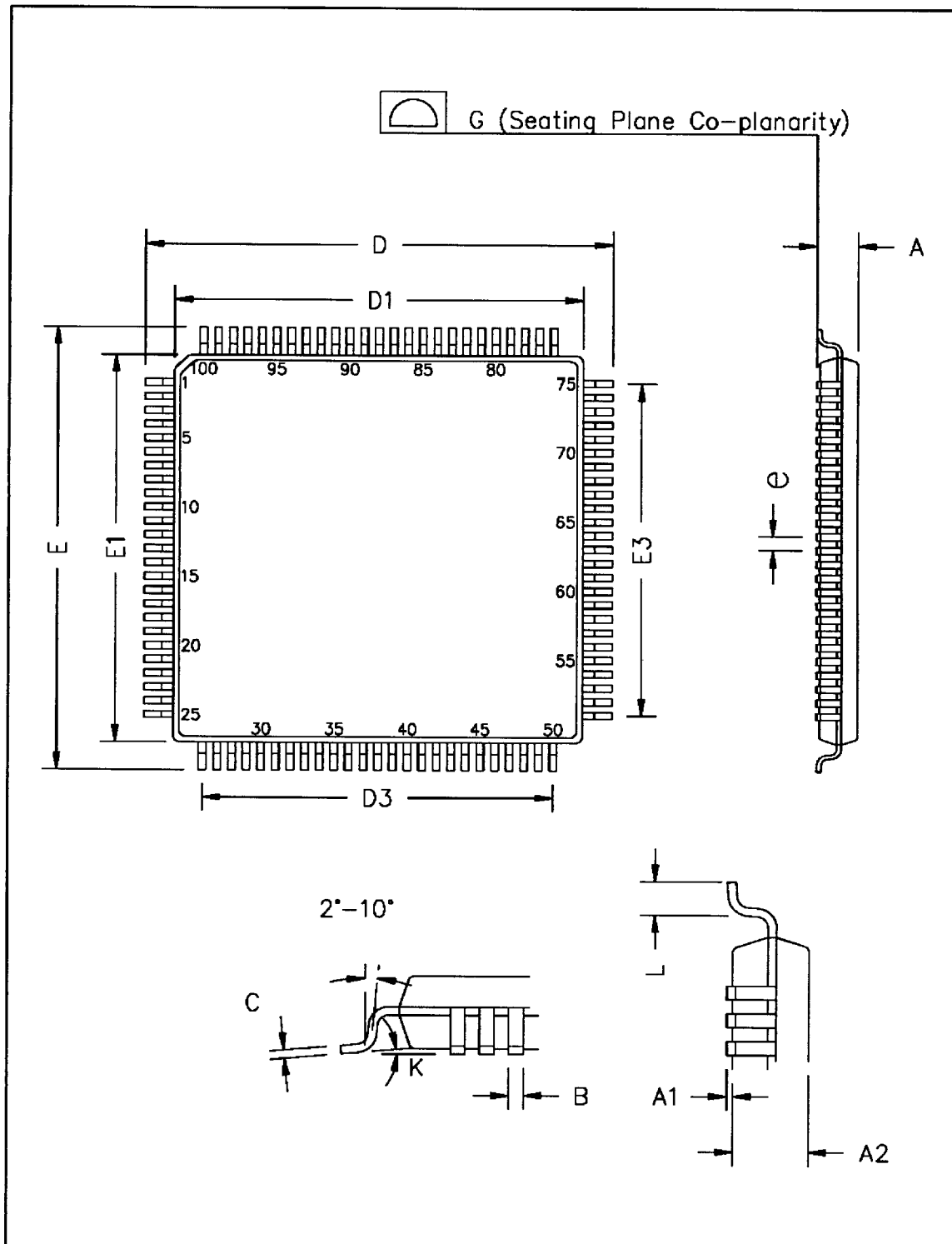


Figure 9.8 IMS T400 100-pin TQFP package dimensions

## DIMENSIONS

| REF. | CONTROL DIM. mm |       |       | ALTERNATIVE DIM. INCHES |       |        | Notes |
|------|-----------------|-------|-------|-------------------------|-------|--------|-------|
|      | Min             | Nom   | Max   | Min                     | Nom   | Max    |       |
| A    | —               | —     | 1.60  | —                       | —     | 0.063  | REF   |
| A1   | 0.05            | —     | 0.15  | 0.002                   | —     | 0.006  |       |
| A2   | 1.35            | 1.4   | 1.45  | 0.053                   | 0.055 | 0.057  |       |
| B    | 0.17            | —     | 0.27  | 0.007                   | —     | 0.011  |       |
| C    | —               | —     | 0.17  | —                       | —     | 0.007  |       |
| D    | 15.75           | 16.00 | 16.25 | 0.620                   | 0.630 | 0.640  |       |
| D1   | 13.95           | 14.00 | 14.05 | 0.549                   | 0.551 | 0.553  |       |
| D3   | —               | 12.00 | —     | —                       | 0.472 | —      |       |
| E    | 15.75           | 16.00 | 16.25 | 0.620                   | 0.630 | 0.640  |       |
| E1   | 13.95           | 14.00 | 14.05 | 0.549                   | 0.551 | 0.553  |       |
| E3   | —               | 12.00 | —     | —                       | 0.472 | —      |       |
| e    | —               | 0.500 | —     | —                       | 0.020 | —      |       |
| G    | —               | —     | 0.08  | —                       | —     | 0.0032 |       |
| K    | 05              | —     | 75    | 05                      | —     | 75     |       |
| L    | 0.50            | 0.60  | 0.75  | 0.020                   | 0.024 | 0.030  |       |
|      |                 |       |       |                         |       |        | BSC   |

**Notes:**

- 1 Lead finish to be 60Sn/40Pb solder plate.
- 2 Maximum lead displacement from the notional centre line will be no greater than + 0.08mm.

**9.5 Thermal specification**

The IMS T400 is tested to a maximum silicon temperature of 100 °C. For operation within the given specifications, the case temperature should not exceed 85 °C.

For temperatures above 85 °C the operation of the device cannot be guaranteed and reliability may be impaired.

For further information on reliability refer to the SGS-THOMSON Microelectronics Quality and Reliability Program.

## 10 Ordering

This section indicates the designation of speed and package selections for the various devices. Speed of **ClockIn** is 5 MHz for all parts. Transputer processor cycle time is nominal; it can be calculated more exactly using the phase lock loop factor **PLLx**, as detailed in the external memory section.

For availability contact your local SGS-THOMSON sales office or authorized distributor.

| SGS-THOMSON designation | Processor clock speed | Processor cycle time | PLLx | Package                             |
|-------------------------|-----------------------|----------------------|------|-------------------------------------|
| IMS T400-G20S           | 20.0 MHz              | 50 ns                | 4.0  | 84 pin ceramic pin grid array       |
| IMS T400-J20S           | 20.0 MHz              | 50 ns                | 4.0  | 84 pin plastic PLCC J-Bend          |
| IMS T400-X20I           | 20.0 MHz              | 50 ns                | 4.0  | 100 pin plastic quad flat pack      |
| IMS T400-T20S           | 20.0 MHz              | 50 ns                | 4.0  | 100 pin thin plastic quad flat pack |

Table 10.1 IMS T400 ordering details

## 11 Transputer instruction set summary

### 11.1 Introduction

The Function Codes table 11.9 (page 66) gives the basic function code set. Where the operand value is less than 16, a single byte encodes the complete instruction. If the operand value is greater than 15, one prefix instruction (*prefix*) is required for each additional four bits of the operand. If the operand is negative the first prefix instruction will be *nfix*. Examples of prefix coding are given in table 11.1.

| Mnemonic                                                        | Function code | Memory code |
|-----------------------------------------------------------------|---------------|-------------|
| <i>ldc</i> #3                                                   | #4            | #43         |
| <i>ldc</i> #35                                                  |               |             |
| <b>is coded as</b>                                              |               |             |
| <i>prefix</i> #3                                                | #2            | #23         |
| <i>ldc</i> #5                                                   | #4            | #45         |
| <i>ldc</i> #987                                                 |               |             |
| <b>is coded as</b>                                              |               |             |
| <i>prefix</i> #9                                                | #2            | #29         |
| <i>prefix</i> #8                                                | #2            | #28         |
| <i>ldc</i> #7                                                   | #4            | #47         |
| <i>ldc</i> -31 ( <i>ldc</i> #FFFFFFE1)<br>( <i>ldc</i> #FFE1) † |               |             |
| <b>is coded as</b>                                              |               |             |
| <i>nfix</i> #1                                                  | #6            | #61         |
| <i>ldc</i> #1                                                   | #4            | #41         |
| † IMS T222, IMS T225                                            |               |             |

Table 11.1 *prefix* coding

Tables 11.10 to 11.30 (pages 66–73) give details of the operation codes. Where an operation code is less than 16 (e.g. *add*: operation code 05), the operation can be stored as a single byte comprising the *operate* function code F and the operand (5 in the example). Where an operation code is greater than 15 (e.g. *ladd*: operation code 16), the *prefix* function code 2 is used to extend the instruction.

| Mnemonic                           | Function code | Memory code |
|------------------------------------|---------------|-------------|
| <i>add</i> ( <i>op. code</i> #5)   |               | #F5         |
| <b>is coded as</b>                 |               |             |
| <i>opr</i> add                     | #F            | #F5         |
| <i>ladd</i> ( <i>op. code</i> #16) |               | #21F6       |
| <b>is coded as</b>                 |               |             |
| <i>prefix</i> #1                   | #2            | #21         |
| <i>opr</i> #6                      | #F            | #F6         |

Table 11.2 *operate* coding

## 11 Transputer instruction set summary

### 11.1.1 Product identity numbers

The load device identity (*lddevia*) instruction (table 11.10) pushes the device type identity into the A register. Each product is allocated a unique group of numbers for use with the *lddevia* instruction. Product identity numbers are given in table 11.3.

| Product  | Identity numbers   |
|----------|--------------------|
| IMS T425 | 0 to 9 inclusive   |
| IMS T805 | 10 to 19 inclusive |
| IMS T225 | 40 to 49 inclusive |
| IMS T400 | 50 to 59 inclusive |

Table 11.3 Product identity numbers

### 11.1.2 Floating point unit

In the floating point unit (FPU) basic addition, subtraction, multiplication and division operations are performed by single instructions. However, certain less frequently used floating point instructions are selected by a value in register A (when allocating registers, this should be taken into account). A *load constant* instruction *ldc* is used to load register A; the *floating point entry* instruction *fentry* then uses this value to select the floating point operation. This pair of instructions is termed a *selector sequence*.

In the Floating Point Operation Codes tables 11.23 to 11.29, a selector sequence code is indicated in the Memory Code column by **s**. The code given in the Operation Code column is the indirection code, the operand for the *ldc* instruction.

The FPU and processor operate concurrently, so the actual throughput of floating point instructions is better than that implied by simply adding up the instruction times. For full details see *Transputer Instruction Set – A Compiler Writer's Guide*.

### 11.1.3 Notation

The Processor Cycles column refers to the number of periods **TPCLPCL** (refer to **ProcClockOut**) taken by an instruction executing in internal memory. The number of cycles is given for the basic operation only; where the memory code for an instruction is two bytes, the time for the *prefix* function (one cycle) should be added. Some instruction times vary. Where a letter is included in the cycles column it is interpreted from table 11.4.

| Ident                        | Interpretation                                                                                                                                                                                    |
|------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>b</b>                     | Bit number of the highest bit set in register <b>A</b> . Bit 0 is the least significant bit.                                                                                                      |
| <b>m</b> †                   | Bit number of the highest bit set in the absolute value of register <b>A</b> . Bit 0 is the least significant bit.                                                                                |
| <b>n</b>                     | Number of places shifted.                                                                                                                                                                         |
| <b>w</b>                     | Number of words in the message. Part words are counted as full words. If the message is not word aligned the number of words is increased to include the part words at either end of the message. |
| <b>p</b> †                   | Number of words per row.                                                                                                                                                                          |
| <b>r</b> †                   | Number of rows.                                                                                                                                                                                   |
| † does not apply to IMS T225 |                                                                                                                                                                                                   |

Table 11.4 Instruction set interpretation

The **DEF** column of the tables indicates the descheduling/error features of an instruction as described in table .

| Ident                      | Feature                                              | See section: |
|----------------------------|------------------------------------------------------|--------------|
| <b>D</b>                   | The instruction is a descheduling point              | 11.2         |
| <b>E</b>                   | The instruction will affect the <b>Error</b> flag    | 11.3         |
| <b>F †</b>                 | The instruction will affect the <b>FP_Error</b> flag | 11.6         |
| † applies to IMS T805 only |                                                      |              |

Table 11.5 Instruction features

## 11.2 Descheduling points

The instructions in table 11.6 are the only ones at which a process may be descheduled. They are also the ones at which the processor will halt if the **Analyse** pin is asserted (refer to **Analyse** section).

|                       |                       |                      |                      |
|-----------------------|-----------------------|----------------------|----------------------|
| <i>input message</i>  | <i>output message</i> | <i>output byte</i>   | <i>output word</i>   |
| <i>timer alt wait</i> | <i>timer input</i>    | <i>stop on error</i> | <i>alt wait</i>      |
| <i>jump</i>           | <i>loop end</i>       | <i>end process</i>   | <i>start process</i> |

Table 11.6 Descheduling point instructions

## 11.3 Error instructions

The instructions in table 11.7 are the only ones which can affect the *Error* flag directly. Note, however, that the floating point unit error flag *FP\_Error* is set by certain floating point instructions (section 11.6), and that *Error* can be set from this flag by *fpcheckerror*.

|                              |                               |                       |                           |
|------------------------------|-------------------------------|-----------------------|---------------------------|
| <i>add</i>                   | <i>add constant</i>           | <i>subtract</i>       |                           |
| <i>multiply</i>              | <i>fractional multiply †</i>  | <i>divide</i>         | <i>remainder</i>          |
| <i>long add</i>              | <i>long subtract</i>          | <i>long divide</i>    |                           |
| <i>set error</i>             | <i>testerr</i>                | <i>fpcheckerror ‡</i> |                           |
| <i>check word</i>            | <i>check subscript from 0</i> | <i>check single</i>   | <i>check count from 1</i> |
| † does not apply to IMS T225 |                               |                       |                           |
| ‡ applies to IMS T805 only   |                               |                       |                           |

Table 11.7 Error setting instructions

## 11.4 Debugging support

Table 11.20 (page 70) contains a number of instructions to facilitate the implementation of breakpoints. These instructions overload the operation of *j0*. Normally *j0* is a no-op which might cause descheduling. *Setj0break* enables the breakpointing facilities and causes *j0* to act as a breakpointing instruction. When breakpointing is enabled, *j0* swaps the current **Ip**tr and **Wp**tr with an **Ip**tr and **Wp**tr stored above MemS-tart. The *break* instruction does not cause descheduling, and preserves the state of the registers. It is possible to single step the processor at machine level using these instructions. Refer to *Support for debugging/breakpointing in transputers* (technical note 61) for more detailed information regarding debugger support.

## 11.5 Block move

The block move instructions (Table 11.21) move any number of bytes from any byte boundary in memory, to any other byte boundary, using the smallest possible number of word read, and word or part-word writes.



## 11 Transputer instruction set summary

A block move instruction can be interrupted by a high priority process. On interrupt, block move is completed to a word boundary, independent of start position. When restarting after interrupt, the last word written is written again. This appears as an unnecessary read and write in the simplest case of word aligned block moves, and may cause problems with FIFOs. This problem can be overcome by incrementing the saved destination (**BregIntSaveLoc**) and source pointer (**CregIntSaveLoc**) values by BytesPerWord during the high priority process.

### 11.6 Floating point errors (IMS T805 only)

The FPU has its own error flag *FP\_Error*. This reflects the state of evaluation within the FPU and is set in circumstances where invalid operations, division by zero or overflow exceptions to the ANSI-IEEE 754-1985 standard would be flagged. *FP\_Error* is also set if an input to a floating point operation is infinite or is not a number (NaN). The *FP\_Error* flag can be set, tested and cleared without affecting the main *Error* flag, but can also set *Error* when required. Depending on how a program is compiled, it is possible for both unchecked and fully checked floating point arithmetic to be performed.

The instructions in table 11.8 are the only ones which can affect the floating point error flag *FP\_Error*. *Error* is set from this flag by *fpcheckerror* if *FP\_Error* is set.

|                     |                      |                     |                   |
|---------------------|----------------------|---------------------|-------------------|
| <i>fpadd</i>        | <i>fpsub</i>         | <i>fpmul</i>        | <i>fpdiv</i>      |
| <i>fpdnladds</i>    | <i>fpdnladddb</i>    | <i>fpdnlmulsn</i>   | <i>fpdnlmuldb</i> |
| <i>fpemfirst</i>    | <i>fpusqrtfirst</i>  | <i>fpgt</i>         | <i>fpeq</i>       |
| <i>fpuseterror</i>  | <i>fpuclearerror</i> | <i>fpctesterror</i> |                   |
| <i>fpexpincby32</i> | <i>fpexpdecby32</i>  | <i>fpumulby2</i>    | <i>fpudivby2</i>  |
| <i>fpur32tor64</i>  | <i>fpur64tor32</i>   | <i>fpucki32</i>     | <i>fpucki64</i>   |
| <i>fpstoi32</i>     | <i>fpuabs</i>        | <i>fpint</i>        |                   |

Table 11.8 Floating point error setting instructions

### 11.7 General instructions

The following tables list the complete instruction set which is common to all variants of the transputer. Exceptions are noted at the bottom of each table by † or ‡.

| Function Code | Memory Code | Mnemonic | Processor Cycles | Name                         | DEF |
|---------------|-------------|----------|------------------|------------------------------|-----|
| 0             | 0X          | j        | 3                | jump                         | D   |
| 1             | 1X          | ldlp     | 1                | load local pointer           |     |
| 2             | 2X          | pflix    | 1                | prefix                       |     |
| 3             | 3X          | ldnl     | 2                | load non-local               |     |
| 4             | 4X          | ldc      | 1                | load constant                |     |
| 5             | 5X          | ldnlp    | 1                | load non-local pointer       |     |
| 6             | 6X          | nflix    | 1                | negative prefix              |     |
| 7             | 7X          | ldl      | 2                | load local                   |     |
| 8             | 8X          | adc      | 1                | add constant                 |     |
| 9             | 9X          | call     | 7                | call                         |     |
| A             | AX          | cj       | 2                | conditional jump (not taken) | E   |
|               |             |          | 4                | conditional jump (taken)     |     |
| B             | BX          | ajw      | 1                | adjust workspace             |     |
| C             | CX          | eqc      | 2                | equals constant              |     |
| D             | DX          | stl      | 1                | store local                  |     |
| E             | EX          | stnl     | 2                | store non-local              |     |
| F             | FX          | opr      | —                | operate                      |     |

Table 11.9 Function codes

| Operation Code | Memory Code | Mnemonic      | Processor Cycles | Name                               | DEF |
|----------------|-------------|---------------|------------------|------------------------------------|-----|
| 2A             | 22FA        | testpranal    | 2                | test processor analyzing           |     |
| 3E             | 23FE        | saveh         | 4                | save high priority queue registers |     |
| 3D             | 23FD        | savel         | 4                | save low priority queue registers  |     |
| 18             | 21F8        | sthf          | 1                | store high priority front pointer  |     |
| 50             | 25F0        | sthb          | 1                | store high priority back pointer   |     |
| 1C             | 21FC        | stlf          | 1                | store low priority front pointer   |     |
| 17             | 21F7        | stlb          | 1                | store low priority back pointer    |     |
| 54             | 25F4        | sttimer       | 1                | store timer                        |     |
| 17C            | 2127FC      | lddevid       | 1                | load device identity               |     |
| 7E             | 27FE        | ldmemstartval | 1                | load value of memstart address     |     |

Table 11.10 Processor initialisation operation codes



| Operation Code | Memory Code | Mnemonic | Processor Cycles | Name                   | DEF                                |
|----------------|-------------|----------|------------------|------------------------|------------------------------------|
| 00             | F0          | rev      | 1                | reverse                | E<br><br><br><br><br><br><br><br>E |
| 3A             | 23FA        | xword    | 4                | extend to word         |                                    |
| 56             | 25F6        | cword    | 5                | check word             |                                    |
| 1D             | 21FD        | xdbl     | 2                | extend to double       |                                    |
| 4C             | 24FC        | csngl    | 3                | check single           |                                    |
| 42             | 24F2        | mint     | 1                | minimum integer        |                                    |
| 5A             | 25FA        | dup      | 1                | duplicate top of stack |                                    |
| 79             | 27F9        | pop      | 1                | pop processor stack    |                                    |

Table 11.13 General operation codes

| Operation Code | Memory Code | Mnemonic | Processor Cycles |                | Name                       | DEF |
|----------------|-------------|----------|------------------|----------------|----------------------------|-----|
|                |             |          | 16-bit devices   | 32-bit devices |                            |     |
| 02             | F2          | bsub     | 1                | 1              | byte subscript             |     |
| 0A             | FA          | wsb      | 2                | 2              | word subscript             |     |
| 81 †           | 28F1        | wsbdb    | 3                | 3              | form double word subscript |     |
| 34             | 23F4        | bcnt     | 2                | 2              | byte count                 |     |
| 3F             | 23FF        | wcnt     | 4                | 5              | word count                 |     |
| 01             | F1          | lb       | 5                | 5              | load byte                  |     |
| 3B             | 23FB        | sb       | 4                | 4              | store byte                 |     |
| 4A             | 24FA        | move     | 2w+8             | 2w+8           | move message               |     |

† does not apply to IMS T225

Table 11.14 Indexing/array operation codes

| Operation Code | Memory Code | Mnemonic | Processor Cycles | Name                         | DEF         |
|----------------|-------------|----------|------------------|------------------------------|-------------|
| 22             | 22F2        | ldtimer  | 2                | load timer                   | D<br>D<br>D |
| 2B             | 22FB        | tin      | 30               | timer input (time future)    |             |
|                |             |          | 4                | timer input (time past)      |             |
| 4E             | 24FE        | talt     | 4                | timer alt start              | D<br>D      |
| 51             | 25F1        | taltwt   | 15               | timer alt wait (time past)   |             |
|                |             |          | 48               | timer alt wait (time future) |             |
| 47             | 24F7        | enbt     | 8                | enable timer                 |             |
| 2E             | 22FE        | dist     | 23               | disable timer                |             |

Table 11.15 Timer handling operation codes

## 11 Transputer instruction set summary

| Operation Code | Memory Code | Mnemonic | Processor Cycles | Name                         | DEF |
|----------------|-------------|----------|------------------|------------------------------|-----|
| 07             | F7          | in       | 2w+19            | input message                | D   |
| 0B             | FB          | out      | 2w+19            | output message               | D   |
| 0F             | FF          | outword  | 23               | output word                  | D   |
| 0E             | FE          | outbyte  | 23               | output byte                  | D   |
| 43             | 24F3        | alt      | 2                | alt start                    | D   |
| 44             | 24F4        | altwt    | 5                | alt wait (channel ready)     |     |
|                |             |          | 17               | alt wait (channel not ready) |     |
| 45             | 24F5        | altend   | 4                | alt end                      | D   |
| 49             | 24F9        | enbs     | 3                | enable skip                  |     |
| 30             | 23F0        | diss     | 4                | disable skip                 |     |
| 12             | 21F2        | resetch  | 3                | reset channel                |     |
| 48             | 24F8        | enbc     | 7                | enable channel (ready)       |     |
|                |             |          | 5                | enable channel (not ready)   |     |
| 2F             | 22FF        | disc     | 8                | disable channel              |     |

Table 11.16 Input/output operation codes

| Operation Code | Memory Code | Mnemonic | Processor Cycles | Name                        | DEF |
|----------------|-------------|----------|------------------|-----------------------------|-----|
| 20             | 22F0        | ret      | 5                | return                      |     |
| 1B             | 21FB        | ldpi     | 2                | load pointer to instruction |     |
| 3C             | 23FC        | gajw     | 2                | general adjust workspace    |     |
| 06             | F6          | gcall    | 4                | general call                |     |
| 21             | 22F1        | lend     | 10               | loop end (loop)             | D   |
|                |             |          | 5                | loop end (exit)             | D   |

Table 11.17 Control operation codes

| Operation Code | Memory Code | Mnemonic | Processor Cycles | Name                  | DEF |
|----------------|-------------|----------|------------------|-----------------------|-----|
| 0D             | FD          | startp   | 12               | start process         | D   |
| 03             | F3          | endp     | 13               | end process           |     |
| 39             | 23F9        | runp     | 10               | run process           |     |
| 15             | 21F5        | stopp    | 11               | stop process          |     |
| 1E             | 21FE        | ldpri    | 1                | load current priority |     |

Table 11.18 Scheduling operation codes

| Operation Code | Memory Code | Mnemonic     | Processor Cycles | Name                                  | DEF    |
|----------------|-------------|--------------|------------------|---------------------------------------|--------|
| 13             | 21F3        | csub0        | 2                | check subscript from 0                | E      |
| 4D             | 24FD        | ccnt1        | 3                | check count from 1                    | E      |
| 29             | 22F9        | testerr      | 2                | test error false and clear (no error) | E<br>D |
|                |             |              | 3                | test error false and clear (error)    |        |
| 10             | 21F0        | seterr       | 1                | set error                             |        |
| 55             | 25F5        | stoperr      | 2                | stop on error (no error)              |        |
| 57             | 25F7        | clrhaltterr  | 1                | clear halt-on-error                   | E<br>D |
| 58             | 25F8        | sethaltterr  | 1                | set halt-on-error                     |        |
| 59             | 25F9        | testhaltterr | 2                | test halt-on-error                    |        |

Table 11.19 Error handling operation codes

| Operation Code | Memory Code | Mnemonic      | Processor Cycles | Name                                  | DEF |
|----------------|-------------|---------------|------------------|---------------------------------------|-----|
| 0              | 00          | jump 0        | 3                | jump 0 (break not enabled)            | D   |
|                |             |               | 11               | jump 0 (break enabled, high priority) |     |
|                |             |               | 13               | jump 0 (break enabled, low priority)  |     |
| B1             | 2BF1        | break         | 9                | break (high priority)                 |     |
|                |             |               | 11               | break (low priority)                  |     |
| B2             | 2BF2        | clrj0break    | 1                | clear jump 0 break enable flag        |     |
| B3             | 2BF3        | setj0break    | 1                | set jump 0 break enable flag          |     |
| B4             | 2BF4        | testj0break   | 2                | test jump 0 break enable flag set     |     |
| 7A             | 27FA        | timerdisableh | 1                | disable high priority timer interrupt |     |
| 7B             | 27FB        | timerdisablel | 1                | disable low priority timer interrupt  |     |
| 7C             | 27FC        | timerenableh  | 6                | enable high priority timer interrupt  | D   |
| 7D             | 27FD        | timerenablel  | 6                | enable low priority timer interrupt   |     |

Table 11.20 Debugger support codes

| Operation Code               | Memory Code | Mnemonic       | Processor Cycles | Name                              | DEF |
|------------------------------|-------------|----------------|------------------|-----------------------------------|-----|
| 5B †                         | 25FB        | move2dinit     | 8                | initialise data for 2D block move |     |
| 5C †                         | 25FC        | move2dall      | (2p+23)*r        | 2D block copy                     |     |
| 5D †                         | 25FD        | move2dnnonzero | (2p+23)*r        | 2D block copy non-zero bytes      |     |
| 5E †                         | 25FE        |                | (2p+23)*r        | 2D block copy zero bytes          |     |
| † does not apply to IMS T225 |             |                |                  |                                   |     |

Table 11.21 2D block move operation codes

## 11 Transputer instruction set summary

| Operation Code | Memory Code | Mnemonic    | Processor Cycles | Name                          | DEF |
|----------------|-------------|-------------|------------------|-------------------------------|-----|
| 74             | 27F4        | crcword     | 35               | calculate crc on word         |     |
| 75             | 27F5        | crcbyte     | 11               | calculate crc on byte         |     |
| 76             | 27F6        | bitcnt      | b+2              | count bits set in word        |     |
| 77             | 27F7        | bitrevword  | 36               | reverse bits in word          |     |
| 78             | 27F8        | bitrevnbits | n+4              | reverse bottom n bits in word |     |

Table 11.22 CRC and bit operation codes

## 11.8 Floating point instructions

### 11.9 Floating point instructions for IMS T805 only

| Operation Code | Memory Code | Mnemonic    | Processor Cycles | Name                                | DEF |
|----------------|-------------|-------------|------------------|-------------------------------------|-----|
| 8E             | 28FE        | fpldnlsn    | 2                | fp load non-local single            |     |
| 8A             | 28FA        | fpldnlldb   | 3                | fp load non-local double            |     |
| 86             | 28F6        | fpldnlsni   | 4                | fp load non-local indexed single    |     |
| 82             | 28F2        | fpldnlldbi  | 6                | fp load non-local indexed double    |     |
| 9F             | 29FF        | fpldzerosn  | 2                | load zero single                    |     |
| A0             | 2AF0        | fpldzerodb  | 2                | load zero double                    |     |
| AA             | 2AFA        | fpldnladdsn | 8/11             | fp load non local & add single      | F   |
| A6             | 2AF6        | fpldnladddb | 9/12             | fp load non local & add double      | F   |
| AC             | 2AFC        | fpldnlmulsn | 13/20            | fp load non local & multiply single | F   |
| A8             | 2AF8        | fpldnlmuldb | 21/30            | fp load non local & multiply double | F   |
| 88             | 28F8        | fpstnlsn    | 2                | fp store non-local single           |     |
| 84             | 28F4        | fpstnlldb   | 3                | fp store non-local double           |     |
| 9E             | 29FE        | fpstnli32   | 4                | store non-local int32               |     |

Processor cycles are shown as **Typical/Maximum** cycles.

Table 11.23 Floating point load/store operation codes

| Operation Code | Memory Code | Mnemonic | Processor Cycles | Name                      | DEF |
|----------------|-------------|----------|------------------|---------------------------|-----|
| AB             | 2AFB        | fpentry  | 1                | floating point unit entry |     |
| A4             | 2AF4        | fprev    | 1                | fp reverse                |     |
| A3             | 2AF3        | fpdup    | 1                | fp duplicate              |     |

Table 11.24 Floating point general operation codes

| Operation Code | Memory Code | Mnemonic | Processor Cycles | Name                                | DEF |
|----------------|-------------|----------|------------------|-------------------------------------|-----|
| 22             | s           | fpurn    | 1                | set rounding mode to round nearest  |     |
| 06             | s           | fpurz    | 1                | set rounding mode to round zero     |     |
| 04             | s           | fpurp    | 1                | set rounding mode to round positive |     |
| 05             | s           | fpurm    | 1                | set rounding mode to round minus    |     |

Table 11.25 Floating point rounding operation codes

| Operation Code | Memory Code | Mnemonic      | Processor Cycles | Name                          | DEF |
|----------------|-------------|---------------|------------------|-------------------------------|-----|
| 83             | 28F3        | fpchkerror    | 1                | check fp error                | E   |
| 9C             | 29FC        | fpctesterror  | 2                | test fp error false and clear | F   |
| 23             | s           | fpuseterror   | 1                | set fp error                  | F   |
| 9C             | s           | fpuclearerror | 1                | clear fp error                | F   |

Table 11.26 Floating point error operation codes

| Operation Code | Memory Code | Mnemonic    | Processor Cycles | Name                         | DEF |
|----------------|-------------|-------------|------------------|------------------------------|-----|
| 94             | 29F4        | fpgt        | 4/6              | fp greater than              | F   |
| 95             | 29F5        | fpeq        | 3/5              | fp equality                  | F   |
| 92             | 29F2        | fpordered   | 3/4              | fp orderability              |     |
| 91             | 29F1        | fpnan       | 2/3              | fp NaN                       |     |
| 93             | 29F3        | fpnotfinite | 2/2              | fp not finite                |     |
| 0E             | s           | fpuchki32   | 3/4              | check in range of type int32 | F   |
| 0F             | s           | fpuchki64   | 3/4              | check in range of type int64 | F   |

Processor cycles are shown as **Typical/Maximum** cycles.

Table 11.27 Floating point comparison operation codes

| Operation Code | Memory Code | Mnemonic    | Processor Cycles | Name                       | DEF |
|----------------|-------------|-------------|------------------|----------------------------|-----|
| 07             | s           | fpur32tor64 | 3/4              | real32 to real64           | F   |
| 08             | s           | fpur64tor32 | 6/9              | real64 to real32           | F   |
| 9D             | 29FD        | fpstoi32    | 7/9              | real to int32              | F   |
| 96             | 29F6        | fpi32tor32  | 8/10             | int32 to real32            |     |
| 98             | 29F8        | fpi32tor64  | 8/10             | int32 to real64            |     |
| 9A             | 29FA        | fpb32tor64  | 8/8              | bit32 to real64            |     |
| 0D             | s           | fpunoround  | 2/2              | real64 to real32, no round |     |
| A1             | 2AF1        | fpint       | 5/6              | round to floating integer  | F   |

Processor cycles are shown as **Typical/Maximum** cycles.

Table 11.28 Floating point conversion operation codes



## 11 Transputer instruction set summary

| Operation Code | Memory Code | Mnemonic     | Processor Cycles |        | Name                      | DEF |
|----------------|-------------|--------------|------------------|--------|---------------------------|-----|
|                |             |              | Single           | Double |                           |     |
| 87             | 28F7        | fpadd        | 6/9              | 6/9    | fp add                    | F   |
| 89             | 28F9        | fpsub        | 6/9              | 6/9    | fp subtract               | F   |
| 8B             | 28FB        | fpmul        | 11/18            | 18/27  | fp multiply               | F   |
| 8C             | 28FC        | fpdiv        | 16/28            | 31/43  | fp divide                 | F   |
| 0B             | s           | fpuabs       | 2/2              | 2/2    | fp absolute               | F   |
| 8F             | 28FF        | fpremfirst   | 36/46            | 36/46  | fp remainder first step   | F   |
| 90             | 29F0        | fpreimestep  | 32/36            | 32/36  | fp remainder iteration    |     |
| 01             | s           | fpusqrtfirst | 27/29            | 27/29  | fp square root first step | F   |
| 02             | s           | fpusqrtstep  | 42/42            | 42/42  | fp square root step       |     |
| 03             | s           | fpusqrtlast  | 8/9              | 8/9    | fp square root end        |     |
| 0A             | s           | fpuexpinc32  | 6/9              | 6/9    | multiply by $2^{32}$      | F   |
| 09             | s           | fpuexpdec32  | 6/9              | 6/9    | divide by $2^{32}$        | F   |
| 12             | s           | fpumulby2    | 6/9              | 6/9    | multiply by 2.0           | F   |
| 11             | s           | fpudivby2    | 6/9              | 6/9    | divide by 2.0             | F   |

Processor cycles are shown as **Typical/Maximum** cycles.

Table 11.29 Floating point arithmetic operation codes

### 11.10 Floating point instructions for IMS T400 and IMS T425 only

| Operation Code | Memory Code | Mnemonic   | Processor Cycles | Name                                                 | DEF |
|----------------|-------------|------------|------------------|------------------------------------------------------|-----|
| 73             | 27F3        | cflerr     | 3                | check floating point error                           | E   |
| 9C             | 29FC        | fpsterr    | 1                | load value true (FPU not present)                    |     |
| 63             | 26F3        | unpacksn   | 15               | unpack single length fp number                       |     |
| 6D             | 26FD        | roundsn    | 12/15            | round single length fp number                        |     |
| 6C             | 26FC        | postnormsn | 5/30             | post-normalise correction of single length fp number |     |
| 71             | 27F1        | ldinf      | 1                | load single length infinity                          |     |

Processor cycles are shown as **Typical/Maximum** cycles.

Table 11.30 Floating point support operation codes